
Introduction**1 Introduction**

The MuSLIC, a chipset of three highly sophisticated ICs, bridges the gap between the analog and the digital signal transmission in modern telecommunication systems.

This highly integrated chip set supports to realize an extremely compact Analog Subscriber Line Interface Module. Only a few external components are required and there is no trimming or adjustment necessary to meet worldwide recommendations.

Each device is made of the best fitting technology (CMOS, BiCMOS and Smart Power Technology) and the standard SMD-packages P-MQFP and P-DSO are used.

The chipset consists of the following three ICs:

- PEB 31665 (MuPP Multichannel Processor for POTS)
- PEB 3465 (QAP Quad Analog POTS)
- PEB 4165 (AHV-SLIC Advanced High Voltage Subscriber Line Circuit)

Multichannel Subscriber Line Interface Concept MuSLIC

PEB 3465
PEB 31665
PEB 4165

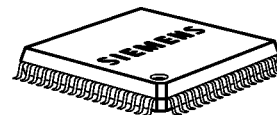
Version 1.0

CMOS

1.1 Features

- Chip set of three well fitted chips optimized for a 16 POTS-base system
- Including all low and high voltage SLIC functions
- Only a few external components are required
- No trimming or adjustments are required
- Specification according to relevant ITU-T, LSSGR and DTAG recommendations
- Digital signal processing technique
- Advanced low power CMOS and BiCMOS¹⁾ and Smart Power technology
- PCM encoded digital voice transmission (A-Law or μ -Law)
- Two serial IOM-2 (GCI) Interfaces with together 6 pins
- 12 Pin, 8 bits parallel microcontroller interface
- High performance AD and DA Conversion
- Programmable digital filters for
 - Impedance matching
 - Transhybrid balancing
 - Frequency response
 - Gain
- Advanced test capabilities
 - Integrated line and circuit tests
 - Two programmable tone generators

¹⁾ Abbreviations see chapter 10.3



P-MQFP-80-1



P-MQFP-44-2



P-DSO-20

Type	Ordering Code	Package
PEB 3465 V1.0	on request	P-MQFP-80-1
PEB 31665 V1.0	on request	P-MQFP-44-2
PEB 4165 V1.0	on request	P-DSO-20

Introduction

- Fully digital programmable DC-Characteristic
 - Programmable Constant Current from 0 to 50 mA
 - Programmable Resistive Values from 0 to $2 \times 500 \Omega$
 - Programmable Constant Voltage
- Programmable Integrated Teletax Injection and Filtering during Active in Onhook and Offhook
 - Programmable up to 10 Vrms at Ring/Tip-wire of the AHV-SLIC
 - Programmable frequency (12/16 kHz)
- Polarity reversal (programmable soft or hard)
- Integrated (balanced) Ringing Generation with zero crossing injection
 - Programmable frequency between 16.6 and 70 Hz
 - Programmable amplitude up to 85 Vrms at Ring/Tip-wire of the AHV-SLIC
- Three operating modes: Power Down, Active and Ringing
- Offhook detection with programmable thresholds for all operating modes
- Integrated Ring Trip Detection with zero crossing turn off function
- Ground Start and Loop Start possible
- Integrated checksum calculation for CRAM (AC and DC separated)
- Linecard Identification
- Sensing of transversal and longitudinal line current
- Battery voltage – 24 V ... – 80 V; Auxiliary voltage + 5 V... + 85 V
- Boosted battery mode with up to 150 V supply for long telephone lines and up to 85 Vrms balanced ringing
- Reliable 170 V Smart Power Technology
- Standard SMD packages: P-MQFP-44 and P-MQFP-80 for the low voltage parts and small power package P-DSO-20 for the high voltage device

Introduction

1.2 Logic Symbol (PEB 3465)

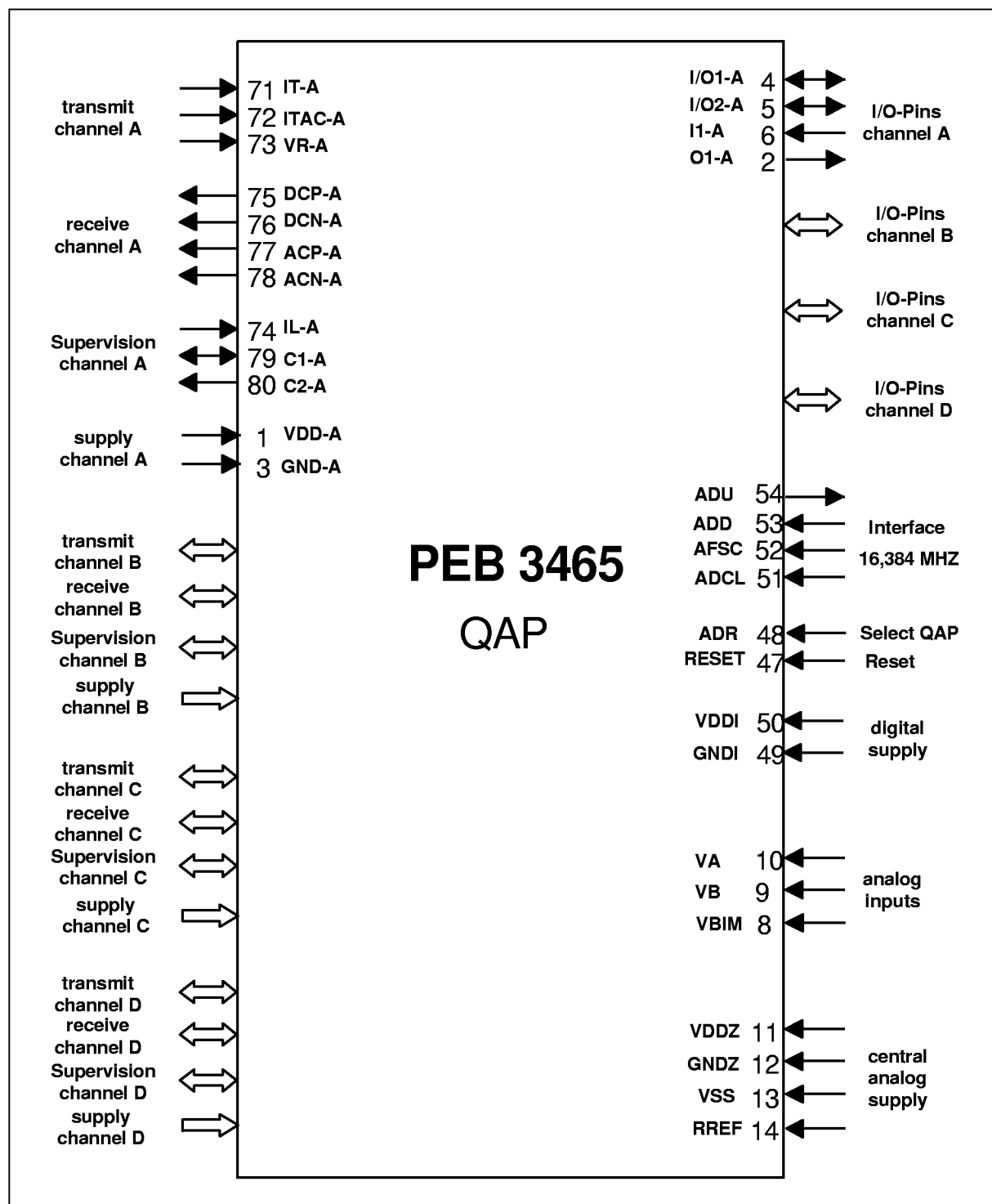


Figure 1

1.2.1 Pin Configuration (PEB 3465)

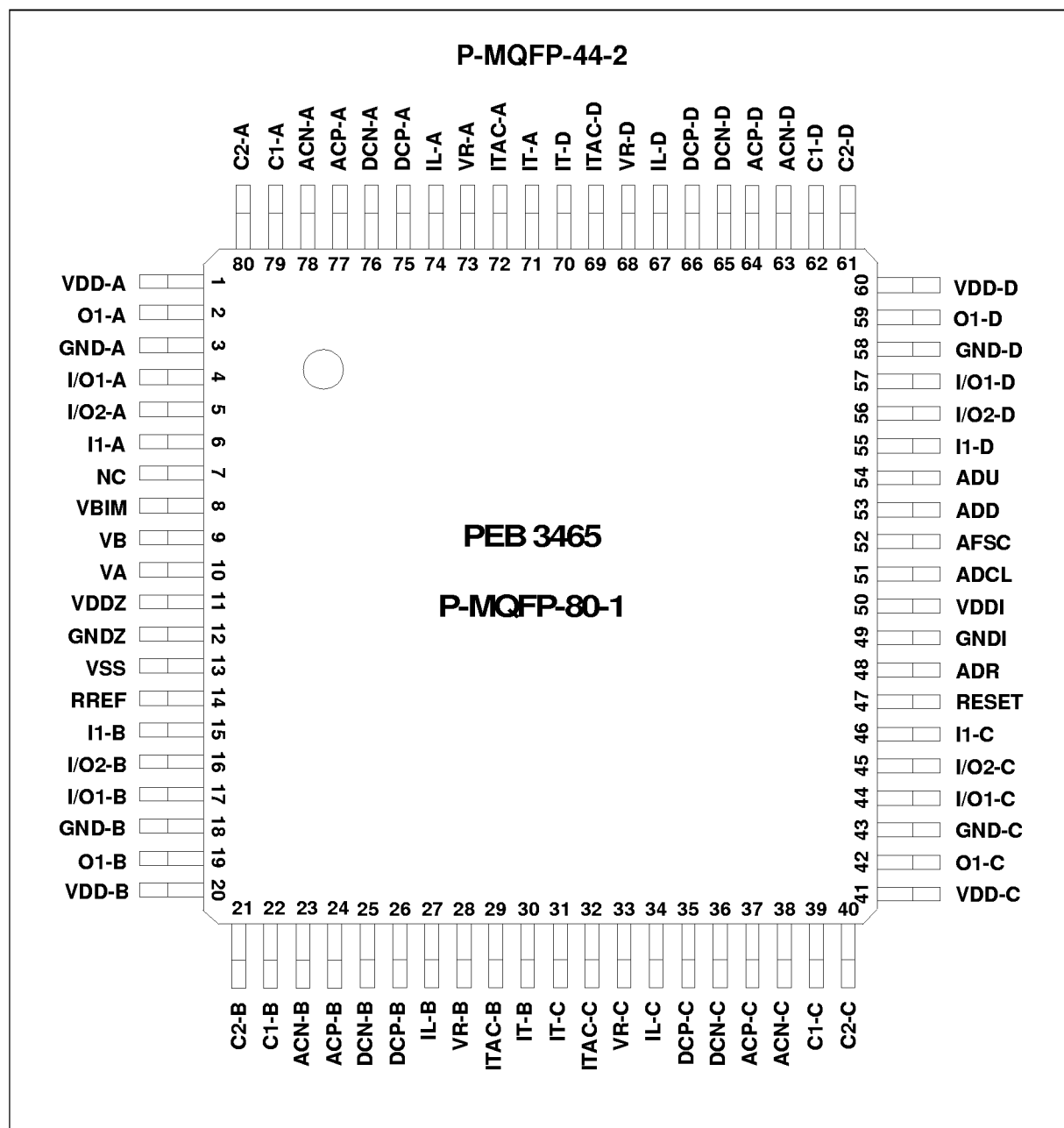


Figure 2

Introduction
1.2.2 Pin Definition and Functions (PEB 3465)

The following tables group the pins according to their functions. They include pin number, pin name, type, a brief description of the function, and cross-references referring to the sections in which the pin functions are discussed.

Table 1 Pin Definition and Functions (PEB 3465)

Pin No.	Name	Type	Function	Reference
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Power Supply Pins

1	VDD-A	–	+ 5 V Analog Supply Voltage (channel A)	
20	VDD-B	–	+ 5 V Analog Supply Voltage (channel B)	
41	VDD-C	–	+ 5 V Analog Supply Voltage (channel C)	
60	VDD-D	–	+ 5 V Analog Supply Voltage (channel D)	
3	GND-A	–	Analog Ground (channel A)	
18	GND-B	–	Analog Ground (channel B)	
43	GND-C	–	Analog Ground (channel C)	
58	GND-D	–	Analog Ground (channel D)	
11	VDDZ	–	+ 5 V Analog Supply Voltage (bias)	
12	GNDZ	–	Analog Ground (bias)	
13	VSS	–	– 5 V Analog Supply Voltage	
50	VDDI	–	+ 5 V Digital Supply Voltage	
49	GNDI	–	Digital Ground	

Interface Pins to MuPP (PEB 31665)

54	ADU	O	Analog Data Upstream	
53	ADD	I	Analog Data Downstream	
51	ADCL	I	Analog Data-Clock	
52	AFSC	I	Analog Frame-Sync.	
48	ADR	I	Select odd or even port nr.	
47	RESET	I	Interface-Reset	

Introduction
Table 1 Pin Definition and Functions (PEB 3465) (cont'd)

Pin No.	Name	Type	Function	Reference
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Interface to AHV-SLIC (PEB 4165)

71	IT-A	I	Transversal Current Input (AC+DC), chan. A	
72	ITAC-A	I	Transversal Current Input (AC), chan. A	
73	VR-A	I	Reference Input, chan. A	
74	IL-A	I	Longitudinal Current Input, chan. A	
77	ACP-A	O	Two Wire Output Voltage (ACP), chan. A	
78	ACN-A	O	Two Wire Output Voltage (ACN), chan. A	
75	DCP-A	O	Two Wire Output Voltage (DCP), chan. A	
76	DCN-A	O	Two Wire Output Voltage (DCN), chan. A	
79	C1-A	I/O	Digital Interface to HV-SLIC, chan. A	
80	C2-A	O	Digital Interface to HV-SLIC, chan. A	
30	IT-B	I	Transversal Current Input (AC+DC), chan. B	
29	ITAC-B	I	Transversal Current Input (AC), chan. B	
28	VR-B	I	Reference Input, chan. B	
27	IL-B	I	Longitudinal Current Input, chan. B	
24	ACP-B	O	Two Wire Output Voltage (ACP), chan. B	
23	ACN-B	O	Two Wire Output Voltage (ACN), chan. B	
26	DCP-B	O	Two Wire Output Voltage (DCP), chan. B	
25	DCN-B	O	Two Wire Output Voltage (DCN), chan. B	
22	C1-B	I/O	Digital Interface to HV-SLIC, chan. B	
21	C2-B	O	Digital Interface to HV-SLIC, chan. B	
31	IT-C	I	Transversal Current Input (AC+DC), chan. C	
32	ITAC-C	I	Transversal Current Input (AC), chan. C	
33	VR-C	I	Reference Input, chan. C	
34	IL-C	I	Longitudinal Current Input, chan. C	
37	ACP-C	O	Two Wire Output Voltage (ACP), chan. C	
38	ACN-C	O	Two Wire Output Voltage (ACN), chan. C	
35	DCP-C	O	Two Wire Output Voltage (DCP), chan. C	
36	DCN-C	O	Two Wire Output Voltage (DCN), chan. C	

Introduction
Table 1 Pin Definition and Functions (PEB 3465) (cont'd)

Pin No.	Name	Type	Function	Reference
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Interface to AHV-SLIC (PEB 4165) (cont'd)

39	C1-C	I/O	Digital Interface to HV-SLIC, chan. C	
40	C2-C	O	Digital Interface to HV-SLIC, chan. C	
70	IT-D	I	Transversal Current Input (AC+DC), chan. D	
69	ITAC-D	I	Transversal Current Input (AC), chan. D	
68	VR-D	I	Reference Input, chan. D	
67	IL-D	I	Longitudinal Current Input, chan. D	
64	ACP-D	O	Two Wire Output Voltage (ACP), chan. D	
63	ACN-D	O	Two Wire Output Voltage (ACN), chan. D	
66	DCP-D	O	Two Wire Output Voltage (DCP), chan. D	
65	DCN-D	O	Two Wire Output Voltage (DCN), chan. D	
62	C1-D	I/O	Digital Interface to HV-SLIC, chan. D	
61	C2-D	O	Digital Interface to HV-SLIC, chan. D	

Introduction
Table 1 Pin Definition and Functions (PEB 3465) (cont'd)

Pin No.	Name	Type	Function	Reference
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IO Pins

4	IO1-A	I/O	User-Programmable I/O Pin, chan. A	
5	IO2-A	I/O	User-Programmable I/O Pin, chan. A	
6	I1-A	I	Fixed Input Pin, chan. A	
2	O1-A	O	Fixed Output Pin, chan. A	
17	IO1-B	I/O	User-Programmable I/O Pin, chan. B	
16	IO2-B	I/O	User-Programmable I/O Pin, chan. B	
15	I1-B	I	Fixed Input Pin, chan. B	
19	O1-B	O	Fixed Output Pin, chan. B	
44	IO1-C	I/O	User-Programmable I/O Pin, chan. C	
45	IO2-C	I/O	User-Programmable I/O Pin, chan. C	
46	I1-C	I	Fixed Input Pin, chan. C	
42	O1-C	O	Fixed Output Pin, chan. C	
57	IO1-D	I/O	User-Programmable I/O Pin, chan. D	
56	IO2-D	I/O	User-Programmable I/O Pin, chan. D	
55	I1-D	I	Fixed Input Pin, chan. D	
59	O1-D	O	Fixed Output Pin, chan. D	

Miscellaneous Function Pins

14	RREF	I	External resistor to GNDZ	
10	VA	I	Voltage sense a	
9	VB	I	Voltage sense b	
8	VBIM	I	Battery image sense input	

Pins not Used

7	N.C.	–	Not connected (not used)	
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1.2.3 Functional Block Diagram (PEB 3465)

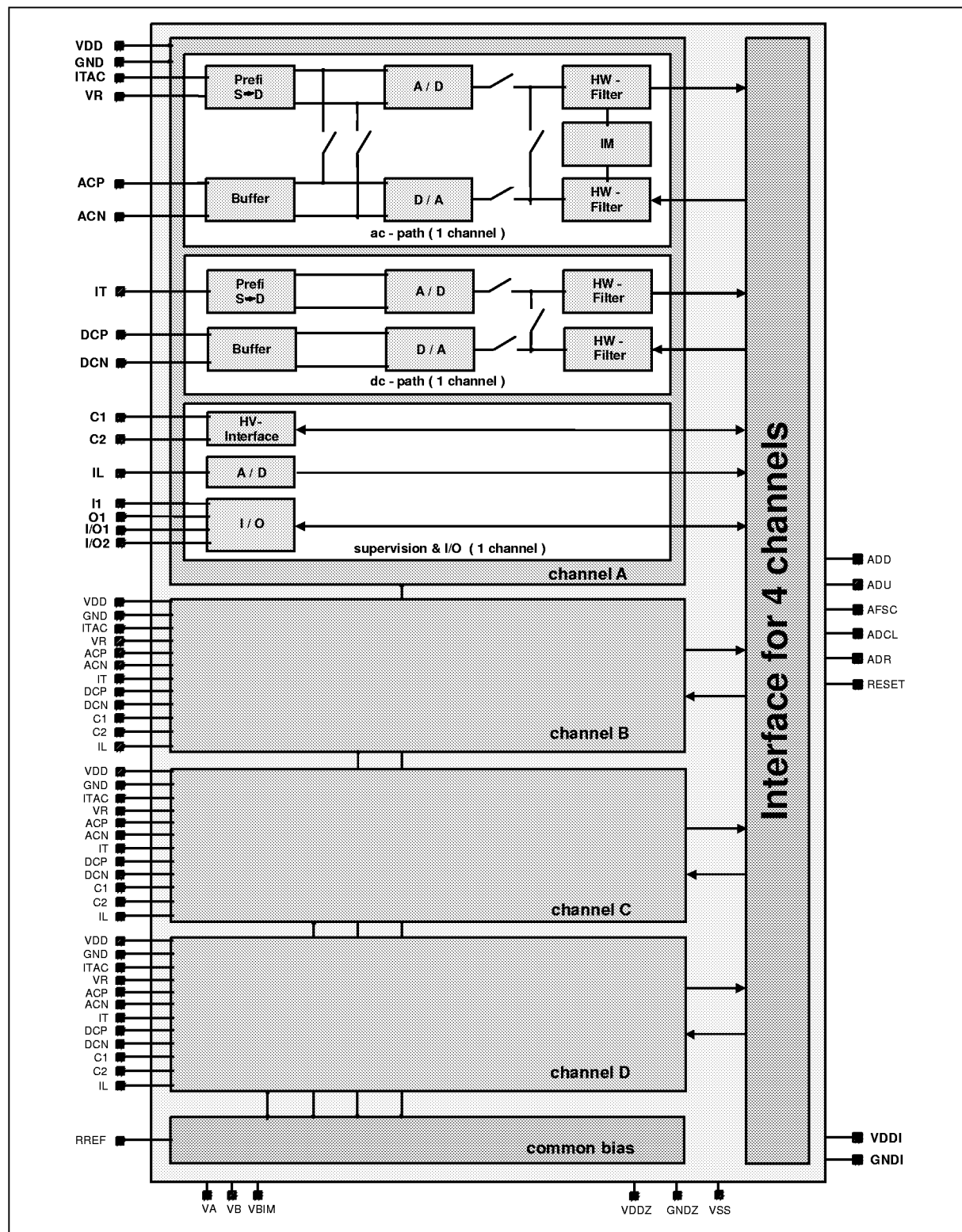


Figure 3

1.3 Logic Symbol (PEB 31665)

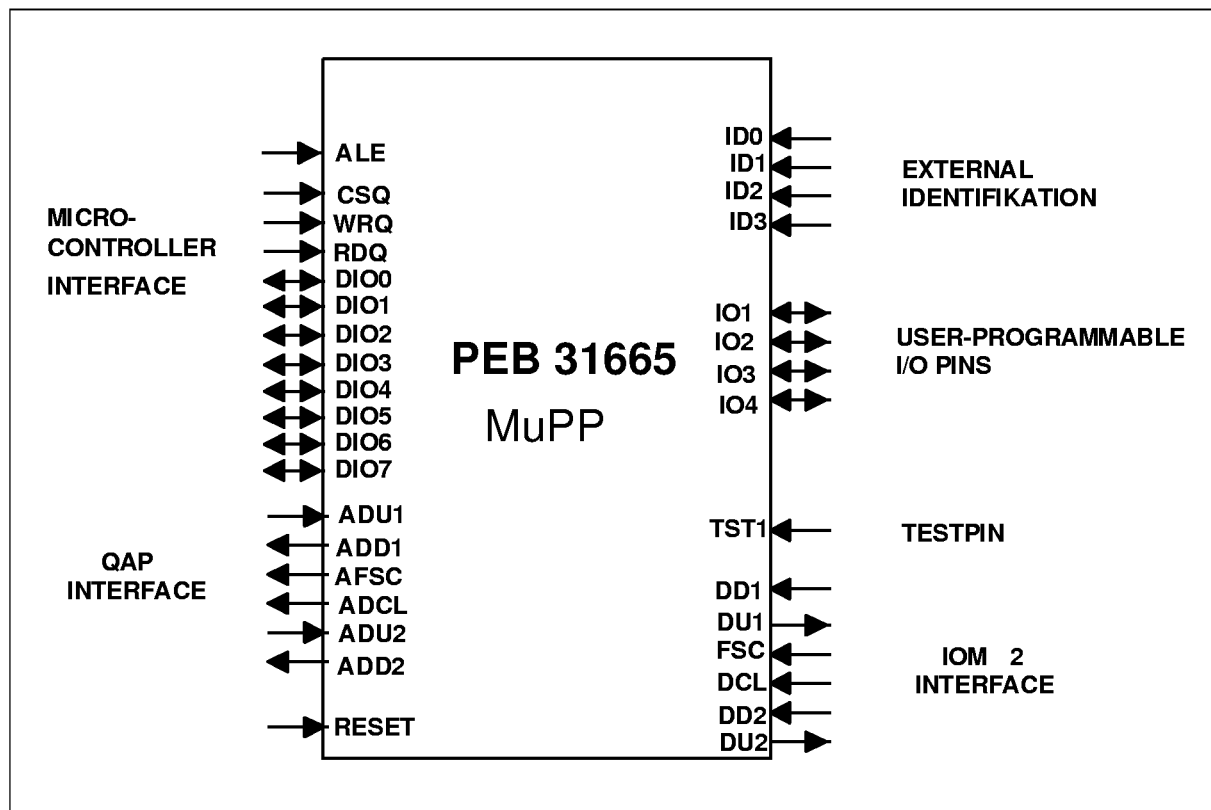


Figure 4

1.3.1 Pin Configuration (PEB 31665)

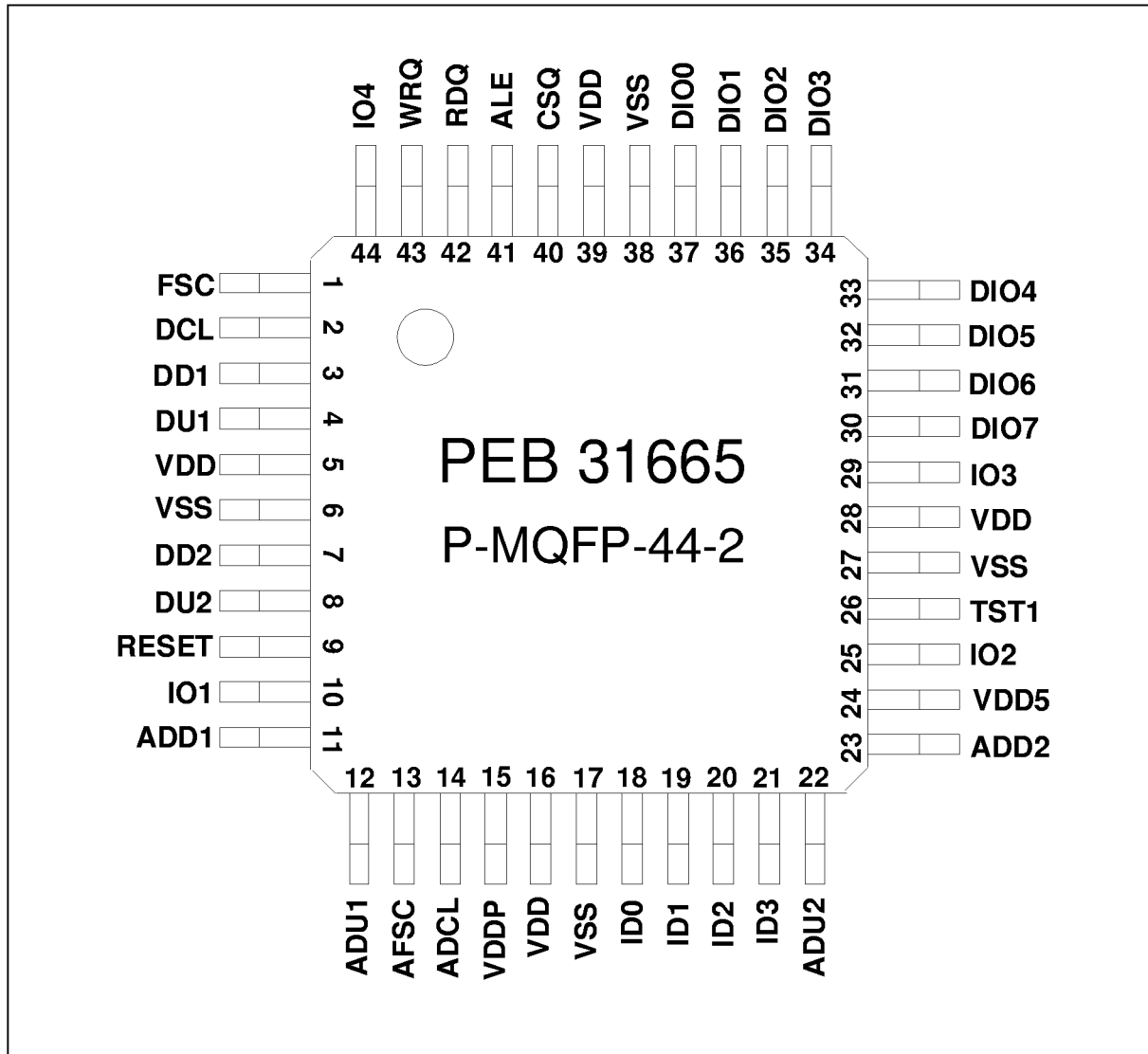


Figure 5

Introduction
1.3.2 Pin Definitions and Functions (PEB 31665)

The following tables group the pins according to their functions. They include pin number, pin name, type, a brief description of the function, and cross-references referring to the sections in which the pin functions are discussed.

Table 2 Pin Definitions and Functions (PEB 31665)

Pin No.	Name	Type	Function	Reference
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Power Supply Pins

6	VSS	–	Digital Ground	
17	VSS	–	Digital Ground	
27	VSS	–	Digital Ground	
38	VSS	–	Digital Ground	
5	VDD	–	+ 3.3 V Digital Supply Voltage	
15	VDDP	–	+ 3.3 V Digital Supply Voltage for PLL	
16	VDD	–	+ 3.3 V Digital Supply Voltage	
28	VDD	–	+ 3.3 V Digital Supply Voltage	
39	VDD	–	+ 3.3 V Digital Supply Voltage	
24	VDD5	–	+ 5 V Digital Supply Voltage	

IOM[®]-2 Pins

4	DU1	O	1'st IOM-2 Data Upstream (open drain)	
3	DD1	I	1'st IOM-2 Data Downstream	
2	DCL	I	IOM-2 Data-Clock	
1	FSC	I	IOM-2 Frame-Sync.	
8	DU2	O	2'nd IOM-2 Data Upstream (open drain)	
7	DD2	I	2'nd IOM-2 Data Downstream	

Introduction
Table 2 Pin Definitions and Functions (PEB 31665) (cont'd)

Pin No.	Name	Type	Function	Reference
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MuPP/QAP Interface

11	ADD1	O	1'st QAP Data Downstream	
12	ADU1	I	1'st QAP Data Upstream	
13	AFSC	O	QAP Frame-Sync	
14	ADCL	O	QAP Data-Clock	
23	ADD2	O	2'nd QAP Data Downstream	
22	ADU2	I	2'nd QAP Data Upstream	

Microcontroller Interface

40	CSQ	I	μC Chip select	
41	ALE	I	μC Address latch enable	
42	RDQ	I	μC Data-Clock read	
43	WRQ	I	μC Data-Clock write	
37	DIO0	I/O	μC Data / Address	
36	DIO1	I/O	μC Data / Address	
35	DIO2	I/O	μC Data / Address	
34	DIO3	I/O	μC Data / Address	
33	DIO4	I/O	μC Data / Address	
32	DIO5	I/O	μC Data / Address	
31	DIO6	I/O	μC Data / Address	
30	DIO7	I/O	μC Data / Address	

IO Pins

10	IO1	I/O	User-Programmable I/O Pin	
25	IO2	I/O	User-Programmable I/O Pin	
29	IO3	I/O	User-Programmable I/O Pin	
44	IO4	I/O	User-Programmable I/O Pin	

Introduction
Table 2 Pin Definitions and Functions (PEB 31665) (cont'd)

Pin No.	Name	Type	Function	Reference
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Miscellaneous Function Pins

9	RESET	I	Reset	
18	ID0	I	External Identification	
19	ID1	I	External Identification	
20	ID2	I	External Identification	
21	ID3	I	External Identification	
26	TST1	I	Test Pin (must be connected to VSS)	

Introduction

1.3.3 Functional Block Diagram (PEB 31665)

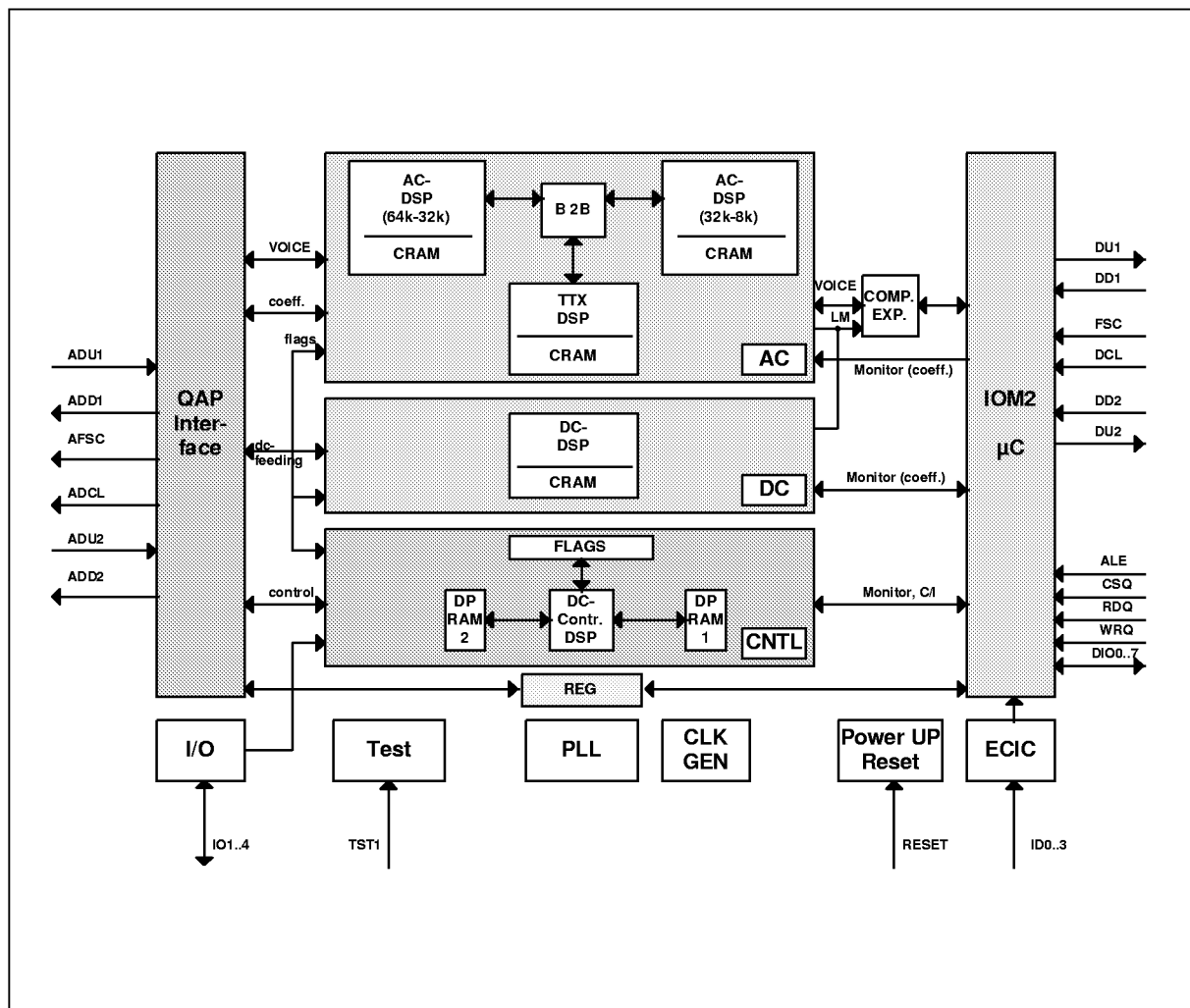


Figure 6

1.4 Logic Symbol (PEB 4165)

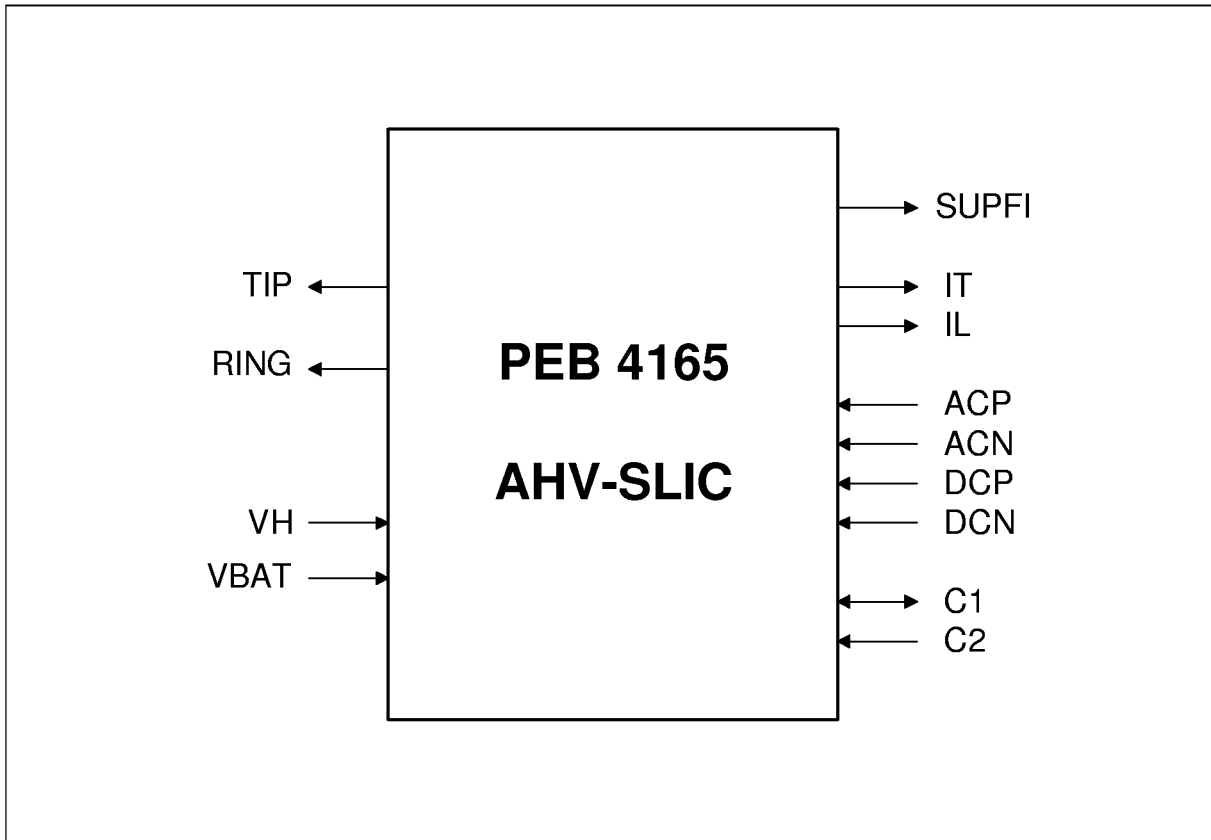


Figure 7

1.4.1 Pin Configuration (PEB 4165)

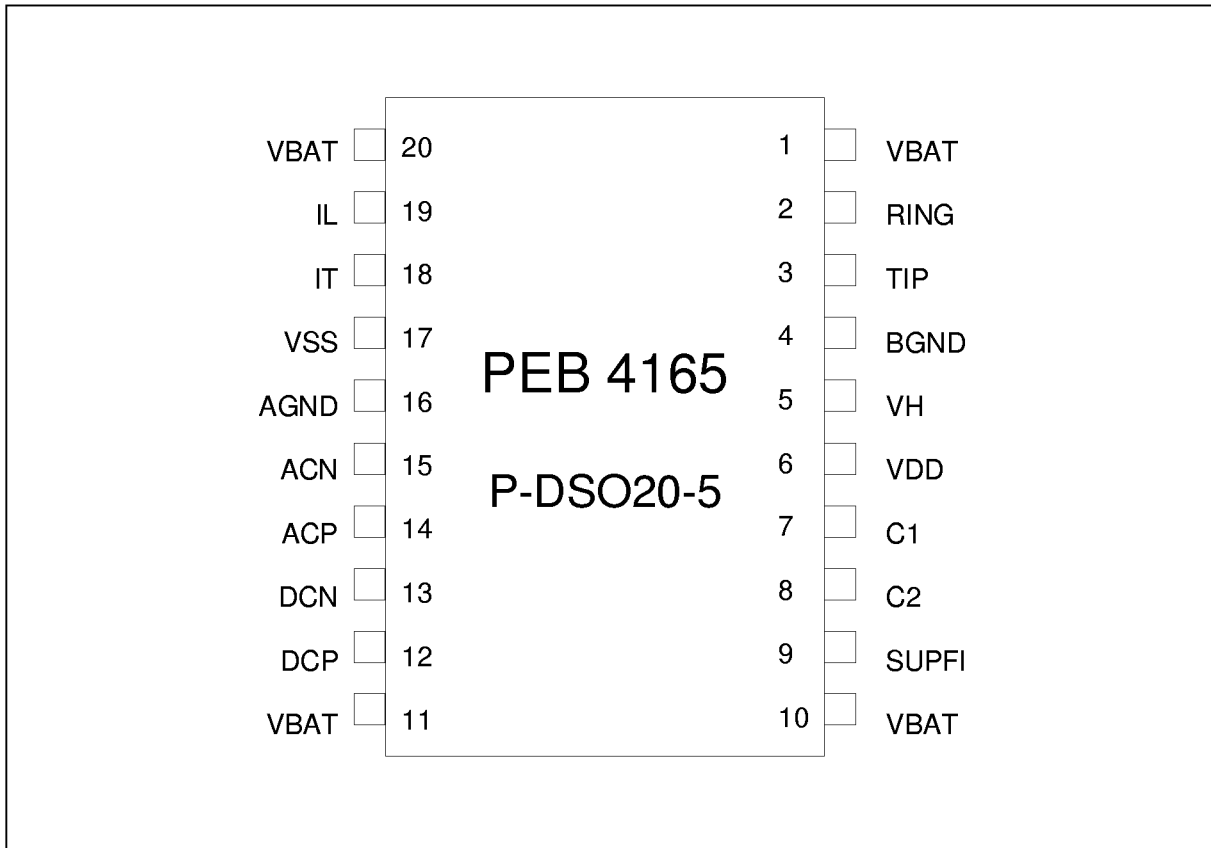


Figure 8

Introduction
1.4.2 Pin Definitions and Functions (PEB 4165)

Pin No.	Symbol	Type	Description
1,10,11,20	VBAT	Supply	Negative battery supply voltage ($-24 \dots -80 \text{ V}$), referred to BGND
2	RING	O	Subscriber loop connection RING
3	TIP	O	Subscriber loop connection TIP
4	BGND	Supply	Battery ground: TIP, RING, VBAT and VH refer to this pin
5	VH	Supply	Auxiliary positive battery supply voltage ($+5 \dots +85 \text{ V}$) used in ringing mode
9	SUPFI	O	External capacitance for supply voltage filtering (internal resistance of about $30 \text{ k}\Omega$)
6	VDD	Supply	Positive supply voltage ($+5 \text{ V}$), referred to AGND
7	C1	I/O	Ternary logic input, controlling the operation mode; in case of thermal overload this pin sinks a current of typ. $150 \mu\text{A}$
8	C2	I	Ternary logic input, controlling the operation mode
12,13	DCP,DCN	I	Differential two wire DC-input voltage; multiplied by -25 and related to $(VH - VBAT) / 2$, DCN appears at TIP and DCP at RING output, respectively
14,15	ACP,ACN	I	Differential two wire AC-input voltage; multiplied by -3.125 , ACN appears at TIP and ACP at RING output, respectively
16	AGND	Supply	Analog ground: VDD, VSS and all signal and control pins with the exception of TIP and RING refer to AGND
17	VSS	Supply	Negative supply voltage (-5 V), referred to AGND
18	IT	O	Current output representing the transversal current scaled down by a factor of 50.
19	IL	O	Current output: longitudinal line current scaled down by a factor of 50.

1.4.3 Functional Block Diagram (PEB 4165)

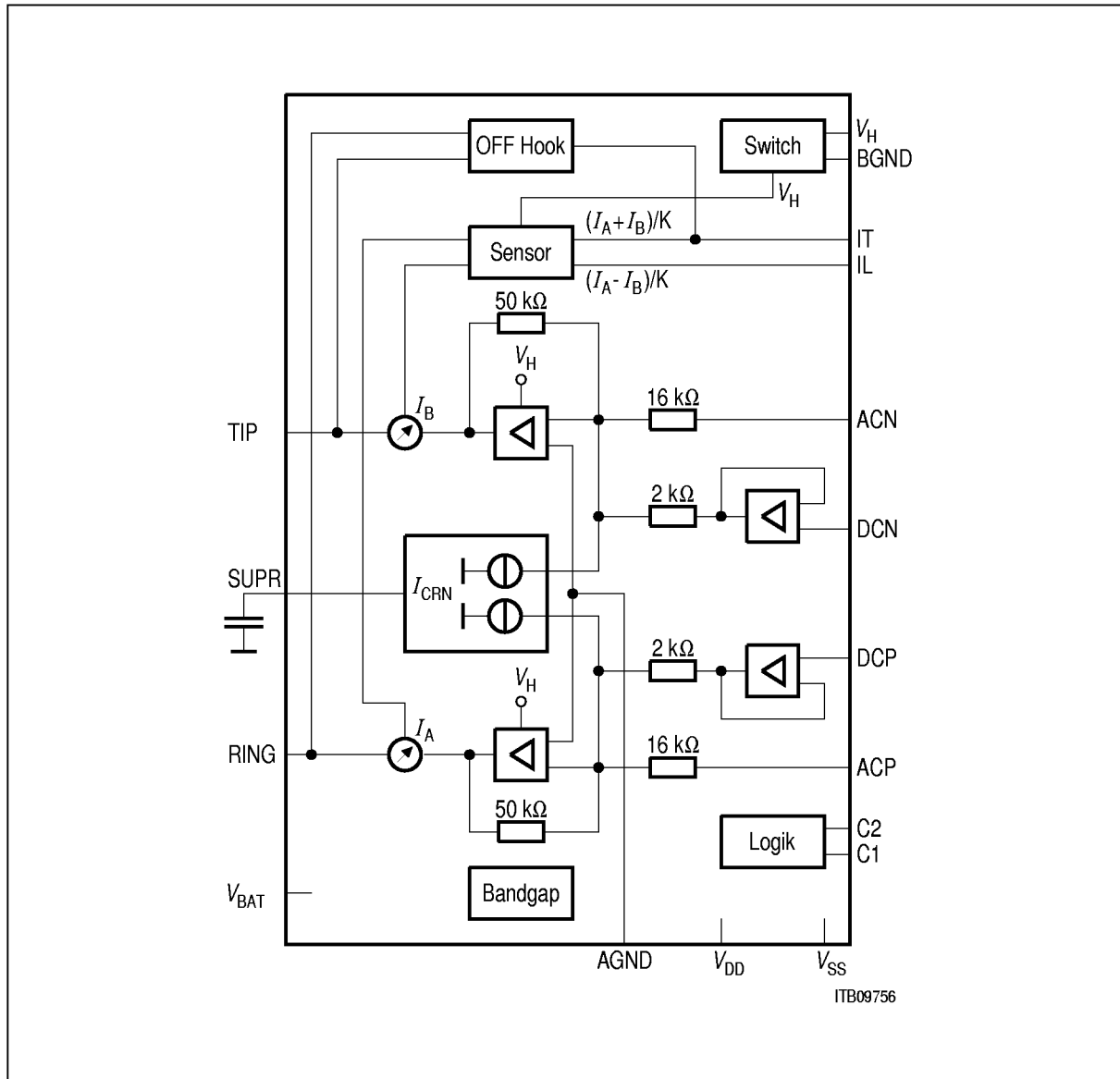


Figure 9

1.5 System Integration

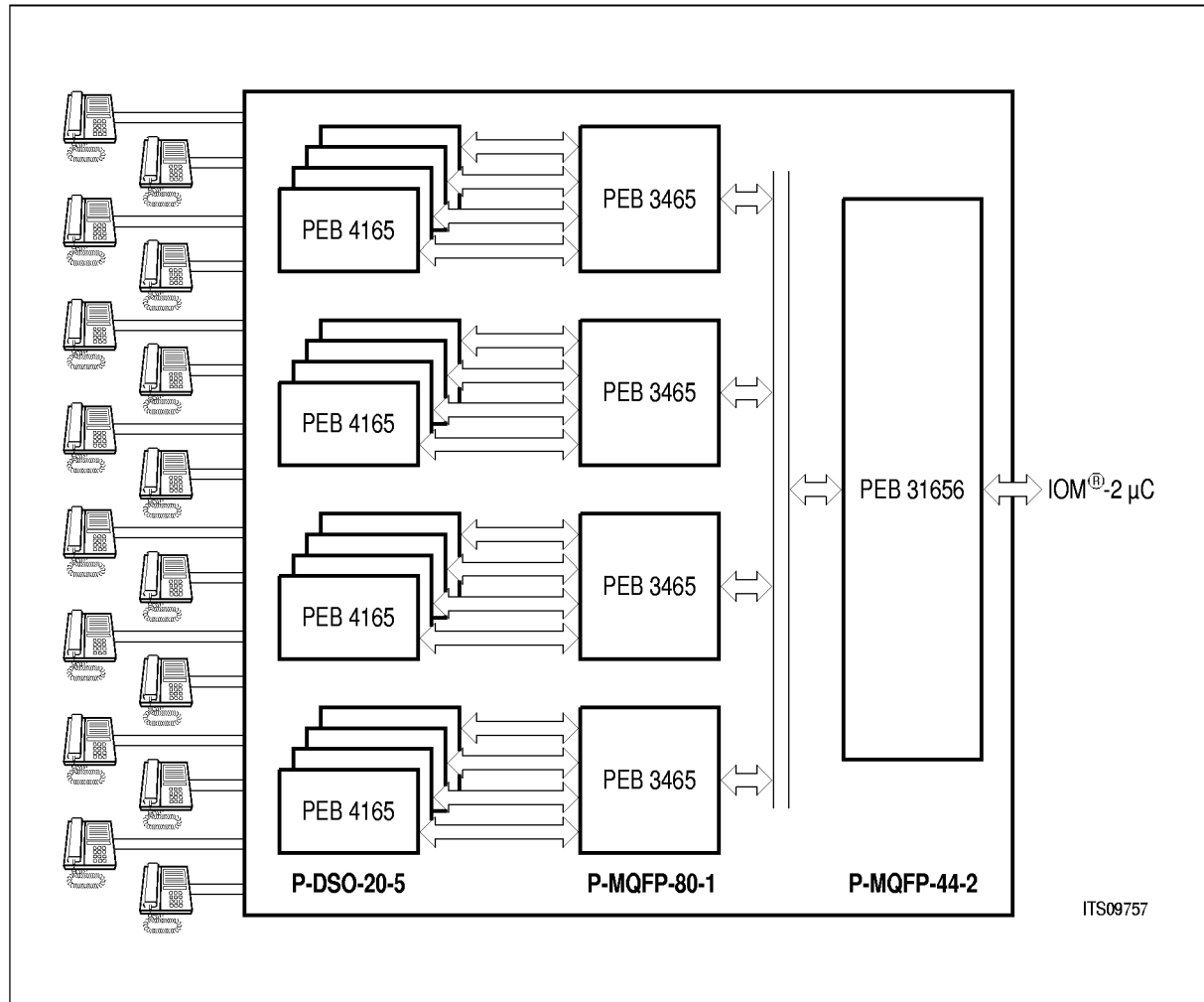


Figure 10 Block Figure of an Analog Linecard for 16 Subscribers Using MuSLIC

Introduction

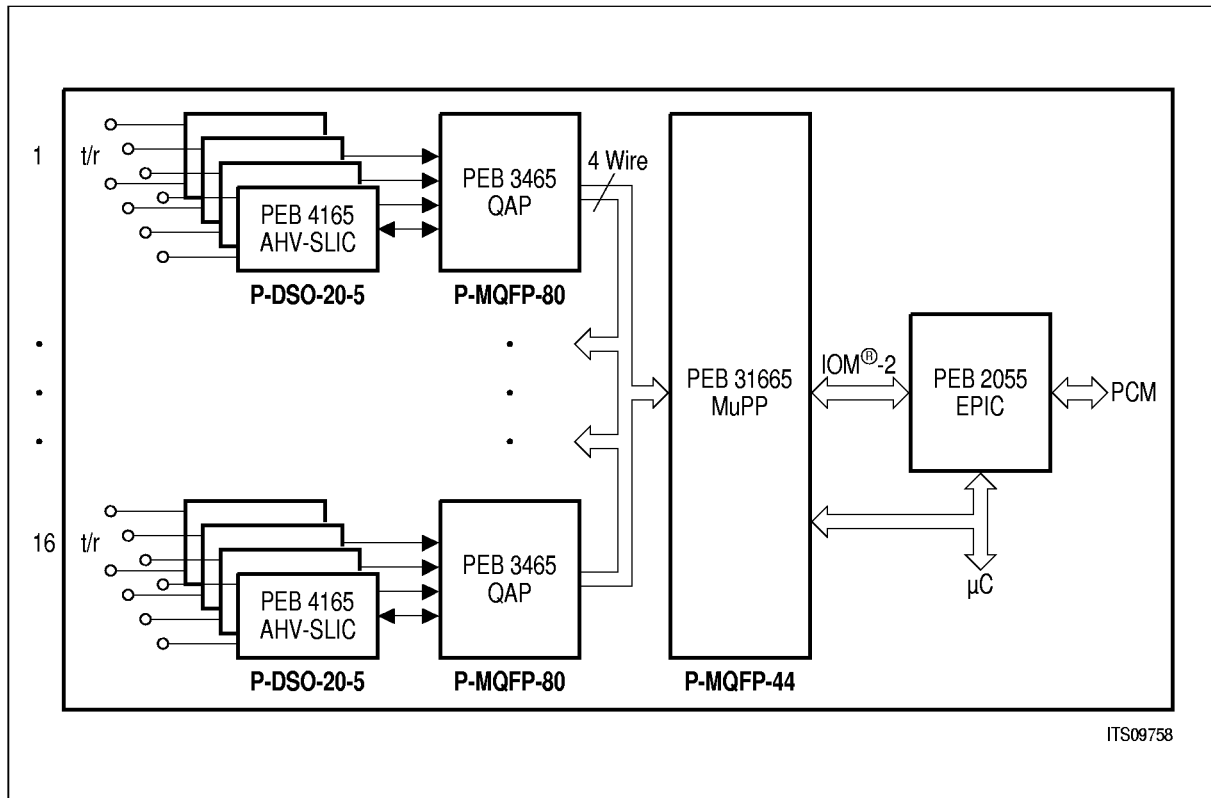


Figure 11 Application Example of a Central Office Analog Linecard for 16 Subscribers

Introduction

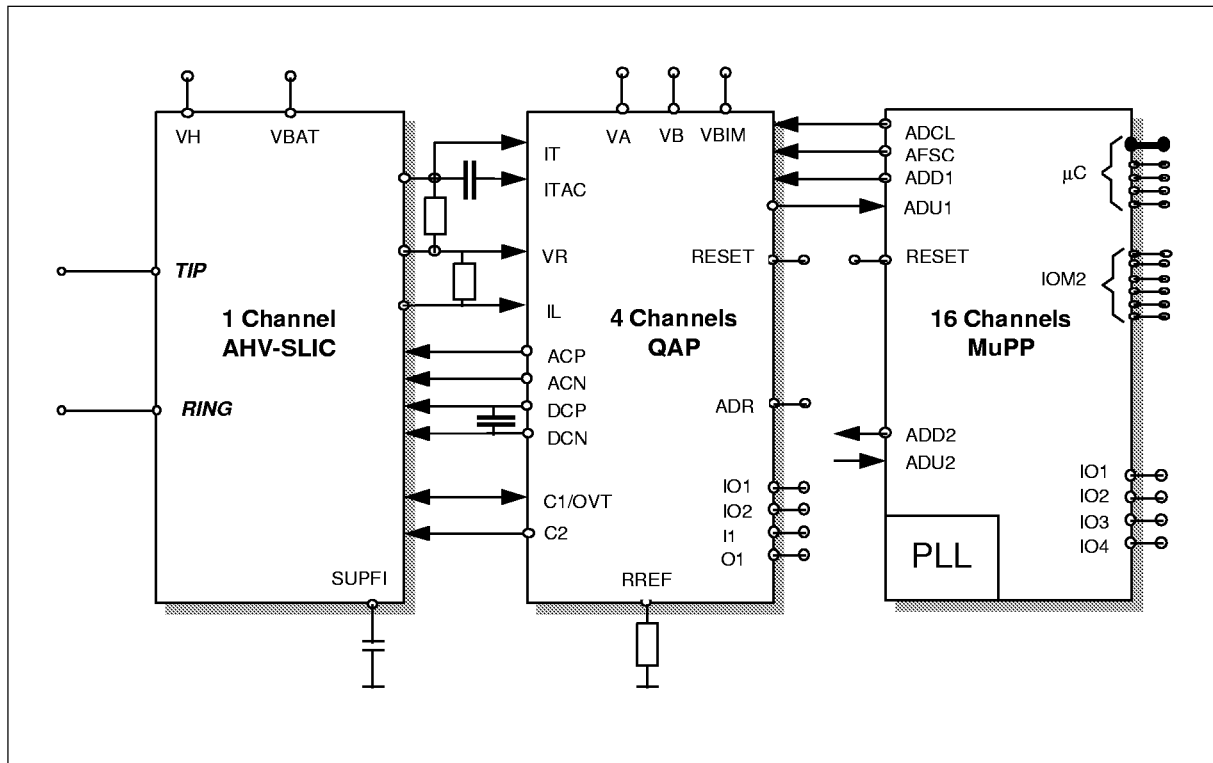


Figure 12 Overview of the Connection of MuPP, QAP and AHV-SLIC for One Subscriber

Functional Description**2 Functional Description**

The Multichannel Signal Processing Subscriber Line Interface Codec Filter Chipset, MuSLIC, is a logic continuation of the well established family of the SIEMENS PCM-Codec-Filter-ICs with the integration of all DC-feeding, Supervision and Meterpulse Injection features on chip as well. Fabricated in advanced CMOS, BiCMOS and High Voltage Technology SPT170 the MuSLIC is tailored for very flexible solutions in analog/digital communication systems.

The chip set consists of the digital signal processor for 16 channels (MuPP, multichannel processor for POTS), the analog/digital and digital/analog converter for 4 channels (QAP, quad analog POTS) and the high voltage interface chip for 1 channel (AHV-SLIC, advanced high voltage subscriber line interface circuit).

The MuPP uses the benefits of a DSP not only for the voice channel but even for line feeding and supervision which leads to a very high flexibility without the need of external components. Based on an advanced digital filter concept, the PEB 31665 (MuPP) and the PEB 3465 (QAP) provides excellent transmission performance. The new filter concept leads to a maximum of independence between the different filter blocks. Each filter block can be seen as a one to one representative of the corresponding network element. Together with the software package MuSLICOS, filter optimizing to different applications can be done in a clear and straight forward procedure. The AC frequency behavior is mainly determined by the digital filters. Using the oversampling 1 bit $\Sigma\Delta$ -AD/DA converters, linearity is only limited by second order parasitic effects.

The digital solution of line feeding offers free programmability of feeding current and voltage as well as very fast settling of the dc-operating point after transitions. A 0.3 Hz lowpass filter in the DC-loop is mainly responsible for the system stability.

Additionally teletax generation and filtering is implemented as well as free programmable balanced ring generation with zero-crossing injection. Offhook detection with programmable thresholds is possible in all operating modes. To reduce overall power consumption of the linecard, the MuPP, the QAP and the AHV-SLIC provide a Power Down mode.

To program the MuSLIC or to get status information about the chipset or the system 2 user interfaces are available: the IOM-2 interface and a 8-bit-parallel simple microcontroller interface.

The PEB 4165 (AHV-SLIC) provides battery feeding between – 24 V and – 80 V and ringing injection with a differential ring voltage up to 85 Vrms. In order to achieve these high amplitudes, an auxiliary positive battery voltage is used during ringing. This voltage can also be applied to drive very long telephone lines.

The AHV-SLIC is designed for a voltage feeding - current sensing line interface concept and provides sensing of transversal and longitudinal currents on both wires. In Power Down mode the AHV-SLIC is switched off turning the line outputs to a high impedance state. Off-hook supervision is provided by activating a simple line current sensor.

Functional Description

2.1 Principles

2.1.1 Signal Flow Graph: AC

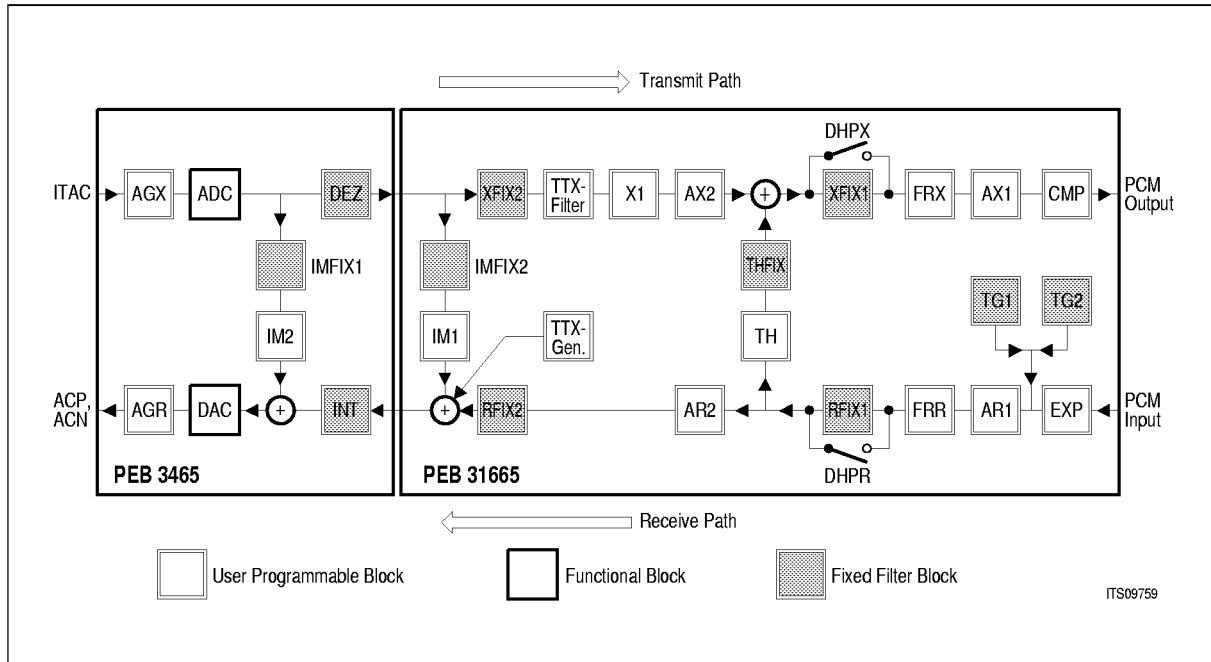


Figure 13

Transmit Path

The analog input signal has to be connected to pin ITAC of the PEB 3465 by an external capacitor (470 nF) for AC/DC separation. After passing a programmable gain stage (AGX = 0 or 6 dB) and a simple antialiasing prefilter the voice signal is converted to a 1-bit digital data stream in the $\Sigma\Delta$ -converter. The first down sampling steps are done in fast running digital hardware filters on the PEB 3465. This down sampled AC-signal (64 kHz sampling rate) is sent to the PEB 31665 via the MuPP/QAP-Interface in the ADU-channel. The following signal processing is done in the DSP-machine of the PEB 31665. The benefits of this are the programmability of frequency and gain behavior. At the end the fully processed signal is transferred to the IOM-2 Interface in a PCM-compressed (A-law / μ -law) signal representation.

Functional Description

Receive Path

The digital input signal is received via the IOM-2 Interface of the PEB 31665. Expansion, PCM-lowpass-filtering, gain correction and frequency response correction are the next steps which are done by the DSP-machine. This 64 kHz AC signal is sent from the QAP to the MuPP via the MuPP/QAP-Interface in the ADD-channel. The up sampling interpolation steps are processed by fast hardware structures in the PEB 3465 to reduce the DSP-workload. The 1-bit data stream is then converted to an analog equivalent. A subsequent programmable gain stage (AGR = 0 or 6 dB) and smoothing filter provides the AC output signal at the Pins ACP and ACN of the PEB 3465 for direct connection to the AHV-SLIC PEB 4165.

Loops

There are two different loops implemented: The Impedance Matching (IM) loop which is divided into 2 separate loops to guarantee very high flexibility to various impedances, and the Transhybrid Balancing (TH) loop.

For test purposes it is possible to close a loop behind the $\Sigma\Delta$ -converter to check either the analog of the digital part of the PEB 3465 and the PEB 31665 respectively.

2.1.2 Signal Flow Graph: DC

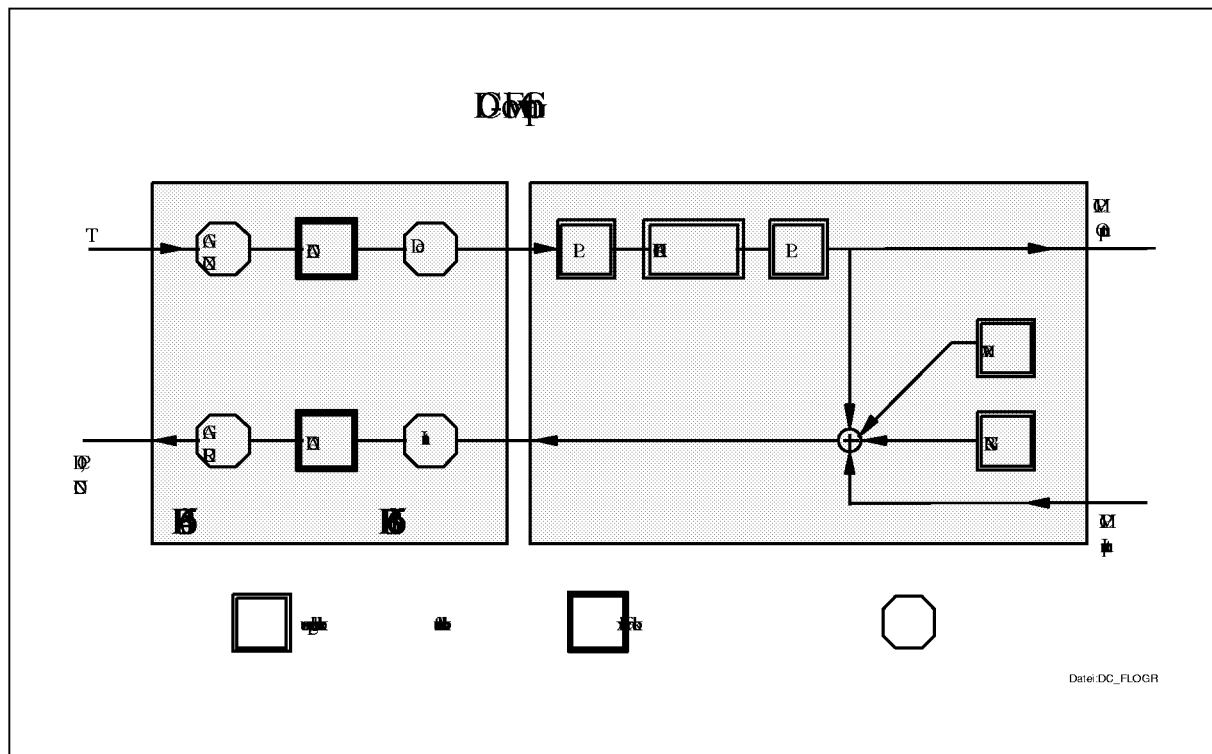


Figure 14

Functional Description**DC Characteristic**

The incoming information (transmit direction) at pin IT (scaled transversal AC + DC-current, transferred to a voltage via an external 1.5 k Ω resistor at IT) passes first an antialiasing filter and is then converted to a 1-bit digital data stream in the $\Sigma\Delta$ -converter. Down sampling is done in hardware filters of the PEB 3465. This DC-information (2 kHz sampling rate) is then fed to the PEB 31665 where it is first lowpass filtered (0.3 Hz corner frequency) for stability and noise reasons. The following DC-characteristic consists of three branches which represents different kinds of feeding behavior. In typical applications it acts as a programmable constant current source ($R_{in} > 30$ k Ω). If the desired value cannot be held feeding switches automatically and smoothly to the resistive branch (R_{in} programmable between 0 ... 1 k Ω). The third branch is used for feeding long lines - the DC-characteristic switches to a constant voltage behavior. For superimposing voice as well as Teletax pulses the necessary drop at the line can be calculated and taken into account as well. The outgoing bit stream (2 kHz sampling rate), representing the DC-feeding value is then sent back to the PEB 3465 where a 1-bit $\Sigma\Delta$ -converter and a following smoothing filter (using an external 33 nF capacitor) establish the desired values at the Pins DCP and DCN, respectively. Depending on the operating mode (Active, Ringing, Active with Boosted Battery) a gain of 0 or 4 dB is inserted.

For test purposes it is possible to close a loop to test either the analog part or the digital part of the DC path.

Supervision

The HOOK-information is the most important one and is provided via the IOM-2 Interface (CIDU-4: HOOK; see **chapter 4.2**), in all operating modes:

- **Power Down:** In this state the transversal line current is sensed by the PEB 4165 and fed to the PEB 3465 via Pin IT. Offhook is detected if the voltage at IT exceeds a programmed value.
- **Active:** Offhook is detected if the incoming voltage at IT exceeds a programmed value. To avoid instable information, lowpass filtering and a hysteresis is provided.
- **Ringing:** Offhook is detected if the DC-value at IT exceeds the programmed Ring Trip threshold. The AC-value is filtered automatically. Ring Trip detection is reported within 2 cycles of the ring period and then the internal ring generator is switched off within 2 cycles at zero crossing of the ring voltage.

For Ground Key information the PEB 4165 provides the longitudinal current information at the Pin IL. The PEB 3465 uses a $\Sigma\Delta$ -converter - similar to the DC-transmit path - to convert this signal to its digital representation. The accuracy is $\pm 10\%$ compared to $\pm 5\%$ of the DC-path. The 1-bit digital data stream is also down sampled and sent to the

Functional Description

PEB 31665 via the ADU-channel of the MuPP/QAP-Interface. Generation of the Ground Key bit is done in the PEB 31665 (CIDU-3: GNK; see **chapter 4.2**)

Additional Features

The PEB 3465 provides three general purpose input Pins (VA, VB, VBIM) for measuring. Via the MuPP/QAP-Interface it is possible to select one of these inputs for the measurement. The DC-signal at the selected input is converted to digital using the same $\Sigma\Delta$ -converter as for Ground Key information (accuracy of $\pm 10\%$) and sent to the PEB 31665. The input range is between $-2.4\text{ V} \dots +2.4\text{ V}$. As a further selection it is also possible to measure the internal VDDZ-voltage of the PEB 3465.

2.1.3 AHV-SLIC

The Advanced High Voltage Subscriber Line IC (AHV-SLIC) PEB 4165 is a reliable interface between the telephone line and the PEB 3465/PEB 31665.

The PEB 4165 supports AC and DC control loops based on feeding a voltage V_{RT} to the line and sensing the transversal line current I_{RT} (**figure 15**).

DC- and AC-voltages are handled separately with different gain on the AHV-SLIC. Both are applied differentially via pins DCP, DCN, and ACP, ACN, respectively. The line voltages V_R and V_T are the amplified input voltages, related to the mean supply voltage, $V_T = VTIP = (VH' - VBAT) / 2 - 25 \times VDCN - 50/16 \times VACN$

$$V_R = VRING = (VH' - VBAT) / 2 - 25 \times VDCP - 50/16 \times VACP.$$

Depending on the operation mode, VH' is switched either to VH or to $BGND$ via the supply switch. The transversal line voltage $V_{RT} = V_R - V_T$ is simply related to the input voltages

$$V_{RT} = 25 \times (VDCP - VDCN) + 50/16 \times (VACP - VACN) = 50 \times VDCP + 6.25 \times VACP$$

A reversed polarity of V_{RT} is easily obtained by changing the sign of $(VDCP - VDCN)$.

The transversal and longitudinal currents are measured in the buffers and scaled images are provided at the IT and IL pin, respectively:

$$IT = (I_R + I_{TIP})/100 = I_{RT}/50 \quad IL = -(I_R - I_{TIP})/100 = -I_{Long}/50$$

Functional Description

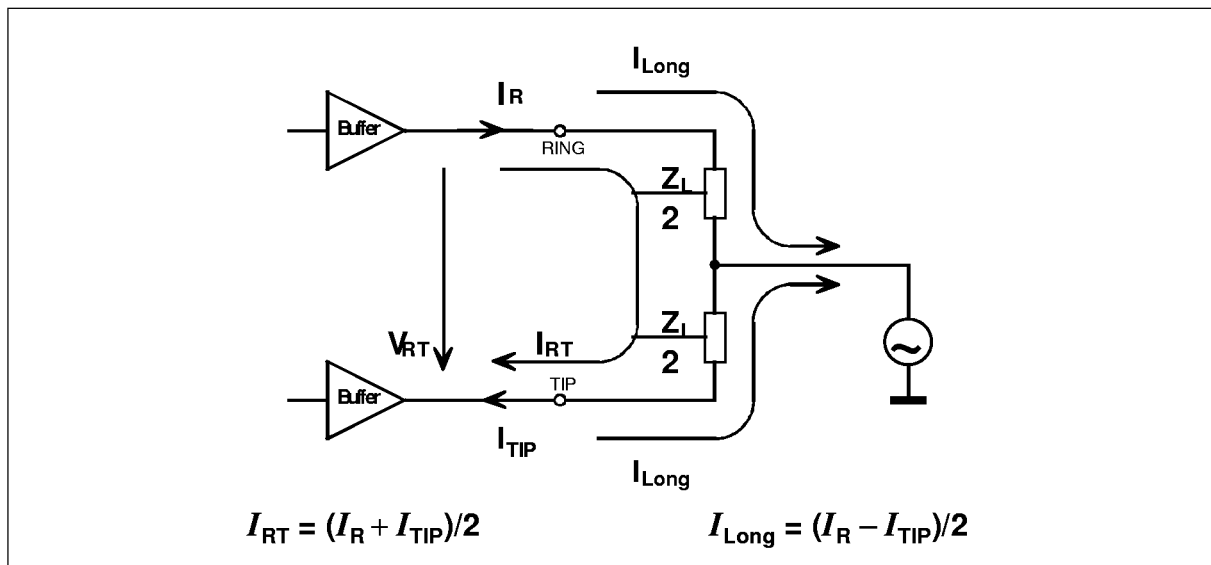


Figure 15 Definition of Output Current Directions

The PEB 4165 operates in four modes controlled by ternary logic signals at the C1 and C2 input (see **table 3**).

Table 3 Programming of Operating Modes

		C 2 (Pin 9)		
		VIL	VIM	VIH
C 1(Pin 8)	VIL	PDNH	PDNR	HIR
	VIM	PDNH	BB	HIT
	VIH	PDNH	ACT	HIRT

HIR ... Ring wire set to high impedance

HIT ... Tip wire set to high impedance

High Impedance (HIR/HIT/HIRT): In this mode each of the line outputs can be programmed to show high impedance. HIT switches off the TIP buffer, while the current through the RING output still can be measured by IT or IL. Programming HIR switches off the RING buffer. In the mode HIRT both buffers show high impedance.

Active (ACT): This is the regular transmit and receive mode for voiceband and teletax. The line driving section is operated between VBAT and BGND.

Boosted battery (BB): In order to provide a balanced ring signal of up to 85 Vrms or to drive longer telephone lines, an auxiliary positive battery voltage VH is used, enabling a higher voltage across the line. Transmission performance remains unchanged compared with ACT mode.

Functional Description

The **Power Down (PDN)** state is intended to reduce power consumption of the linecard to a minimum: the PEB 4165 is switched off completely, no operation is available.

With respect to the output impedance of TIP and RING two PDN-modes have to be distinguished:

A resistive one (PDNR) provides a connection of 10 k Ω each from TIP to BGND and RING to VBAT, respectively, while the outputs of the buffers show high impedance (**figure 16**). The current through these resistors is sensed and transferred to the IT pin to allow offhook supervision.

The other mode (PDNH) offers high impedance at TIP and RING.

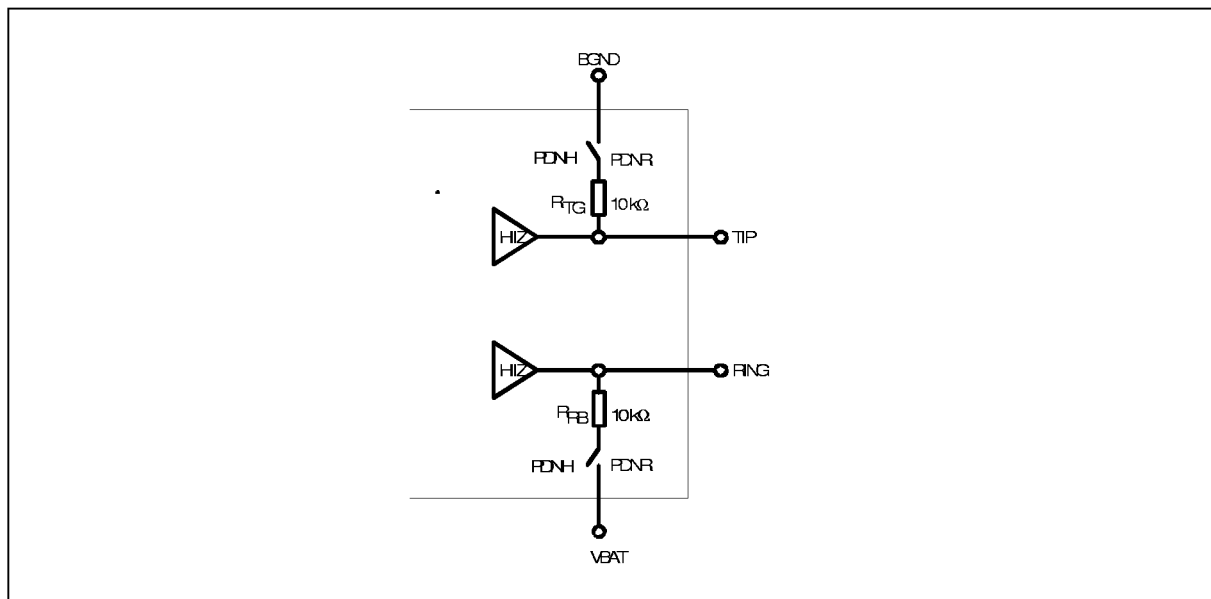


Figure 16 TIP and RING Impedance in Power Down

2.1.4 Test Features

There are two different kinds of test features: Internal test loops for circuit testing and defined test loops to perform board and line tests. There are loops for testing AC and DC path. As a special feature it is possible to switch signals to and from the DC-path via the IOM-2 Interface. Additionally there is the possibility to cut off the AC-receive and transmit path (the different kinds of testmodes are described in **chapter 8**).

3 Interfaces

3.1 IOM[®]-2 Interface

The IOM-2 Interface consists of two data lines and two clock lines. DU (data upstream) carries data from the MuSLIC to a master device. DD (data downstream) carries data from the master device to the MuSLIC. A frame synchronization clock signal (8 kHz, FSC) as well as a data clock signal (4096 kHz, DCL) has to be supplied to the MuSLIC. The MuSLIC handles data as described in the IOM-2 specification for analog devices (see **chapter 10.1**).

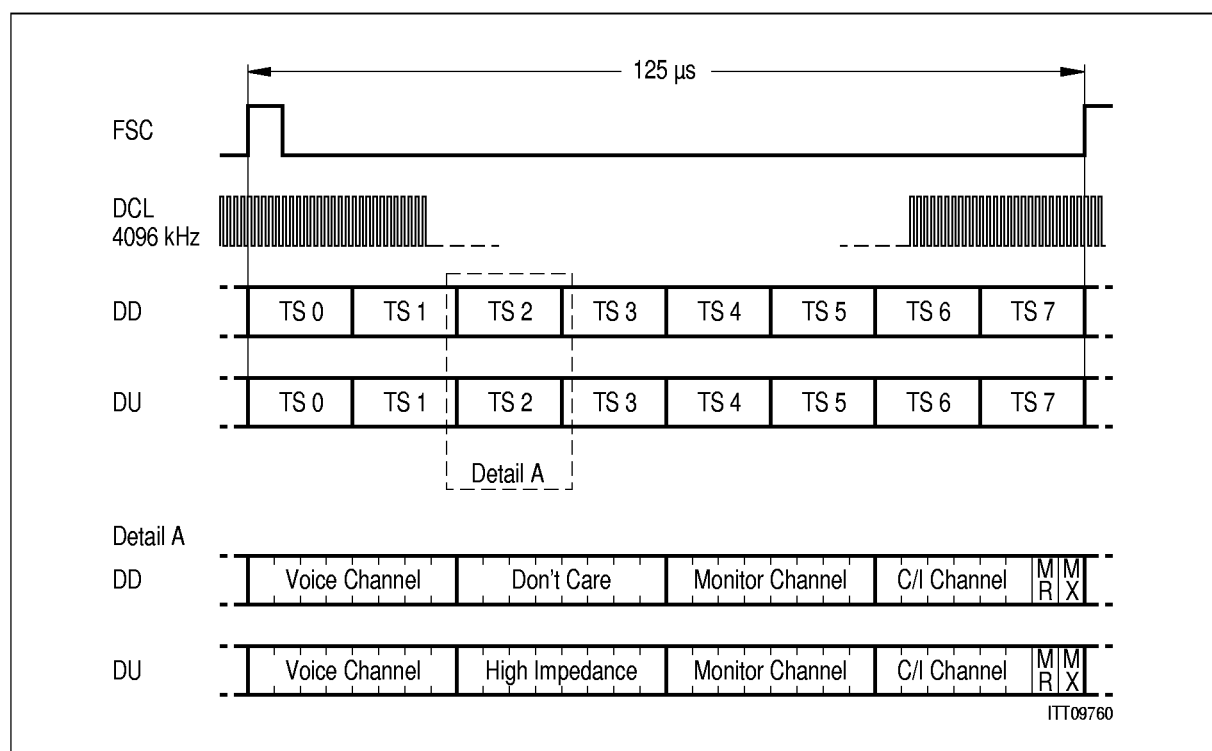


Figure 17 IOM[®]-2 Interface Timing for 8 Voice Channels (per 8 kHz frame)

Interfaces

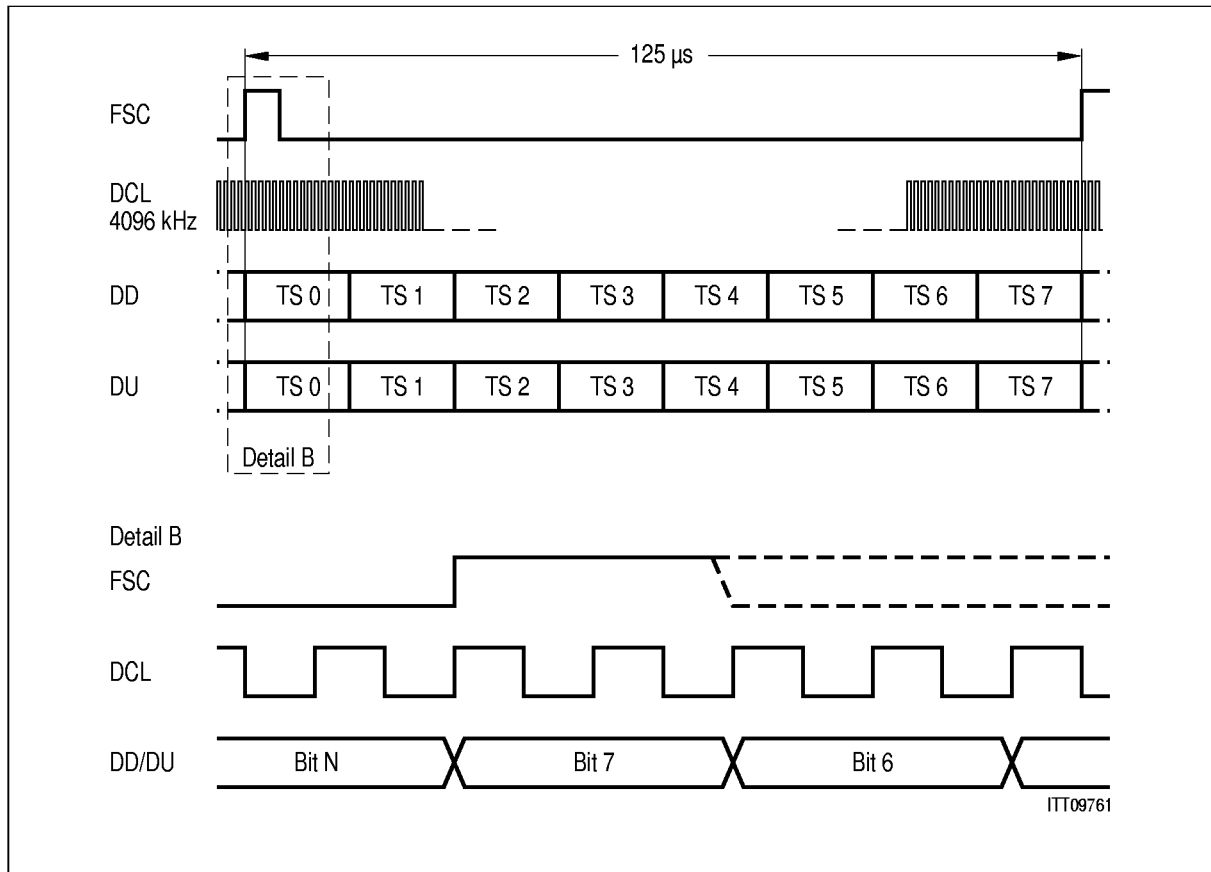


Figure 18 IOM[®]-2 Interface Timing (DCL = 4096 kHz, per 8 kHz frame)

IOM[®]-2 Time Slot Assignment

An assignment of 16 time slots is given by the two IOM-2 interfaces of the MuPP. Each of them assigns 8 time slots synchronized with the FSC. This 8 slot structure is carried on from the MuPP to the QAP. In the QAP the assignment is partly done by pin-strapping (see **figure 19**).

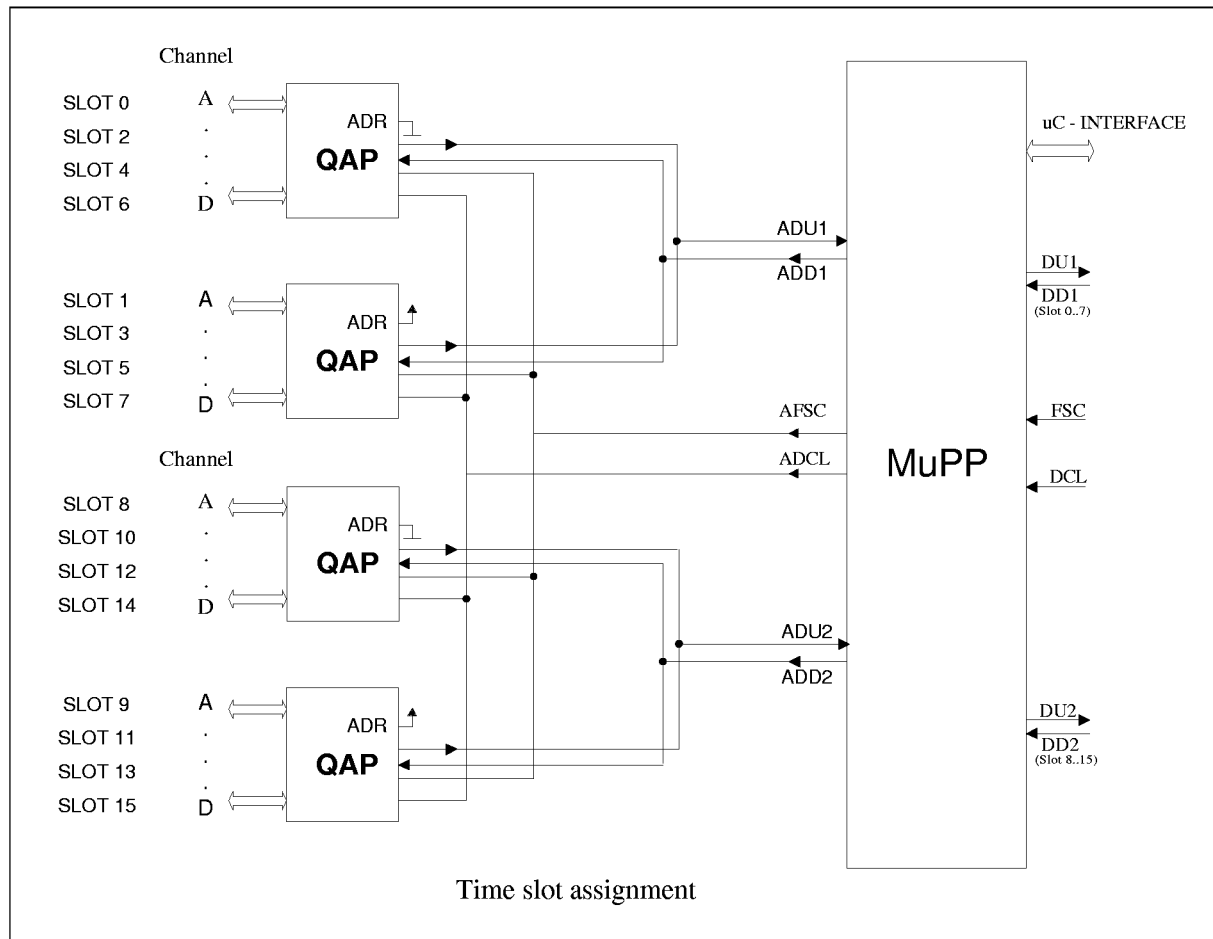


Figure 19 Time Slot Assignment

3.2 μ C Interface

The parallel μ C-Interface is used to communicate with an external master device and consists of four control lines (ALE, CSQ, RDQ, WRQ) and 8 bidirectional data lines (DIO0 ... DIO7) and provides fast parallel data transfer to a microcontroller device as an alternative to the IOM-2 monitor channel data transfer. Only one method of transfer can be used at a time, with the μ C-Interface having a higher priority than the IOM-2 Interface. Thus, data transfer via the μ C-Interface interrupts a communication via the IOM-2 monitor channel. During a data transfer cycle via the μ C-Interface, IOM-2 monitor channel data will be ignored. The C/I-channel information is still transferred via the C/I-channel of the IOM-2 interface and is not affected by the μ C-Interface communication.

The μ C-Interface of the MuPP has a multiplexed 8-bit address/data bus and allows direct connection to a microcontroller of the 8051- and the Siemens C16X-family without additional components.

With every falling edge of ALE-line the MuPP latches the bus data on the 8 data lines DIO0 ... DIO7 and stores it as address information. CSQ combined with RDQ or WRQ starts the data transfer cycle via the parallel μ C-Interface. The data on DIO0 ... DIO7 are valid on the rising edge of WRQ/RDQ (if CSQ is low). Depending on the previously latched address information, these data have a different meaning; e.g. the 8 bit of a command/data byte is preceded by the address 00000001 or the subscriber/slot address for a subsequent data byte of a e.g. SOP-, TOP-, or COPI-command has the address information 00000000 (see **table 4**).

A data transfer cycle to address 00000000 and 11111111 is already finished after the transfer of the first data byte; transfer cycles to addresses 00000001 and 00000010 consists of more transfers, depending on the length information in the first byte.

As soon as the data transfer cycle via the μ C-Interface has been completed, control information via the IOM-2 monitor channel will be accepted again (synchronized with the next FSC), until the next data transfer cycle starts with CSQ and RDQ/WRQ.

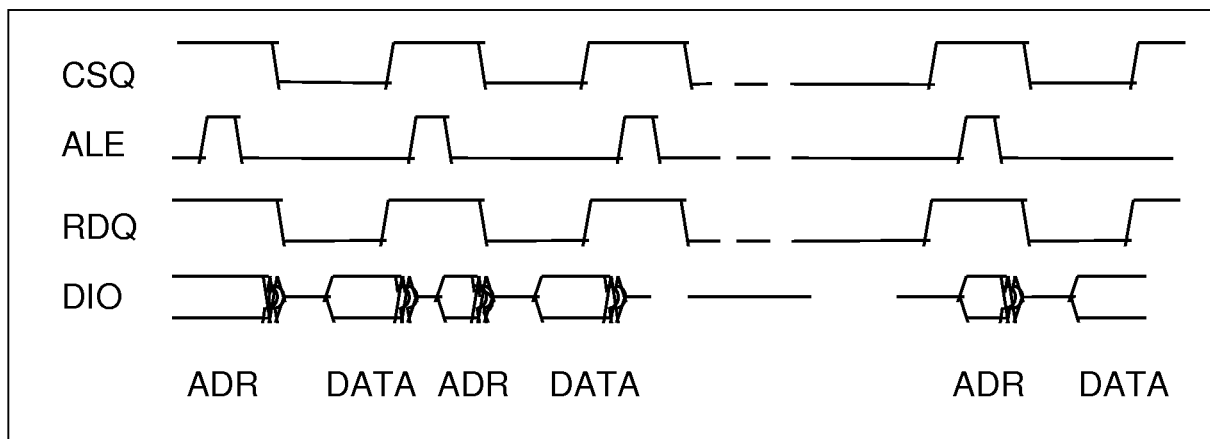


Figure 20 Example for a Read Access, with One Data Byte Transferred via DIO

Interfaces

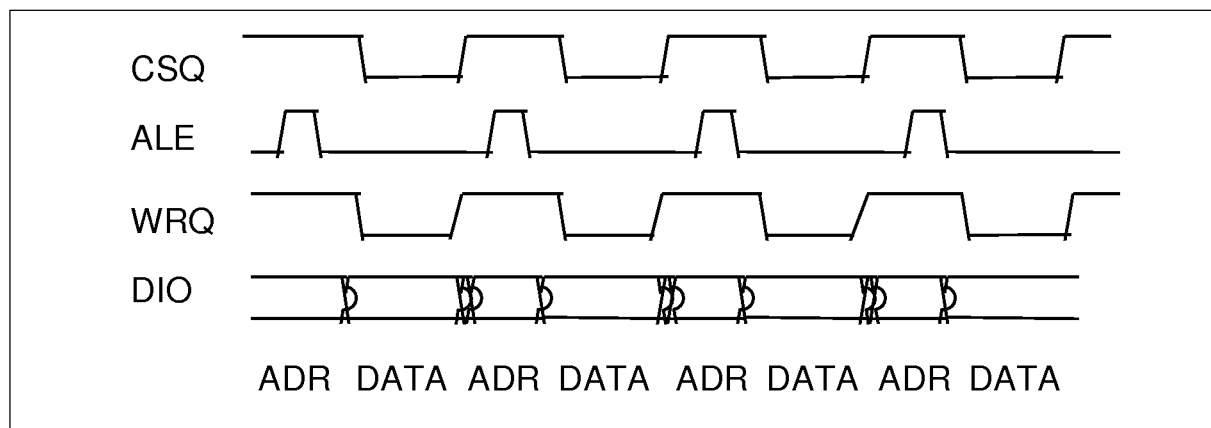


Figure 21 Example for a Write Access, With One Data Byte Transferred

Table 4 Possible Address Information to Identify the Following Data Nibbles

Address	Command
00000000	address
00000001	data
00000010	status
...	reserved
11111111	reset μ C Interface

Data transfer to and from the MuSLIC is asynchron and the data will be transferred in bytes. Basically there is no difference to the IOM-2 commands, accept those which requires a slot specific address information.

3.3 MuPP/QAP Interface

The MuPP/QAP-Interface, the link between the MuPP and the QAP, is a serial interface based on the 6 signals AFSC (analog frame sync), ADCL (analog data clock), ADU1/ADU2 (analog data upstream) and ADD1/ADD2 (analog data downstream). ADU1 and ADD1 are common to the first group of 8 time slots (channels) and ADU2 and ADD2 to the second 8 time slots (channels). AFSC and ADCL are common to both groups of time slots (timing diagram see **chapter 7.2.6**).

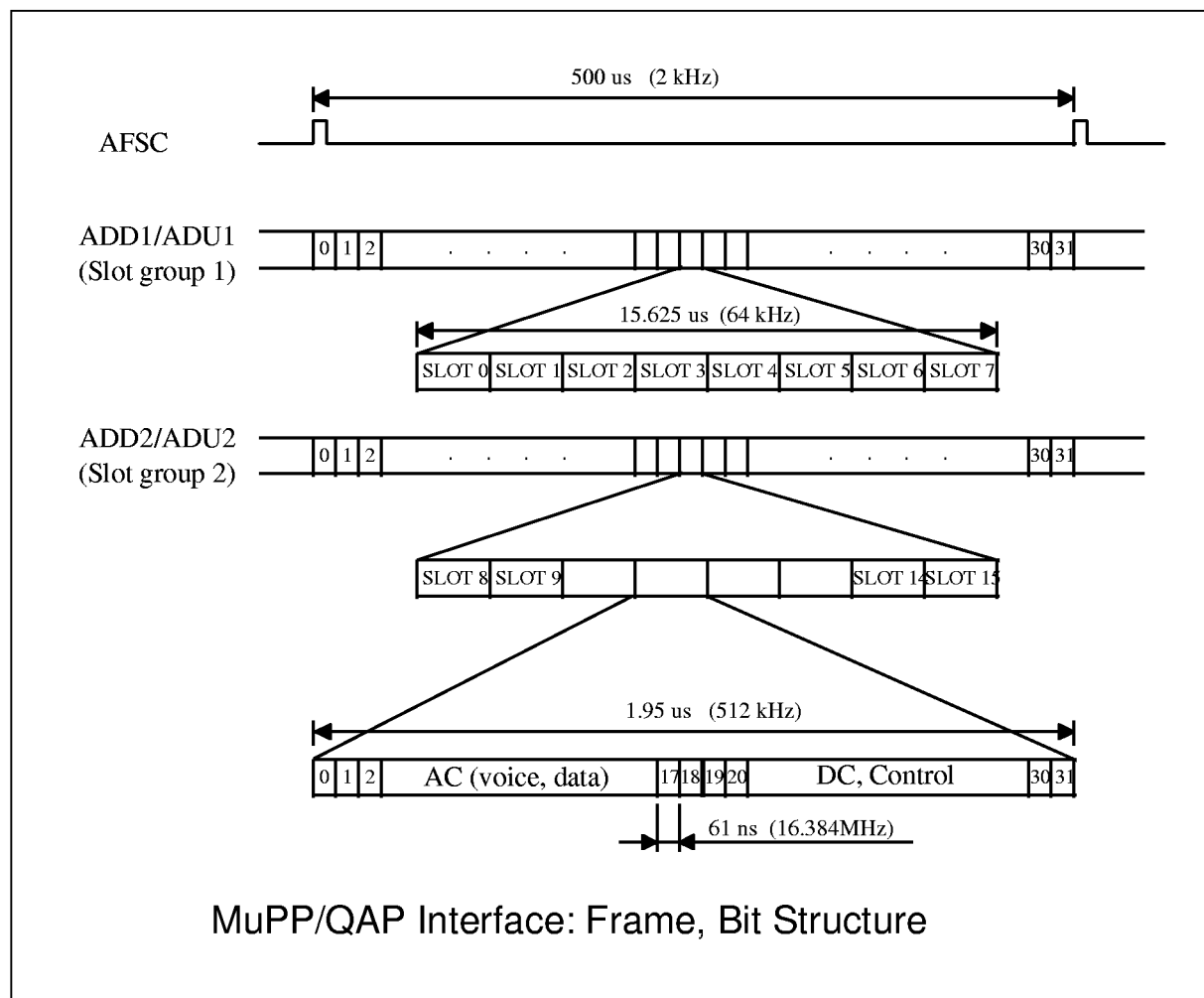


Figure 22 MuPP/QAP Interface: Frame, Bit Structure

3.4 QAP/AHV-SLIC Interface

Output Voltage AC (ACP, ACN)

The output voltage at the pins ACP and ACN represents the AC-information together with Teletax info at the receive path. The AC-information is received via the MuPP/QAP-Interface in the ADD channel. The 64-kHz Bitstream is converted to analog, passes a programmable gain stage of 0 / – 6 dB and is buffered to drive a load of $R_L > 15\text{ k}\Omega$ and $C_L < 10\text{ pF}$, which is the input impedance of the AHV-SLIC.

Output Voltage DC (DCP, DCN)

The output voltage at the pins DCP and DCN represents the DC-information together with the Ring Burst at the receive path. The DC-information is received via the MuPP/QAP-Interface in the ADD channel. The 2-kHz Bitstream is converted to analog and buffered to drive an external smoothing capacitor of 33 nF. The pins are directly connected to the AHV-SLIC.

Transversal Current Sense AC - Input (ITAC)

The pin ITAC is the input voltage pin for the AC transversal current information from the AHV-SLIC in the transmit path. AC/DC separation is done by an external highpass filter (ext. capacitor = 470 nF). The input resistance is larger than 20 k Ω . Current/voltage conversion is done via an external resistor of 1.5 k Ω (same for pin IT). The signal passes a programmable gain stage 0 or 6 dB, is converted to digital and sent to the PEB 31665 via the MuPP/QAP-Interface in the ADU channel (64-kHz Bitstream).

Transversal Current Sense DC - Input (IT)

The pin IT is the input voltage pin for the DC transversal current information from the AHV-SLIC in the transmit path. The input resistance is larger than 500 k Ω . Current/voltage conversion is done via an external resistor of 1.5 k Ω (same for pin ITAC). The voltage at Pin IT is lowpass filtered and converted to digital. The bitstream (2 kHz) is sent to the PEB 31665 via the MuPP/QAP-Interface for further signal processing.

Longitudinal Current Sense - Input (IL)

The scaled longitudinal current information transferred from the AHV-SLIC - the current/voltage conversion is done by an external resistor of 1.5 k Ω - is converted into digital and sent to the PEB 31665 via the MuPP/QAP-Interface in the ADU channel. In the PEB 31665 the IL-information is lowpass filtered (time programmable using DUPGNK-counter) and reported via the Data Upstream C/I-channel (CIDU-3) of the IOM-2 interface if the measured value exceeds a programmed limit. In Power Down, the GNK-bit is set to "0" and the setting of the Interrupt bit (CIDU-3) caused by GNK is prohibited.

Interfaces
Ternary Interface (C1, C2)

In order to set the AHV-SLIC to the different operating modes, the information of the board-controller is passed through from the IOM-2-channel via the MuPP/ QAP-Interface to the ternary AHV-SLIC-Interface pins C1 and C2.

Table 5

		C2		
		VOL	VOM	VOH
C1	VOL	PDNH	PDNR	HIR
	VOM	ACT2	BB	HIT
	VOH	ACT3	ACT	HIRT

- PNDH - Power Down High Impedance
- PDNR - Power Down Resistive
- ACT - Active Mode
- ACT2 - Active Mode 2 (power save for SLIC, for future use)
- ACT3 - Active Mode 3 (power save for SLIC, for future use)
- BB - Boosted Battery
- HIR - Ring wire set to high impedance
- HIT - Tip wire set to high impedance
- HIRT - Ring and Tip wires set to high impedance

For signalling "Over temperature" the AHV-SLIC drains a current (IOT) from pin C1. This current is sensed by the PEB 3465 and transferred in the ADU channel to the PEB 31665. The PEB 31665 sends the overtemperature message via the C/I-channel (CIDU-2: SLCX and TCR0-5) of the IOM-2 Interface. This is possible in any operating states of the AHV-Interface except for Power Down.

Programming the MuSLIC

4 Programming the MuSLIC

With the appropriate commands, the MuSLIC can be programmed and verified very flexible via the IOM-2 Interface Monitor channel, and the Microcontroller Interface respectively.

Transfer via the IOM[®]-2 Interface

Data transfer to the MuSLIC starts with a MuSLIC-specific address byte (81_H).

With the second byte one of 5 different types of commands (SOP, TOP, XOP, COP or COPI) is selected. Due to the extended MuSLIC feature control facilities these commands contain additional information (e.g. number of subsequent bytes) for programming (write) and verifying (read) the MuSLIC status.

A write command is followed by up to 8 bytes of data. The MuSLIC responds to a read command with its IOM-2 specific address and the requested information, that is up to 15 bytes of data.

Attention: Each byte of the monitor channel has to be transferred twice at least according to the IOM-2 Monitor handshake procedure. (For more information on IOM-2 specific Monitor Channel Data Structure see **chapter 3.1** and **chapter 10**).

Transfer via the Microcontroller Interface

Data transfer to and from the MuSLIC is asynchron and the data will be transferred in bytes. Basically there is no difference to the IOM-2 commands.

(For more information, about the μ C Interface see **chapter 3.2**).

4.1 Types of Monitor / μ C Interface Bytes

The 8-bit Monitor / μ C Interface bytes have to be interpreted as either commands or status information stored in Configuration Registers or the Coefficient RAMs. There are 5 different types of MuSLIC commands which are selected by bit 4 and 5 (partly bit 2 and 3) as shown below.

SOP STATUS OPERATION: MuSLIC status setting/monitoring

Bit	7	6	5	4	3	2	1	0
	B	RW	0	1	ATR	LSEL2	LSEL1	LSEL0

XOP EXTENDED OPERATION: General settings

Bit	7	6	5	4	3	2	1	0
	0	RW	1	0	ATR	LSEL2	LSEL1	LSEL0

Programming the MuSLIC

TOP TRANSFER OPERATION: Read Certain Status / Options only

Bit	7	6	5	4	3	2	1	0
	0	R	1	1	0	0	LSEL1	LSEL0

COP COEFFICIENT OPERATION: Filter coefficient setting/monitoring

Bit	7	6	5	4	3	2	1	0
	ICRAM	RW	0	0	0	1	WCRAM1	WCRAM0

COPI COEFFICIENT OPERATION INITIALIZE: Coefficient set assignment

Bit	7	6	5	4	3	2	1	0
	B	RW	0	0	1	0	LSEL1	LSEL0

Table 6 Storage of Programming Information

6 status configuration registers: (for each channel)	SCR0, ... SCR5 accessed by SOP command
2 test registers: (for each channel)	STCR0, STCR1 accessed by SOP command
9 extended configuration registers:	XR0 ... XR8 accessed by XOP command
18 extended test registers:	XTR0 ... XTR17 accessed by XOP command
2 Transfer configuration registers: (for each channel)	TCR0, TCR1 accessed by TOP command
AC- and DC-Coefficient RAMs:	CRAMs accessed by COP command
2 coefficient set assignment registers: (for each channel)	CAR0, CAR1 accessed by COPI command

Programming the MuSLIC

Overview of commands and registers via the IOM-2/μC Interface:

SOP Command

Bit	7	6	5	4	3	2	1	0
SOP for SCR/STCR	B	RW	0	1	ATR	LSEL2	LSEL1	LSEL0

SOP Configuration Registers

Bit	7	6	5	4	3	2	1	0
SCR0	POLNR	N/BB	LB	ETG2	ETG1	ENO	ENTE	COR
SCR1	TTXNO	TTX12	NOSL	SOREV	ACT3	ACT2	QIO2D	QIO1D
SCR2	VB/2M	ICONM	TEMPM	FAILM	MVAM	LSUPM	1	1
SCR3	AG6DB	LIN	LAW	COR8	0	0	0	0
SCR4	LOW Byte of DC-Offset Compensation							
SCR5	HIGH Byte of DC-Offset Compensation							
STCR0	FUSE3	FUSE2	FUSE1	FUSE0	0	0	0	0
STCR1	RSV5	RSV4	RSV3	RSV2	RSV1	RSV0	RSVU1	RSVU0

XOP Command

Bit	7	6	5	4	3	2	1	0
XOP for XR/XTR	0	RW	1	0	ATR	LSEL2	LSEL1	LSEL0

Programming the MuSLIC
XOP Configuration Registers

Bit	7	6	5	4	3	2	1	0
XR0	MIO4D	MIO3D	MIO2D	MIO1D	MIO4	MIO3	MIO2	MIO1
XR1	DUPGNK				DUP			
XR2	REXTEN	0	0	FIXC	IDR	EX-MCLK	0	0
XR3	LOW Byte of AC-CRAM checksum							
XR4	HIGH Byte of AC-CRAM checksum							
XR5	LOW Byte of AC-CRAM checksum							
XR6	HIGH Byte of AC-CRAM checksum							
XR7	ECIC1 (Byte 0 to Byte 14)							
XR8	ECIC2 (Byte 15 to Byte 29)							

Programming the MuSLIC
XOP Test Register

Bit	7	6	5	4	3	2	1	0
XTR0	HIT	HIR	ELM	SOFTON	OPIM8M	DLP03	DLP5	DISPOFI
XTR1	CAL	LMSEL1	LMSEL0	LMNOTCH	LMBP	LM2PCM	PCM2DC	ITIME
XTR2	RING-ON	DDCC	DCAD16	ERAMP	ERECT	AC-ADCPD	AC-DACPD	AFE-OFF
XTR3	DHP-X	DHP-R	TH	FRX	FRR	AX	AR	IM
XTR4	DLB-8M	DLB-64K	DLB-32K	DLB-PCM	ALB-8M	ALB-64K	ALB-8K	DCHOLD
XTR5	DC-DLB	DC-ALB	DC-ALBIT	DC-ALBIL	DC-ALBV	DCLMU2	DCLMU1	DCLMU0
XTR6	TTXL	DTTTL	NOAGC	ILITMUX	COT16	DITOFF	AXG0	ARG0
XTR7	QDETQ4	QDETQ3	QDETQ2	QDETQ1	0	0	0	0
XTR8	TQAP-FIR3	TQAP-FIR2	TQAP-FIR1	TQAP-FIR0	0	0	0	0
XTR9	Fuse QAP1				Fuse QAP2			
XTR10	Fuse QAP 3				Fuse QAP4			
XTR11	Blocktest 1							
XTR12	Blocktest 2							
XTR13	Blocktest 3							
XTR14	RSV1Q3	RSV1Q2	RSV1Q1	RSV1Q0	RSV2Q3	RSV2Q2	RSV2Q1	RSV2Q0
XTR15	RSV3Q3	RSV3Q2	RSV3Q1	RSV3Q0	RSV4Q3	RSV4Q2	RSV4Q1	RSV4Q0
XTR16	RSV5Q3	RSV5Q2	RSV5Q1	RSV5Q0	RSV6Q3	RSV6Q2	RSV6Q1	RSV6Q0
XTR17	RSVU1Q3	RSVU1Q2	RSVU1Q1	RSVU1Q0	RSVU0Q3	RSVU0Q2	RSVU0Q1	RSVU0Q0

Programming the MuSLIC
TOP Command

Bit	7	6	5	4	3	2	1	0
	0	R	1	1	0	0	LSEL1	LSEL0

TOP Configuration Registers

Bit	7	6	5	4	3	2	1	0
TCR0	VB/2	ICON	TEMP	FAIL	MVA	LSUP	RES	0

TCR1	NMVB/2	NMICON	NMTEMP	NMFAIL	NMMVA	NMLSUP	RLM1	RLM0
------	--------	--------	--------	--------	-------	--------	------	------

COP Command

Bit	7	6	5	4	3	2	1	0
	ICRAM	RW	0	0	0	1	WCRAM1	WCRAM0

	SET2	SET1	SET0	CODE4	CODE3	CODE2	CODE1	CODE0
--	------	------	------	-------	-------	-------	-------	-------

COPI Command

Bit	7	6	5	4	3	2	1	0
	B	RW	0	0	1	0	LSEL1	LSEL0

CAR Coefficient set Assignment Registers

Bit	7	6	5	4	3	2	1	0
CAR0	DC1	DC0	AC2	AC1	AC0	0	0	HLOAD

CAR1	TG1.2	TG1.1	TG1.0	TG2.2	TG2.1	TG2.0	0	0
------	-------	-------	-------	-------	-------	-------	---	---

Programming the MuSLIC

4.1.1 SOP Command

To modify or evaluate the MuSLIC status, individually for each channel, the contents of up to 6 configuration registers SCR0, ... SCR5 may be transferred to or from the MuSLIC. This is done by a SOP Command (status operation command).

With ATR = 1 and LSEL0 = 0/1 and LSEL1 = LSEL2 = 0 the registers STCR0, STCR1 can be set/read.

Bit	7	6	5	4	3	2	1	0
	B	RW	0	1	ATR	LSEL2	LSEL1	LSEL0

B Broadcast

B = 0 Only one channel (time slot) is programmed

B = 1 All channels (up to 16) are programmed with the same information

RW Read/Write Information: Enables reading from the MuSLIC or writing information to the MuSLIC

RW = 0 Write to the MuSLIC

RW = 1 Read from the MuSLIC

ATR Access Test Register

ATR = 0 SCR0 ... SCR5 Registers are available

ATR = 1 STCR0, STCR1 Registers are read/writeable

LSEL Length select information

This field identifies the number of SOP Register

ATR	LSEL 2	LSEL 1	LSEL 0	
0	0	0	0	SCR0
0	0	0	1	SCR1
0	0	1	0	SCR2
0	0	1	1	SCR3
0	1	0	0	SCR4
0	1	0	1	SCR5
0	1	1	1	SCR0 to SCR5
1	0	0	0	STCR0
1	0	0	1	STCR1

Programming the MuSLIC

SCR0 Configuration Register 0

Configuration register SCR0 defines the basic feeding modes of the MuSLIC and enables/disables test features:

Bit	7	6	5	4	3	2	1	0
	POLNR	N/BB	LB	ETG2	ETG1	ENO	ENTE	COR

Reset value: 00_H

- POLNR** Normal or Reverse Polarity (see **chapter 5.4**)
 POLNR = 0 sets the MuSLIC to Normal Polarity feeding
 POLNR = 1 sets the MuSLIC to Reverse Polarity feeding
- N/BB** MuSLIC is in normal or Boosted Battery mode (see **chapter 5.4**).
 N/BB = 0 Normal feeding
 N/BB = 1 Changes ternary interface to AHV-SLIC which sets the AHV-SLIC to Boosted Battery mode
- LB** Handling of Loop Back functions for testing PCM loops
 LB = 0 normal function
 LB = 1 the desired Loop Back function is enabled
- ETG2** Enables programmable Test Tone Generator 2
 ETG2 = 0 Test Tone Generator 2 is disabled
 ETG2 = 1 Test Tone Generator 2 is enabled
- ETG1** Enables programmable Test Tone Generator 1
 ETG1 = 0 Test Tone Generator 1 is disabled
 ETG1 = 1 Test Tone Generator 1 is enabled
- ENO** Enables Offset compensation
 ENO = 0 no DC offset compensation
 ENO = 1 DC offset compensation
- ENTE** Enables Test
 ENTE = 0 normal operation
 ENTE = 1 enables the test selected by the test registers (see **chapter 8**)
- COR** Cut Off Receive Path for test reasons (see **chapter 8**)
 COR = 0 Receive Path transmission is available
 COR = 1 Receive Path is disabled

Programming the MuSLIC

SCR1 Configuration Register 1

Configuration register SCR1 defines the meterpulse settings and the soft/hard reversal, linear mode and IO settings.

Bit	7	6	5	4	3	2	1	0
	TTXNO	TTX12	NOSL	SOREV	ACT3	ACT2	QIO2D	QIO1D

Reset value: 00_H

TTXNO Meterpulses are represented by teletax (TTX) with 12 or 16 kHz or with Reverse Polarity

TTXNO = 0 Meterpulses are represented with 12 kHz or 16 kHz

TTXNO = 1 Meterpulses are represented with Reverse Polarity

TTX12 Teletax-signal with 12 kHz or 16 kHz

TTX12 = 0 16 kHz teletax-signal

TTX12 = 1 12 kHz teletax-signal

NOSL No slope: means that the ramping of teletax (TTX) signal is switched off

NOSL = 0 Slope of TTX-Signal is smooth

NOSL = 1 Hard switch of TTX-Signal

SOREV Soft Reversal Meterpulses

SOREV = 0 hard reversal

SOREV = 1 soft reversal

ACT3 Active Mode with power save status of HV-SLIC (for future use)

ACT3 = 0 normal mode

ACT3 = 1 C1, C2 indicates the power save mode for the HV-SLIC

ACT2 Active Mode with power save status of HV-SLIC (for future use)

ACT2 = 0 normal mode

ACT2 = 1 C1, C2 indicates the power save mode for the HV-SLIC

QIO1D Direction for programmable IO - Pin of the QAP IO1

QIO1D = 0 sets the pin IO1 as an input

QIO1D = 1 sets the pin IO1 as an output

QIO2D Direction for programmable IO - Pin of the QAP IO2

QIO2D = 0 sets the pin IO2 as an input

QIO2D = 1 sets the pin IO2 as an output

Programming the MuSLIC

SCR2 Configuration Register 2

Configuration register SCR2 is the Mask register. Each bit of TCR0 (Signalling register) can be masked (except the RES bit); that means changes of such a 'masked bit' are not causing a change of the SLCX - bit (Data Upstream C/I-channel byte).

Bit	7	6	5	4	3	2	1	0
	VB/2M	ICONM	TEMPM	FAILM	MVAM	LSUPM	1	1

Reset value: FF_H

- VB/2M** Mask bit for half battery information
 VB/2M = 0 each change of the VB/2 bit leads to an interrupt (SLCX-bit)
 VB/2M = 1 changes of VB/2 bit are neglected
- ICONM** Mask bit for constant current information
 ICONM = 0 each change of the ICON bit leads to an interrupt (SLCX-bit)
 ICONM = 1 changes of ICON bit are neglected
- TEMPM** Mask bit for over temperature information
 TEMPM = 0 each change of the TEMP bit leads to an interrupt (SLCX-bit)
 TEMPM = 1 changes of TEMP bit are neglected
- FAILM** Mask bit for clock fail information
 FAILM = 0 each change of the FAIL bit leads to an interrupt (SLCX-bit)
 FAILM = 1 changes of FAIL bit are neglected
- MVAM** Mask bit for internal measurement results
 MVAM = 0 each change of the MVA bit leads to an interrupt (SLCX-bit)
 MVAM = 1 changes of the MVA bit are neglected
- LSUPM** Mask bit for line supervision
 LSUPM = 0 each change of the LSUP bit leads to an interrupt (SLCX-bit)
 LSUPM = 1 changes of the LSUP bit are neglected

Information about changing half battery- and constant current- information will be neglected on both of the Power Down and the Ringing state.

Programming the MuSLIC

SCR3 Configuration Register

Bit	7	6	5	4	3	2	1	0
	AG6DB	LIN	LAW	COR8	0	0	0	0

Reset value: 00_H

AG6DB Fixed gain in the transmit path.

AG6DB = 0 0 dB gain

AG6DB = 1 + 6 dB gain

LIN Linear mode selection (16 bit linear information in voice channel A (upper byte) and B (lower byte))

LIN = 0 PCM-mode is selected

LIN = 1 linear mode is selected

LAW PCM-law selection

LAW = 0 A-Law is selected

LAW = 1 μ -Law is selected (μ 255 PCM)

COR8 Cut off receive (voice only)

COR8 = 0 normal operation

COR8 = 1 cut off receive is enabled

SCR4 and SCR5 Configuration Register

These two registers content the DC offset bytes. They can be used one by one. Activation is controlled by the ENO bit (SCR0-2)

SCR4

Bit	7	6	5	4	3	2	1	0
	LOW Byte of DC-Offset Compensation							

Reset value: 00_H

SCR5

Bit	7	6	5	4	3	2	1	0
	HIGH Byte of DC-Offset Compensation							

Reset value: 00_H

Programming the MuSLIC
STCR0 Test Configuration Register 0

The Test Configuration register STCR0 is used for fuse operation and test only.

Bit	7	6	5	4	3	2	1	0
	FUSE3	FUSE2	FUSE1	FUSE0	0	0	0	0

Reset value: 00_H

FUSE0 to FUSE3 Information for fuse operation

STCR1 Test Configuration Register 1

The Test Configuration register STCR1 is used for reserved operations of the PEB 3465 (QAP).

Bit	7	6	5	4	3	2	1	0
	RSV5	RSV4	RSV3	RSV2	RSV1	RSV0	RSVU1	RSVU2

Reset value: 00_H

RSV0 to RSV5 from PEB 31665 to PEB 3465

RSVU0 to RSVU1 from PEB 3465 to PEB 31665

Programming the MuSLIC
4.1.2 XOP Command

To modify or evaluate test configurations, to select special functions, to control the coefficient RAMs, to get information for fusing and ECIC and other common functions up to 15 Bytes maybe transferred to or from the MuSLIC, using the XOP Command (extended operation command).

Bit	7	6	5	4	3	2	1	0
	0	RW	1	0	ATR	LSEL2	LSEL1	LSEL0

RW Read/Write Information: Enables reading from the MuSLIC or writing information to the MuSLIC

RW = 0 Write to the MuSLIC

RW = 1 Read from the MuSLIC

LSEL Length select information.

This field identifies the subsequent data bytes.

ATR	LSEL 2	LSEL 1	LSEL 0	
0	0	0	0	XR0
0	0	0	1	XR1
0	0	1	0	XR2
0	0	1	1	AC-RAM + DC-RAM Checksum
0	1	0	0	AC-RAM Checksum
0	1	0	1	DC-RAM Checksum
0	1	1	0	ECIC1 (0 to 14)
0	1	1	1	ECIC2 (15 to 29)
1	0	0	0	XTR0
1	0	0	1	XTR1 and XTR2
1	0	1	0	XTR0 to XTR8
1	0	1	1	Fuse register 0 to Fuse register 1
1	1	0	0	Blocktest 1 to Blocktest 3
1	1	0	1	XTR14 to XTR17
1	1	1	0	RESERVED
1	1	1	1	RESERVED

Programming the MuSLIC

XR0 Extended Operation Register 0

Extended Operation Register 0 defines the four IO-pins of the MuPP.

Bit	7	6	5	4	3	2	1	0
	MIO4D	MIO3D	MIO2D	MIO1D	MIO4	MIO3	MIO2	MIO1

Reset value: 00_H

MIOiD Direction for programmable IO - Pins of the MuPP IO1 to IO4

MIOiD = 0 sets the pin IOi as an input

MIOiD = 1 sets the pin IOi as an output

MIOi Value of programmable IO - Pins of the MuPP IO1 to IO4

MIOi = 0 sets the pin IOi to LOW or if it is read it is LOW

MIOi = 1 sets the pin IOi to HIGH or if it is read it is HIGH

If the bit REXTEN (XR2-7) is set to 1 (Unbalanced Ringing) the MIO1 pin is switched to the ring pulse control function. Thus a zero-crossing signal connected to the MIO1 (combined with the Ringing Mode, burst on/off) generates a correct switching signal for the ringer relay sent on QIO1 of the selected subscriber line (see **chapter 4.2** and **chapter 5.5**).

If the bit EX-MCLK (XR2-2) and TST1 pin (No.26) are set to 1 and the MIO2 pin is set as an input the MuPP is ready for external clocking (32 MHz) (the internal PLL is shut down).

If the TST1 pin (No.26) and the bit EX-MCLK (XR-2) is set to 1 and the MIO2 pin is set as an output the 32 MHz clock (output of the internal PLL) is on the MIO2 pin.

Programming the MuSLIC

XR1 Extended Operation Register 1

Extended Operation Register 1 defines the Data Upstream Persistency Counters.

Bit	7	6	5	4	3	2	1	0
	DUPGNK				DUP			

Reset value: 5A_H

DUPGNK To restrict the rate of upstream C/I-bit changes, deglitching (persistence checking) of the status information from the MuSLIC may be applied. New status information will be transmitted upstream, after it has been stable for N milliseconds. N is binary programmable in the range of 4 to 60 ms in steps of 4 ms, with DUPGNK = 0_H the deglitching is disabled.

Reset value is 20 ms.

The HOOK bit (for external indication) and the GNK bit are influenced.

(Detailed info see **chapter 4.2**, and **figure 23**.)

DUP To restrict the rate of upstream C/I-bit changes, deglitching (persistence checking) of the status information from the MuSLIC may be applied. New status information will be transmitted upstream, after it has been stable for N milliseconds. N is binary programmable in the range of 1 to 15 ms in steps of 1 ms; with DUP = 0h the deglitching is disabled.

Reset value is 10 ms.

The HOOK, SLCX and the QI1-bits are influenced (different counters but same programming).

(Detailed info see **chapter 4.2**, and **figure 23**.)

Programming the MuSLIC
XR2 Extended Operation Register 2

Extended Operation Register 2 defines basic operations for all channels.

Bit	7	6	5	4	3	2	1	0
	REXTEN	0	0	FIXC	IDR	EX-MCLK	0	0

Reset value: 10_H

REXTEN External Ringing Mode Enabled (see **chapter 5.5**)

REXTEN = 0 use internal ringing mode

REXTEN = 1 use external ringing mode

FIXC The MuSLIC uses either fixed coefficients or the programmed ones.

FIXC = 0 programmed coefficients used

FIXC = 1 fixed coefficients used

IDR Initializes Data RAM

IDR = 0 normal operation is selected

IDR = 1 content of Data RAM is set to 0 (for test purposes)

EX-MCLK Possibility to provide the MuSLIC with an external clock (see XR0)

EX-MCLK = 0 normal operation is selected

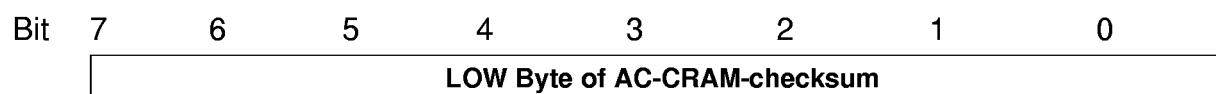
EX-MCLK = 1 internal PLL is shut down or internal clock is connected to the pin MIO2, respectively (see XR0)

Programming the MuSLIC

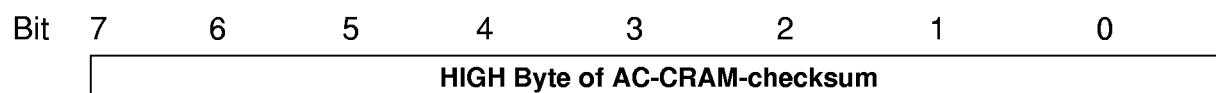
XR3 TO XR6 Extended Operation Registers 3 to 6

XR3 to XR6 are the checksums of all the Coefficient bytes written into the Coefficient RAM (CRAM) of the MuPP by the COP-Command. Reading these bytes starts the sum generation. There are two identical blocks of CRAMs (time slot 0 to 7 and 8 to 15). Each reading alternates the block access.

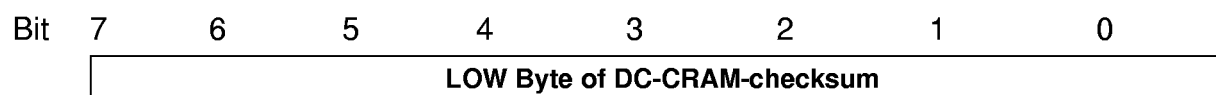
XR3



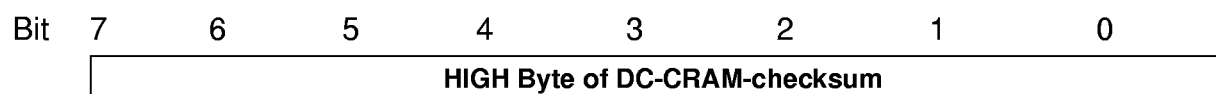
XR4



XR5



XR6



(Algorithm of defining the checksum: $x^{16} + x^{10} + x^7 + x + 1$)

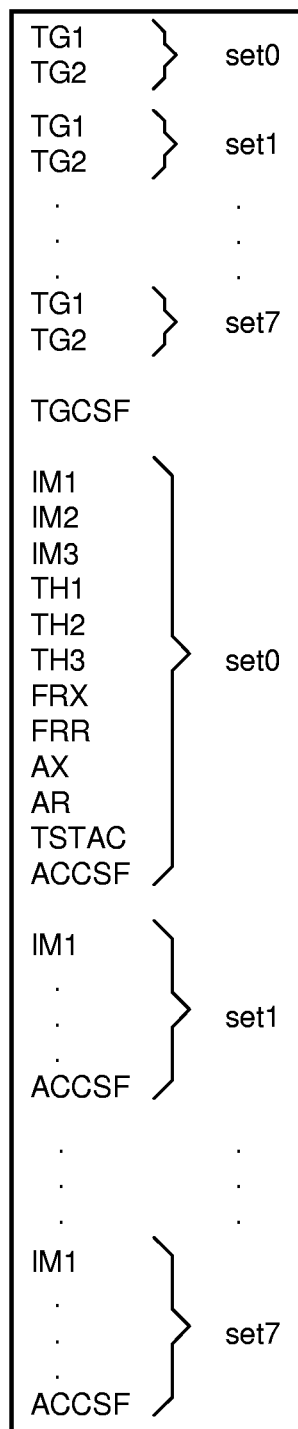
(With that algorithm you can reach a fault coverage of: $1-2^{-15}$)

Programming the MuSLIC

Sum generation is done in the following manner (see **chapter 4.1.4**)

AC-CRAM-Checksum

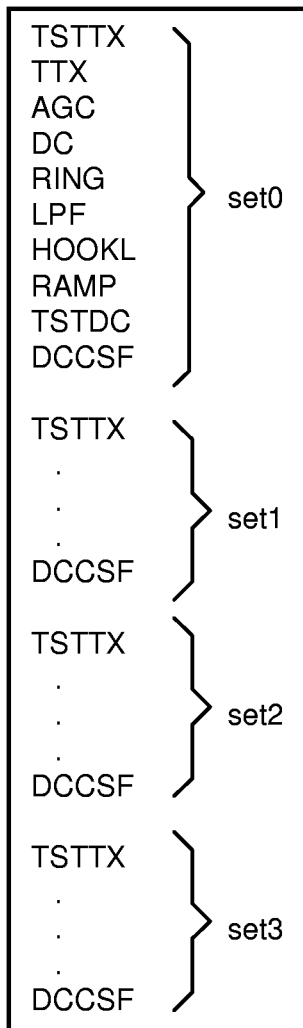
The sequence of the coefficients is:



Programming the MuSLIC

DC-RAM-Checksum

The sequence of the coefficients is:



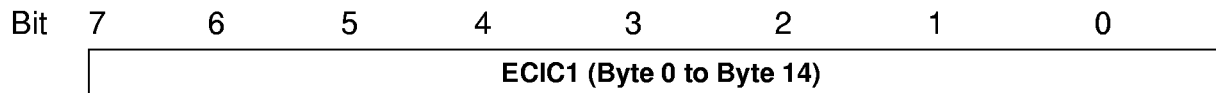
Using the “checksum fill” Bytes (TGCSF, ACCSF, DCCSF) it is possible to create a fixed set-checksum independent of changed coefficients.

Programming the MuSLIC

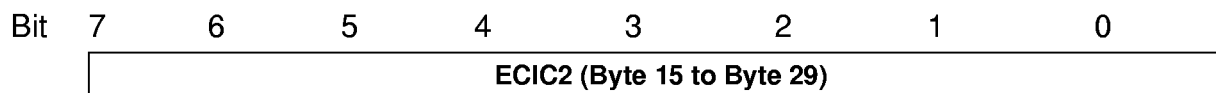
XR7 and XR8 Extended Operation Register 7 to 8

Each of these two registers feasible to read 15 bytes of design/status information generated by an external ASIC. More details about the extended IOM-2 Channel Identification see **chapter 10**.

XR7



XR8



XR7 and XR8 shows the data stream of the input pin ID0. If the input pins ID1, ID2 and ID3 = 1, ID0 works as a serial input controlled by FSC and DCL (see **chapter 10**).

Reading XR7 or XR8 15 bytes each will be transferred from ID0 to IOM-2 Interface Monitor channel.

XTR0 Extended Operation Test Register 0

Extended Operation Test Register XTR0 defines testing features.



Reset value: 00_H

HIT for AHV-SLIC test functions
 HIT = 0 normal operation
 HIT = 1 changes HV-interface (C1,C2) which set the TIP wire to high impedance

HIR for AHV-SLIC test functions
 HIR = 0 normal operation
 HIR = 1 changes HV-interface (C1,C2) which set the RING wire to high impedance

Programming the MuSLIC

ELM	Enable level meter
ELM = 0	normal operation if LM2PCM = 1 the input to the Levelmeter is switched to PCM Voice-Channel
ELM = 1	level meter function is enabled if LM2PCM = 1 the output of the Levelmeter is switched to PCM Voice-Channel
SOFTON	SW-fuses are activated in the PEB 3465
SOFTON = 0	HW-fuses are activated
SOFTON = 1	SW-fuses are activated
OPIM8M	Open fast digital Impedance Matching Loop (IM8M)
OPIM8M = 0	normal operation
OPIM8M = 1	opens fast digital IM-Loop ($H_{IM8M} = 0$)
DLP03	Disable LP03-lowpass
DLP03 = 0	normal operation
DLP03 = 1	disables programmable lowpass ($H_{LP03} = 1$)
DLP5	Disable LP5-lowpass
DLP5 = 0	normal operation
DLP5 = 1	disables programmable lowpass ($H_{LP5} = 1$)
DISPOFI	Disable Postfilter (DC path)
DISPOFI = 0	normal operation
DISPOFI = 1	disables postfilter

Programming the MuSLIC

XTR1 Extended Operation Test Register 1

XTR1 controls the level meter functions

Bit	7	6	5	4	3	2	1	0
	CAL	LMSEL1	LMSEL0	LMNOTCH	LMBP	LM2PCM	PCM2DC	ITIME

Reset value: 00_H

CAL	Enable level meter result register		
CAL = 0	normal operation (offset register - SCR4/SCR5 - is read)		
CAL = 1	levelmeter result register is read		
LMSEL	selects Levelmeter and Thresholdpairs		
LMSEL1	LMSEL0		
0	0	DC-Levelmeter Thresholdpair 0	
0	1	DC-Levelmeter Thresholdpair 1	
1	0	AC-Levelmeter	
1	1	TTX-Levelmeter	
LMNOTCH	Bandpass or Notchfilter Function for Levelmetering AC		
LMNOTCH = 0	Bandpass Function		
LMNOTCH = 1	Notchfilter Function		
LMBP	Activates the Bandpass or Notchfilter in the AC Transmit Path		
LMBP = 0	normal operation		
LMBP = 1	Bandpass/Notchfilter enabled		
LM2PCM	Switches the selected Levelmeter Signal to the PCM Voice-Channel		
LM2PCM = 0	normal operation		
LM2PCM = 1	switches the selected Levelmetersignal to the PCM Voice-Channel		
PCM2DC	switches the Receive PCM Voice-Channel to DC-Output		
PCM2DC = 0	normal operation		
PCM2DC = 1	switches the Receive PCM Voice-Channel to DC-Output		
ITIME	Integration time of AC and TTX Levelmeter		
ITIME = 0	16 ms Integrationtime		
ITIME = 1	256 ms Integrationtime		

Programming the MuSLIC

XTR2 Extended Operation Test Register 2

Extended Operation Test Register XTR2 defines testing features (see **chapter 8**).

Bit	7	6	5	4	3	2	1	0
	RING-ON	DDCC	DCAD16	ERAMP	ERECT	AC-ADCPD	AC-DACPD	AFE-OFF

Reset value: 00_H

RING-ON	Interrupt DC-characteristic and enables the Ringing Offset RING-ON = 0 normal operation RING-ON = 1 Interrupts DC-loop (HDCC = 0) and enables the Ringing Offset
DDCC	Disable DC-characteristic DDCC = 0 normal operation DDCC = 1 disables DC-loop (HDCC = 1)
DCAD16	DC gain of 16 in AD direction DCAD16 = 0 normal operation DCAD16 = 1 gain of 16
ERAMP	Enable Ramping generator ERAMP = 0 ramping generator off ERAMP = 1 ramping generator on
ERECT	Enable rectifier in DC-levelmeter ERECT = 0 normal operation (HRECT = 1) ERECT = 1 enables rectifier
AC-ADCPD	ADC is set to power down (transmit path is opened) AC-ADCPD = 0 normal operation AC-ADCPD = 1 transmit path is inactive
AC-DACPD	DAC is set to power down (receive path is opened) AC-DACPD = 0 normal operation AC-DACPD = 1 receive path is inactive
AFE-OFF	Analog front end is activated or deactivated AFE-OFF = 0 normal operation AFE-OFF = 1 the analog front end is deactivated

Programming the MuSLIC

XTR3 Extended Operation Test Register 3

Extended Operation Test Register XTR3 defines the basic MuSLIC settings which enable / disable the programmable digital filters.

Bit	7	6	5	4	3	2	1	0
	DHP-X	DHP-R	TH	FRX	FRR	AX	AR	IM

Reset value: 00_H

- DHP-X** Disable Transmit Highpass for test reasons
DHP-X = 0 Transmit Highpass Filter is enabled
DHP-X = 1 Transmit Highpass Filter is disabled
- DHP-R** Disable Receive Highpass for test reasons
DHP-R = 0 Receive Highpass Filter is enabled
DHP-R = 1 Receive Highpass Filter is disabled
- TH** Set Transhybrid Balancing Filter - together with the bit FIXC (XR2-4).
For FIXC = 1: the TH-Filter is set to H_{TH} = for Z_{BRD} ;
For FIXC = 0:
TH = 0 TH-filter is disabled
TH = 1 TH-filter is enabled (use programmed values)
- FRX** Enable FRX- (Frequency Response Transmit) Filter
For FIXC = 0:
FRX = 0 FRX-filter is disabled ($H_{FRX} = 1$)
FRX = 1 FRX-filter is enabled (use programmed values)
- FRR** Enable FRR- (Frequency Response Receive) Filter
For FIXC = 0:
FRR = 0 FRR-filter is disabled ($H_{FRR} = 1$)
FRR = 1 FRR-filter is enabled (use programmed values)
- AX** Set AX- (Amplification/Attenuation Transmit) Filter
For FIXC = 0:
AX = 0 AX-filter is set to default value ($H_{AX} = 10$ dB)
AX = 1 AX-filter is enabled (use programmed values)
- AR** Set AR- (Amplification/Attenuation Receive) Filter
For FIXC = 0:
AR = 0 AR-filter is set to default value ($H_{AR} = -15.11$ dB)
AR = 1 AR-filter is enabled (use programmed values)
- IM** Activates or deactivates the 64 kHz filter
IM = 0 64 kHz filter is deactivated ($H_{IM} = 0$)
IM = 1 64 kHz filter is activated

Programming the MuSLIC

XTR4 Extended Operation Test Register 4

Extended Operation Test Register XTR4 defines testing features.

Bit	7	6	5	4	3	2	1	0
	DLB-8M	DLB-64K	DLB-32K	DLB-PCM	ALB-8M	ALB-64K	ALB-8K	DCHOLD

Reset value: 00_H

DLB-8M	AC digital loop: 8 MHz in/output is short cut DLB-8M = 0 normal operation DLB-8M = 1 8 MHz in/output is short cut
DLB-64K	AC digital loop: 64 kHz in/output is short cut DLB-64K = 0 normal operation DLB-64K = 1 64 kHz in/output is short cut
DLB-32K	AC digital loop: 32 kHz in/output is short cut DLB-32K = 0 normal operation DLB-32K = 1 32 kHz in/output is short cut
DLB-PCM	AC digital loop: PCM in/output is short cut DLB-PCM = 0 normal operation DLB-PCM = 1 PCM in/output is short cut
ALB-8M	AC analog loop: 8 MHz in/output is short cut ALB-8M = 0 normal operation ALB-8M = 1 8 MHz short cut
ALB-64K	AC analog loop: 64 kHz in/output is short cut ALB-64K = 0 normal operation ALB-64K = 1 64 kHz in/output is short cut
ALB-8K	AC analog and digital loops: ALB-8K = 0 normal operation ALB-8K = 1 and ALB-8M = 0 8 kHz loop in the AC DSP (AC digital loop) ALB-8K = 1 and ALB-8M = 1 Pre-/Postfilter out/input is short cut (AC analog loop)
DCHOLD	Holds the current DC-Output DCHOLD = 0 normal operation DCHOLD = 1 DC-Output is held

Programming the MuSLIC

XTR5 Extended Operation Test Register 5

XTR5 defines testing functions

Bit	7	6	5	4	3	2	1	0
	DC-DLB	DC-ALB	DC-ALBIT	DC-ALBIL	DC-ALBV	DCLMU2	DCLMU1	DCLMU0

Reset value: 00_H

DC-DLB DC digital loop: 1 MHz in/output is short cut
 DC-DLB = 0 normal operation
 DC-DLB = 1 1 MHz in/output is short cut

DC-ALB DC analog loop:
 DC-ALB = 0 normal operation
 DC-ALB = 1 short cut of in/output of DC-ADC and DC-DAC

DC-ALBIT DC analog loop: IT is switched to DCP/DCN
 DC_ALBIT = 0 normal operation
 DC_ALBIT = 1 IT is switched to DCP/DCN

DC-ALBIL DC analog loop: IL is switched to DCP/DCN
 DC_ALBIL = 0 normal operation
 DC_ALBIL = 1 IL is switched to DCP/DCN

DC-ALBV DC analog loop: VA, VB, VBIM, VDDIM is switched to DCP/DCN
 DC_ALBV = 0 normal operation
 DC_ALBV = 1 VA, VB, VBIM, VDDIM is switched to DCP/DCN

DCLMU Selects the signal switched to the DC-Levelmeter

DCLMU2	DCLMU1	DCLMU0	
0	0	0	IT
0	1	0	IL
1	0	0	VA
1	0	1	VB
1	1	0	VBIM
1	1	1	VDDIM

Programming the MuSLIC
XTR6 Extended Operation Test Register 6

XTR6 defines testing functions

Bit	7	6	5	4	3	2	1	0
	TTXL	DTTXL	NOAGC	ILITMUX	COT16	DITOFF	AXG0	ARG0

Reset value: 00_H

TTXL	Enables current measurement for TTX TTXL = 0 normal operation TTXL = 1 and IM = 1 and OPIM8M=1 enables TTX current measurement
DTTXL	Analog testloop: input/output is shortcut DTTXL = 0 normal operation DTTXL = 1 input/output is shortcut t
NOAGC	disable automatic gain control for TTX NOAGC = 0 normal operation NOAGC = 1 disable automatic gain control
ILITMUX	IL changes to IT and vice versa ILITMUX = 0 normal operation ILITMUX = 1 IL changes to IT and vice versa
COT16	cut off transmit path COT16 = 0 normal operation COT16 = 1 cut off transmit path
DITOFF	Disables the dither for noisesapers DITOFF = 0 normal operation DITOFF = 1 Dither disabled
AXG0	0 dB Gain for Transmit Path AXG0 = 0 normal operation AXG0 = 1 0 dB Gain for Transmit Path
ARG0	0 dB Gain for Receive Path ARG0 = 0 normal operation ARG0 = 1 0 dB Gain for Receive Path

Programming the MuSLIC

XTR7 Extended Operation Test Register 7

XTR7 informs how many PEB 3465 are connected to the PEB 31665

Bit	7	6	5	4	3	2	1	0
	QDETQ4	QDETQ3	QDETQ2	QDETQ1	0	0	0	0

Reset value: 00_H

QDETQ4 informs about PEB 3465 connection

QDETQi = 0 there is no PEB 3465 connected to the i-th interface

QDETQi = 1 there is a PEB 3465 connected to the i-th interface

Note: This information is available after the first AFSC-pulse.

Programming the MuSLIC
XTR8 Extended Operation Test Register 8

XTR8 defines testing functions

Bit	7	6	5	4	3	2	1	0
	TQAP-FIR3	TQAP-FIR2	TQAP-FIR1	TQAP-FIR0	0	0	0	ENRSV

Reset value: 00_H

- TQAP-FIR3** Disables Noiseshaping Function for Channel 9, 11, 13, 15
TQAP-FIR3 = 0 normal operation
TQAP-FIR3 = 1 Noiseshaping Function is disabled
- TQAP-FIR2** Disables Noiseshaping Function for Channel 8, 10, 12, 14
TQAP-FIR2 = 0 normal operation
TQAP-FIR2 = 1 Noiseshaping Function is disabled
- TQAP-FIR1** Disables Noiseshaping Function for Channel 1, 3, 5, 7
TQAP-FIR1 = 0 normal operation
TQAP-FIR1 = 1 Noiseshaping Function is disabled
- TQAP-FIR0** Disables Noiseshaping Function for Channel 0, 2, 4, 6
TQAP-FIR0 = 0 normal operation
TQAP-FIR0 = 1 Noiseshaping Function is disabled
- ENRSV** Enables Reserved Registers (STCR1, XTR14 to XTR17)
ENRSV = 0 normal operation
ENRSV = 1 reserved registers are enabled

XTR9 to XTR10 Extended Operation Test Register 9 and 10

These bytes are used for the fuse operation of the PEB 3465.

XTR9

Bit	7	6	5	4	3	2	1	0
	Fuse QAP 1				Fuse QAP 2			

Reset value: 00_H

Programming the MuSLIC
XTR10

Bit	7	6	5	4	3	2	1	0
	Fuse QAP 3				Fuse QAP 4			

Reset value: 00_H

XTR11 to XTR13 Extended Operation Test Register 11 to 13

These 3 bytes show the result of the test of internal function blocks.

XTR11

Bit	7	6	5	4	3	2	1	0
	Blocktest 1							

Reset value: 00_H

XTR12

Bit	7	6	5	4	3	2	1	0
	Blocktest 2							

Reset value: 00_H

XTR13

Bit	7	6	5	4	3	2	1	0
	Blocktest 3							

Reset value: 00_H

*Note: Write XTR11 with bit 0 = 1 starts the blocktests. There are several types of tests. Selection is done by the bits 1 to 7 of XTR11 (see **chapter 8**).*

XTR14 to XTR16 Extended Operation Test Register 14 to 16

XTR14 to XTR16 are reserved for transfer of information from the PEB 31665 to the PEB 3465.

Reset value: 00_H

Programming the MuSLIC

XTR17 Extended Operation Test Register 17

XTR17 is reserved for transfer of information from the PEB 3465 to the PEB 31665.

Reset value: 00_H

4.1.3 TOP Command

With the TOP Command the TCR0 and TCR1 registers can be read. Each channel has its own registers addressed by the time slot or by address

Bit	7	6	5	4	3	2	1	0
	0	R	1	1	0	0	LSEL1	LSEL0

R Read Information: Enables reading from the MuSLIC

R = 0 No operation

R = 1 Read from MuSLIC

LSEL Length select information

This field identifies the number of the TCR Register and the handling of interrupts too.

LSEL 1 LSEL 0

0 0 TCR0 (Reset of the interrupt)

0 1 TCR1 (Not masked interrupts are not affected)

1 1 TCR0 and TCR1 (Reset of the interrupt)

Programming the MuSLIC

TCR0 Configuration Register 0

TCR0 is the Signalling register. It indicates status information of each channel. If there is any change of one or more bits it is indicated via the SCLX bit in the C/I-channel. Each bit, except the RES bit, can be masked by the SCR2 Register (see also **figure 23**).

Bit	7	6	5	4	3	2	1	0
	VB/2	ICON	TEMP	FAIL	MVA	LSUP	RES	0

Reset value: 02_H

VB/2	Half battery voltage is detected interrupt masked in Power Denial and Ringing State VB/2 = 0 line voltage smaller than half battery VB/2 = 1 line voltage larger than half battery
ICON	Current limitation information interrupt masked in Power Denial and Ringing State ICON = 0 Resistive Feeding ICON = 1 Constant Current Feeding
TEMP	Temperature alarm of the AHV-SLIC which is signalled through the HV-SLIC Interface (see chapter 3.4) TEMP = 0 normal temperature TEMP = 1 Temperature alarm from AHV-SLIC detected
FAIL	DCL or FSC Fail: Not the right count of clock cycles between two frame syncs FAIL = 0 no clock fails are detected FAIL = 1 clock fails are detected The FAIL bit is not influenced by the DUP-counter (each failure is reported).
MVA	Internal measurement results shown in the TCR1-0 and TCR1-1 are valid or not valid (see chapter 8) MVA = 0 the level metering results are not valid MVA = 1 the level metering results are valid
LSUP	Line Supervision (of broken line) LSUP = 0 the transversal current is higher than the programmed level LSUP = 1 the transversal current is lower than the programmed level
RES	Reset status RES = 0 no Reset has occurred RES = 1 Reset has occurred via Reset-pin or via Power on Reset

Programming the MuSLIC

Any change of these bits (except the FAIL bit: only the positive going is reported) is signalled via the interrupt-bit (SLCX) in the C/I-DU-channel. There are two types of generating an interrupt:

- Each toggling of a non-masked TCR0-bit combined with a DUP-counter
- Toggling of the non-masked TEMP or MVA-bit and positive going FAIL bit (no filtering by the DUP-counter)

The status information is stored in the TCR0-register and an interrupt is generated but only if there isn't a not-handled interrupt.

Reading the TCR0-register gives the frozen interrupt status, clears the interrupt and enables the signalling of a further interrupt but not until after at least two 8 kHz frames.

*Note: The HOOK and the GNK signalling are directly filtered by there own DUP(GNK)-counters and they are directly put into the C/I-DU-channel (see **chapter 4.2**).*

TCR1 Configuration Register 1

TCR1 indicates interrupt information and level meter results of one channel.

Bit	7	6	5	4	3	2	1	0
	NMVB/2	NMICON	NMTEMP	NMFAIL	NMMVA	NMLSUP	RLM1	RLM0

Reset value: 00_H

NMVB/2 to NMLSUP Not masked signalling information. (The meaning of each bit is the same as described above.)
Reading this register won't affect any stored information.

RLM1 and RLM0 Result Level Metering

RLM1	RLM0	
0	0	below both levels
x	1	above level 0
1	x	above level 1

Programming the MuSLIC

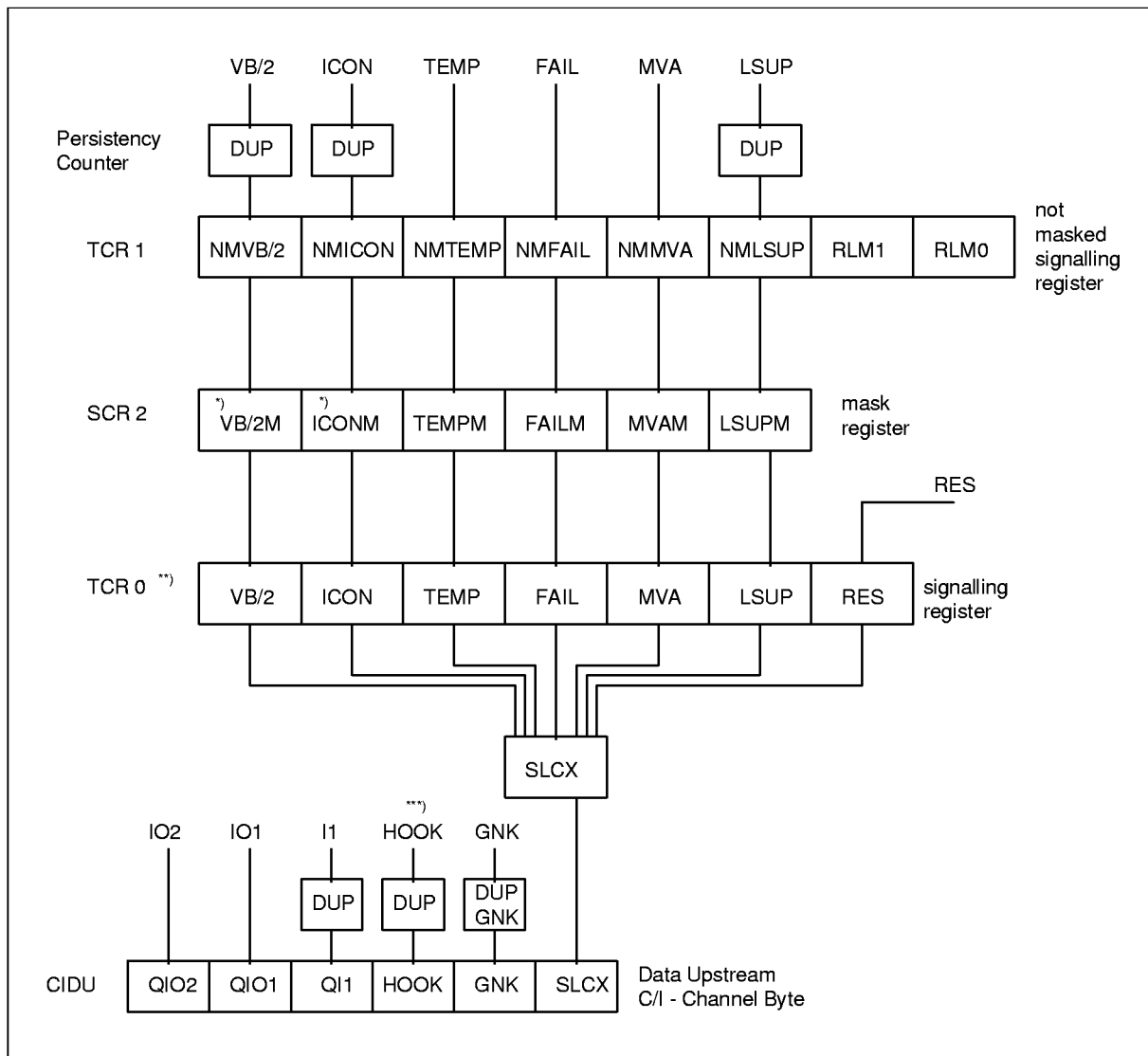


Figure 23 Interrupt Logic (block structure)

- 1) In Power Down and Ringing Mode changes of VB/2 and ICON are masked.
- 2) TCR0 is locked if one of the signals changes and is enabled after reading.
Each change of TCR0 sets the interrupt bit SLCX to 1.
Reading TCR0 sets SLCX to 0 but not before two 8 kHz frames.
A take over of the signal FAIL from TCR1 to TCR0 clears this signal in TCR1.
- 3) In Power Down Mode the persistency counter DUPGNK is used.

Programming the MuSLIC

4.1.4 COP Command

With a COP Command coefficients for the programmable filters can be written to or read from the MuSLIC (write access is only allowed if FIXC = 1 or to an unused SET).

(Filter optimizing to different applications is supported by the software package MuSLICOS.)

The coefficients are gathered to 8 and 4 SETS respectively. So an optimum is reached between supplying each channel, handling and memory space. **Figure 24** gives an overview of the Coefficient RAM structure.

To assign a SET to a channel the COPI command is used.

Bit	7	6	5	4	3	2	1	0
	ICRAM	RW	0	0	0	1	WGRAM1	WGRAM0

Bit	7	6	5	4	3	2	1	0
	SET2	SET1	SET0	CODE 4	CODE 3	CODE 2	CODE 1	CODE 0

ICRAM Initialize CRAM
 ICRAM = 0 Only one coefficient is programmed (destination is coded in the following byte)
 ICRAM = 1 the whole AC- or DC-CRAM is written with the information of the following byte

RW Read/ Write
 RW = 0 Subsequent data is written to the MuSLIC
 RW = 1 Read data from the MuSLIC

WGRAM1 and WGRAM0 Write to CRAM (only valid in combination with ICRAM=1)

WGRAM1	WGRAM0	
0	0	no write
0	1	AC-CRAM
1	0	DC-CRAM
1	1	AC-CRAM and DC-CRAM

Programming the MuSLIC

SET	includes the number of coefficient set			
	SET2	SET1	SET0	
	0	0	0	SET 0
	0	0	1	SET 1
	0	1	0	SET 2
	0	1	1	SET 3
	1	0	0	SET 4
	1	0	1	SET 5
	1	1	0	SET 6
	1	1	1	SET 7
SET 0 to SET 7	for the 8 sets of AC-coefficients and the 8 sets of Tone Generator 1 and 2			
SET 0 to SET 3	for the 4 sets of DC-coefficients			

Programming the MuSLIC

CODE includes the number of following bytes and filter-addresses¹⁾

CODE4	CODE3	CODE2	CODE1	CODE0		
0	0	0	0	0	TH-Filter coefficients (part 1)	(followed by 8 bytes of data)
0	0	0	0	1	TH-Filter coefficients (part 2)	(followed by 8 bytes of data)
0	0	0	1	0	TH-Filter coefficients (part 3)	(followed by 8 bytes of data)
0	0	0	1	1	FRX-filter coefficients	(followed by 8 bytes of data)
0	0	1	0	0	FRR-filter coefficients	(followed by 8 bytes of data)
0	0	1	0	1	AX-filter coefficients	(followed by 8 bytes of data)
0	0	1	1	0	AR-filter coefficients	(followed by 8 bytes of data)
0	0	1	1	1	TG1-filter coefficients	(followed by 8 bytes of data)
0	1	0	0	0	TG2-filter coefficients	(followed by 8 bytes of data)
0	1	0	0	1	AC test coefficients	(followed by 8 bytes of data)
0	1	0	1	0	IM-filter coefficients (part 3)	(followed by 8 bytes of data)
0	1	0	1	1	IM-filter coefficients (part 1)	(followed by 8 bytes of data)
0	1	1	0	0	IM-filter coefficients (part 2)	(followed by 8 bytes of data)
0	1	1	0	1	TG CSF (checksum fill)	(followed by 8 bytes of data)
0	1	1	1	0	AC CSF (checksum fill)	(followed by 8 bytes of data)
1	0	0	0	0	TTX test coefficients	(followed by 8 bytes of data)
1	0	0	0	1	TTX coefficients	(followed by 8 bytes of data)
1	0	0	1	0	AGC coefficients	(followed by 8 bytes of data)
1	0	0	1	1	LP-filter coefficients	(followed by 8 bytes of data)
1	0	1	0	0	Hook level coefficients	(followed by 8 bytes of data)
1	0	1	0	1	DC test coefficients	(followed by 8 bytes of data)
1	0	1	1	0	Ringin coefficients	(followed by 8 bytes of data)
1	0	1	1	1	DC-characteristic coefficients	(followed by 8 bytes of data)
1	1	0	0	0	Ramp generator, Ringer delay coefficients	(followed by 8 bytes of data)
1	1	0	0	1	DC CSF (checksum fill)	(followed by 8 bytes of data)

¹⁾ For generating a correct checksum all not used bits must be set to 0.

Programming the MuSLIC

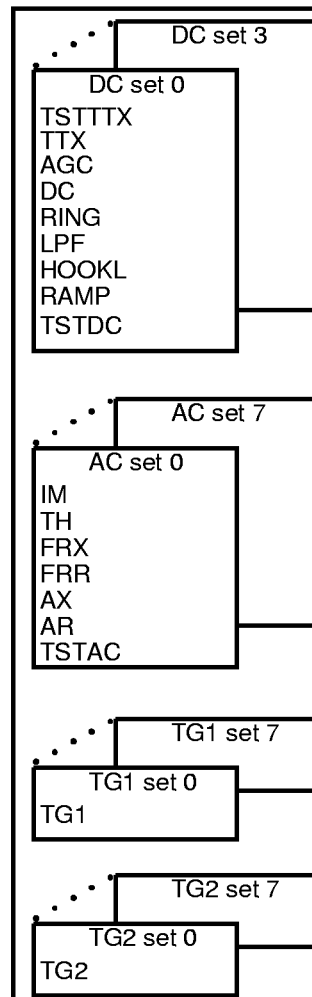


Figure 24 Overview of Sets of Coefficients

Programming the MuSLIC

4.1.5 COPI Command

The COPI command allows to assign the sets of the Coefficient RAMs to a selected channel (given by the time slot or by address).

Bit	7	6	5	4	3	2	1	0
	B	RW	0	0	1	0	LSEL1	LSEL0

B Broadcast
 B = 0 Only one channel (time slot) is programmed
 B = 1 All channels (up to 16) are programmed with the same information

RW Read/ Write
 RW = 0 Subsequent data is written to the MuSLIC
 RW = 1 Set assignment is read

LSEL Length select information.
 This field identifies the subsequent data bytes.

LSEL 1	LSEL 0	
0	0	CAR0
0	1	CAR1
1	1	CAR0 and CAR1

Programming the MuSLIC

CAR0 Coefficient set Assignment Register 0

CAR0 indicates AC and DC coefficients set assignment.

Bit	7	6	5	4	3	2	1	0
	DC1	DC0	AC2	AC1	AC0	0	0	HLOAD

Reset value: 00_H

DC

DC1	DC0	
0	0	DC coefficient set 0
0	1	DC coefficient set 1
1	0	DC coefficient set 2
1	1	DC coefficient set 3

AC

AC2	AC1	AC0	
0	0	0	AC coefficient set 0
0	0	1	AC coefficient set 1
0	1	0	AC coefficient set 2
0	1	1	AC coefficient set 3
1	0	0	AC coefficient set 4
1	0	1	AC coefficient set 5
1	1	0	AC coefficient set 6
1	1	1	AC coefficient set 7

HLOAD

Hook for Load

HLOAD = 0 normal operation

HLOAD = 1 load is activated (LP03 will be preset)

Programming the MuSLIC
CAR1 Coefficient set Assignment Register 1

CAR1 indicates Tone Generator coefficients set assignment.

Bit	7	6	5	4	3	2	1	0
	TG1.2	TG1.1	TG1.0	TG2.2	TG2.1	TG2.0	0	0

Reset value: 00_H

TG1

TG1.2	TG1.1	TG1.0	
0	0	0	Tone Generator 1 set 0
0	0	1	Tone Generator 1 set 1
0	1	0	Tone Generator 1 set 2
0	1	1	Tone Generator 1 set 3
1	0	0	Tone Generator 1 set 4
1	0	1	Tone Generator 1 set 5
1	1	0	Tone Generator 1 set 6
1	1	1	Tone Generator 1 set 7

TG2

TG2.2	TG2.1	TG2.0	
0	0	0	Tone Generator 2 set 0
0	0	1	Tone Generator 2 set 1
0	1	0	Tone Generator 2 set 2
0	1	1	Tone Generator 2 set 3
1	0	0	Tone Generator 2 set 4
1	0	1	Tone Generator 2 set 5
1	1	0	Tone Generator 2 set 6
1	1	1	Tone Generator 2 set 7

Programming the MuSLIC

4.2 IOM[®]-2 Interface Command / Indication Byte

The Command/Indication (C/I) channel is used to communicate real time status information and for fast controlling of the MuSLIC. Data on the C/I channel are continuously transmitted in each frame until new data is sent.

Data Downstream C/I - Channel Byte (receive) - CIDD

This Byte is used for fast controlling of the MuSLIC. Each transfer to the MuSLIC has to last for at least 2 consecutive frames (FSC-cycles) so that it is accepted internally. Changes (spikes) of less than 2 FSC cycles are neglected.

(Note that there is no address DD direction because there is only one MuPP.)

Bit	7	6	5	4	3	2
	QIO2	QIO1	QO1	M2	M1	M0

M0, M1, M2 these bits define the actual status; see table below (for details see chapter 5)

M2	M1	M0	Description
0	0	0	Power-Down High Impedance (loop open, PDNH)
1	1	1	Power-Down Resistive (loop open, PDNR)
0	1	0	Active State
1	1	0	Active State with Meterpulses
1	0	0	Ground Start
0	0	1	Ringling State (ring pause)
1	0	1	Ringling State (ring burst on)

QO1 Value for the fixed Output Pin O1 of the QAP.

QO1 = 0 The corresponding pin at the digital interface of the QAP is set to a logic 0.

QO1 = 1 The corresponding pin at the digital interface of the QAP is set to a logic 1.

Note: The Output Pin O1 of the QAP is tristate after reset and will be enabled by the first SOP command.

Programming the MuSLIC

- QIO1** Value for the programmable Input/Output Pin IO1 of the QAP if programmed as an output pin. If the bit REXTEN (XR2-7) is set to 1 (external ringing) the internally created Ring Burst On Signal (for an external relay driver) **chapter 5.5)**
- QIO1 = 0 The corresponding pin at the digital interface of the QAP is set to a logic 0.
- QIO1 = 1 The corresponding pin at the digital interface of the QAP is set to a logic 1.
- QIO2** Value for the programmable Input/Output Pin IO2 of the QAP if programmed as an output pin.
- QIO2 = 0 The corresponding pin at the digital interface of the QAP is set to a logic 0.
- QIO2 = 1 The corresponding pin at the digital interface of the QAP is set to a logic 1.

Data Upstream C/I - Channel Byte (transmit) - CIDU

This Byte is used for fast transfer of the most important and time critical informations from the MuSLIC. Each transfer from the MuSLIC lasts for at least 2 consecutive frames.

(Note that there is no address in DU direction too.)

Bit	7	6	5	4	3	2
	QIO2	QIO1	QI1	HOOK	GNK	SLCX

- SLCX** Interrupt bit: Summary output of the whole signalling register (TCR0).
- SLCX = 0 No unmasked bit in the signalling register has toggled.
- SLCX = 1 Any unmasked bit in the signalling register has toggled.
- GNK** Indication if a ground connection is detected (filtered via the DUPGNK-counter). The function is disabled in Power Down State (GNK is set to 0).
- GNK = 0 No ground connection was detected.
- GNK = 1 Ground connection was detected.
- HOOK** Indication of the loop condition (filtered via the DUP-counter or the DUPGNK-counter in Power Down State).
- HOOK = 0 Subscriber is Onhook.
- HOOK = 1 Subscriber is Offhook.
- QI1** Logical state of the Input Pin I1 of the QAP.
- QI1 = 0 The corresponding pin at the digital interface of the QAP is receiving a logic 0.
- QI1 = 1 The corresponding pin at the digital interface of the QAP is receiving a logic 1.

Programming the MuSLIC

- QIO1** Logical state of the programmable Input/Output Pin IO1 of the QAP - even if not programmed as an input pin. ¹⁾
- QIO1 = 0 The corresponding pin at the digital interface of the QAP is receiving a logic 0.
- QIO1 = 1 The corresponding pin at the digital interface of the QAP is receiving a logic 1.
- QIO2** Logical state of the programmable Input/Output Pin IO2 of the QAP - even if not programmed as an input pin.
- QIO2 = 0 The corresponding pin at the digital interface of the QAP is receiving a logic 0.
- QIO2 = 1 The corresponding pin at the digital interface of the QAP is receiving a logic 1.

¹⁾ If the Input/Output Pin is programmed as an output the corresponding bit in the CIDU is "1".

The DUP- (DUPGNK-)counters filter the status-information and the input I1. The counters count down and generate enable signals for the registers if they are zero. Then they start counting again at the programmed value. If a status information or the input signal changes the proper counter is set and continues counting down. There are DUP-counters for HOOK, VB/2, ICON, LSUP generating SLCX and the input pin I1 and one DUPGNK-counter for HOOK in Power Down mode or for GNK in all other modes. Changing the mode freezes the actual status of HOOK and sets the actual HOOK-counter.

Operating Modes
5 Operating Modes

The MuSLIC supports 3 different Operating Modes: Power Down (PDown), Active and Ringing which are controlled via the lower 3 bits of the Data Downstream C/I Channel Byte (CIDD).

Table 7

M2 (CIDD-4)	M1 (CIDD-3)	M0 (CIDD-2)	Description
0	0	0	Power-Down High Impedance (PDNH)
1	1	1	Power-Down Resistive (PDNR)
0	1	0	Active State
1	1	0	Active State with Meterpulses
1	0	0	Active State with Ground Start
0	0	1	Ringing State (ring pause)
1	0	1	Ringing State (ring burst on)

Operating Modes

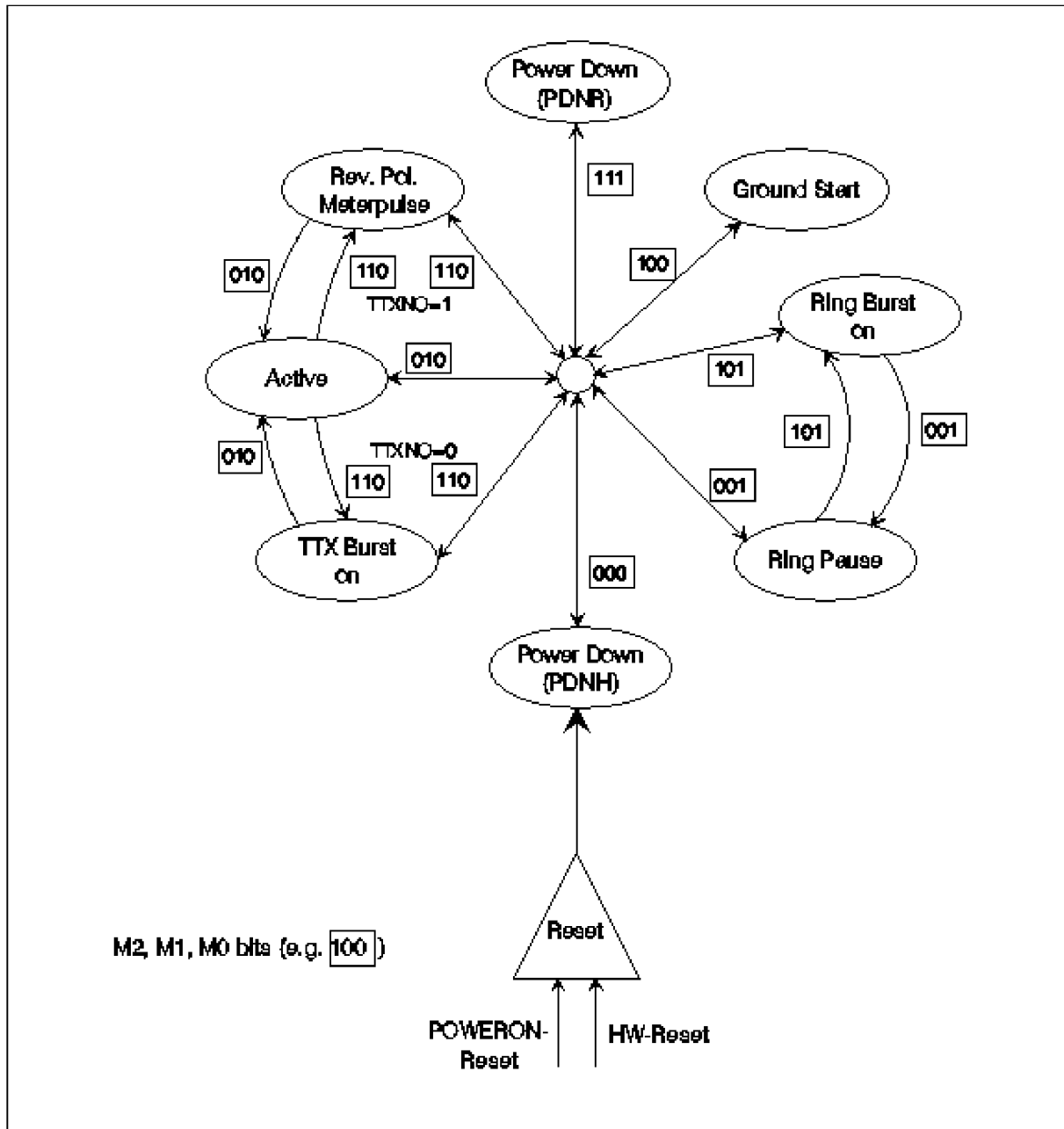


Figure 25

Operating Modes

Table 8 Operating Modes and the Ternary HV-Interface

MuPP							QAP						AHV-SLIC						
							C1			C2			C1			C2			
M2 (CIDD-4)	M1 (CIDD-3)	M0 (CIDD-2)	Description	BB (SCR0-6)	HIT (XTR0-7)	HIR (XTR0-6)	VOL	VOM	VOH	VOL	VOM	VOH	VIL	VIM	VIH	VIL	VIM	VIH	Description
0	0	0	Power Down High Impedance (PDNH)	0	0	0	X			X					(X)	X			PDNH (also for not used combinations)
1	1	1	Power Down Resistive (PDNR)	0	0	0	X				X					X			PDNR
0	1	0	Active State	0	0	0			X		X				X		X		ACT
1	1	0	Active State with Meterpulses	0	0	0			X		X				X		X		ACT
1	0	0	Active State with Ground Start	0	0	0	X								X			X	HIT
0	0	1	Ringing State (ring pause)	0	0	0	X				X				X		X		BB
1	0	1	Ringing State (ring burst on)	0	0	0	X				X				X		X		BB
0	1	0	Every Active State	1	0	0	X				X				X		X		BB
1	1	0																	
0	1	0	For testing only; Active State with or without Meterpulses	0	1	0	X								X			X	HIT
1	1	0																	
0	1	0	For testing only; Active State with or without Meterpulses	0	0	1	X										X	X	HIR
1	1	0																	
0	1	0	For testing only; Active State with or without Meterpulses	0	1	1			X									X	HIRT

Operating Modes

5.1 Reset Behavior

The MuSLIC has 2 different reset sources that are internally connected.

The **Reset pins**,
which work totally asynchronously to the external clocks.

Power On Reset.

If internal VDD gets above typ. 2.33 V the MuPP is reset by Power On Reset.

Both sources set the MuSLIC to the basic setting modes (see below).

After a reset caused by any of the sources mentioned above, the reset bit (TCR0-1 = RES) is set to one and the SLCX-interrupt (CIDU-2) is set. Reading the TCR0 register clears the interrupt and the RES-bit.

The Reset pin (RESET) of the MuPP and the QAP has a Schmitt-Trigger input to reduce the sensitivity for spikes. In addition the pin RESET has a spike rejection. All spikes smaller than typ. 70 ns are neglected. The pin RESET can be set to 1 for an unlimited time but at least 2 μ s is recommended; during that, the DU pin is set to high impedance. The μ C-IO pins are set as inputs.

In the MuPP a reset activates the reset routine - but only if the DCL is present - which lasts at least two 2 kHz frame (AFSC) periods for setting the default values. After this time and if an external reset is not active (RESET = 0) the MuPP starts the normal (default) operation at the beginning of the next 8 kHz frame (FSC).

In the QAP a reset works totally asynchronously and no reset routine is necessary.

The normal (default) operation of the QAP starts at the beginning of a 2 kHz frame (ASFC) if the external reset (RESET = 0) is released.

5.2 Basic Setting Modes

After RESET, the MuSLIC is switched automatically to its basic settings in which internal default values for all filters and settings (AC and DC) are used. The whole module works in a kind of "emergency mode" and can be handled by the C/I-Interface commands only. This means that for an (un-)determined reset (e.g. Power On Reset) the MuSLIC is reset, but can be switched to or return automatically into any operating mode presented by the C/I-channel after 2 AFSC + 2 FSC cycles. In all modes the outputs (QO_i) become tristate up to the first SOP Command, the I/Os (MIO_i, QIO_i) become inputs, supervision and DC-feeding are still working and conversation can go on in a proper way until all filters and settings have been reloaded by SOP, XOP and COP Commands.

Actions initialized by a reset:

- All configuration registers are set to their default values (note that the Coefficient RAM is **not** reset)
- The RES-bit (TCR0-1) is set to 1 to indicate that a reset has taken place
- The IOM-2 and the μ C-interface is reset. Running communication is stopped
- DU is in high impedance state
- AC- and DC-loop use the default values and not the programmed ones (see below)

Operating Modes
Table 9

DC			
Const I	24	mA	Limit for Constant Current
Const V	38	V	Limit for Constant Voltage
Vdrop	28	V	Overall voltage drop
BoostGain	1.3		Additional gain in Boosted Battery Mode
RFS	375	Ω	Feeding Resistance (excluding the external Fuse resistors)
f_{Ring}	25	Hz	Ring Frequency
A_{Ring}	62	Vrms	Ring rms-value at Ring/Tip wire
DC Offset _{Ring}	22	V	Ring offset
f_{RingLP}	75	Hz	Corner Frequency of Ring-Lowpass
OffhookPD	2	mA	Power-Down Current for Offhook Detection
OffhookAct	8	mA	Offhook Detection in Active with 2 mA hysteresis
OffhookRing	5	mA	DC-Current for Offhook Detection in Ringing Mode
LineSup	5	mA	Current for Line-Supervision
Levelmeter1	8	mA	First levelmeter threshold
Levelmeter2	12	mA	Second levelmeter threshold
Levelmeter3	21	mA	Third levelmeter threshold
Levelmeter4	25	mA	Fourth levelmeter threshold
GKD1	17	mA	First threshold-current for Ground-Key-Detection
GKD2	40	mA	Second threshold-current for Ground-Key-Detection
RingTip	52	V	Threshold at Ring/Tip wire
DC-Lowpass	0.3/20	Hz	DC- Lowpass set to 0.3 and 20 Hz respectively
ConstRamp	300	V/s	Slope of the ramp while testing
delay _{Ring}	0	ms	Delay of Ring Burst
SRend1	1/128		Silent-Reversal threshold 1 (referred to the input of the rampgenerator)
SRend2	1/512		Silent-Reversal threshold 2 (referred to the input of the rampgenerator)
SRduration	ca. 80	ms	Duration of a Silent-Reversal-sequence
DUP	10	ms	Data Upstream Persistency Counter is set to 10 ms
DUPGNK	20	ms	Data Upstream Persistency Counter for GNK is set to 20 ms

- Boosted Battery is reset to normal feeding
- Reverse Polarity is reset to Normal Polarity
- All bits of the Signalling Register are masked and reset to 0 without the RES bit

Operating Modes

- The Data Upstream C/I channel bits are set to 0 except SLCX, it is set to 1 (the IO's are set to Input pins)
- Outputs are set tristate until the first SOP command
- C1 and C2 are set to PDNH
- A-Law is chosen

Table 10

AC			
IM-Filter	900	Ω	Approximately 900 Ω Real Input Impedance
TH-Filter	TH _{BRD}		Approximately BRD-Impedance for Balanced Network
AX	10	dB	Attenuation Transmit (this means about 0 dB)
AR	– 15.11	dB	Attenuation Receive (this means about – 7 dB)
ATTX	4	Vrms	Teletax Generator Amplitude at Ring / Tip wire at AHV-SLIC
f _{TTX}	16	kHz	Teletax Generator frequency;
TG1	1008	Hz	Tone Generator 1 and AC -levelmeter Bandpass (– 14 dBm0)
TG2	2000	Hz	Tone Generator 2 (+ 2 dB compared to TG1)

5.3 Power Down (PDown)

After a Reset (including the Power On Reset) or programming the CIDD-Byte the MuSLIC is set to Power Down State. In Power Down all functions which are not necessary are disabled to minimize power consumption. This can be done for all the channels or only for the not active ones. While the interface is fully working - including programmability of the registers with SOP or XOP commands and the Coefficient RAM (COP commands) - the rest of the MuSLIC is turned off except the supervision of the line. The change of the line state is reported via the HOOK-bit in the IOM-2 Data Upstream channel. To avoid spurious Offhook informations caused by longitudinal induction the HOOK-bit is low pass filtered (programmable with the DUPGNK-counter in PDown state only). The voice channel Data Downstream is directly fed into the voice channel Data Upstream. The HOOK-indication in PDown is optimized for longitudinal suppression up to 65 Vrms for the Offhook transition.

In Power Down Mode the AHV-SLIC can be set into two different modes:

1. PDNR, the resistive mode which provides a connection of 10 k Ω from TIP and RING to BGND and VBAT, respectively
2. PDNH, offers high impedance at TIP and RING

Operating Modes**5.4 Active Mode (Act)**

In Active Mode ("Conversation State") both AC-and DC-Loop are fully working. The output voltage at the DC pins is controlled via the IT input pin in such way, that it behaves like a constant current source which turns automatically into a programmable resistive feeding source due to the DC-Characteristic values.

The ternary AHV-SLIC-interface is set to one of the active modes.

Polarity

The MuSLIC supports either normal or reverse Polarity which is set by the POLNR-bit (SCR0-7). A 180 degrees phase shift of the AC- and DC-Loop is done. The performance and the functionality is not influenced by that.

Boosted Battery

To feed subscriber lines with enhanced loop resistance the MuSLIC supports the Boosted Battery mode. The AHV-SLIC-Interface pins (C1, C2) are set to Boosted Battery (BB) mode and the maximum DC output voltage is extended to 140 V.

Meterpulses

The MuSLIC supports two different kinds of meterpulses: Meterpulses with 12/16 kHz (Teletax Metering) and with polarity reversal. The decision between these two types is made by the bit TTXNO (SCR1-7). If the bit TTXNO is set to 1 then the meterpulse is reversal. If the bit TTXNO is set to 0, Teletax Metering is used.

Metering with Polarity Reversal

As long as the M1 and the M2 bit of the C/I-channel (CIDD-4) is set to 1, the MuSLIC performs an immediate 180 degrees phase shift of the AC- and DC-Loop.

Teletax Metering Injection

For countries with Teletax Metering the MuSLIC provides either a 12 or a 16 kHz Signal (switchable with the bit TTX12 (SCR1-6))¹⁾ which amplitude is free programmable up to 10 Vrms at the Ring/Tip wire. The MuSLIC filters the Teletax pulses in transmit direction, too. The slope of the pulses are internally shaped so that the noise during switching and transmission is less than $50 \times 6.25 \mu\text{V}$ at AC pins and 1 mV at the IOM-2 interface (psophometrically weighted). With the bit NOSL (SCR1-5) the slope can be switched off. In that case the switching noise is not defined (for signalling only).

¹⁾ Note, that the right Teletax Coefficient Set (via COP-command) must be provided, too.

Operating Modes

5.5 Ringing Mode

The MuSLIC generally supports balanced and unbalanced ringing.

If the MuSLIC is set to Ringing Mode, the AC-loop is turned off and the DC-loop is automatically opened.

The voice channel Data Downstream is directly fed into the voice channel Data Upstream.

Balanced Ringing

The sine wave of the ringing is generated in the MuSLIC. The frequency and the amplitude are free programmable between 16 and 70 Hz and up to 85 Vrms at the Ring/Tip wire, respectively. The DC offset voltage is programmable between 0 V and 30 V. If the Ring Burst On command is sent to the MuSLIC via the C/I-channel (M0 and M2 = 1) the begin (M2 = 1) and the end (M2 = 0) of the ring burst is automatically synchronized at the voltage zero crossing. If the DC-current at the IT-pin exceeds the programmed value, Offhook is detected within 2 periods of the ringing frequency and the Ring Burst is neglected. If Offhook is detected the MuSLIC changes automatically to the active mode.

Unbalanced Ringing

The ringing voltage is generated by an external ring generator. To connect this generator to the Ring/Tip wires relays are used. To control the relays the MuSLIC offers following functions:

If the REXTEN bit (XR2-7) is set to 1 the MIO1 is an input for the zero crossing signal. QIO1 is switched to the CIDD-4 (M2 bit) and offers the zero crossed ring burst on/off control signal.

5.6 Ground Start

Changing into the Ground Start mode by programming the CIDD Byte (M2 = 1, M1 and M0 = 0) the active mode is chosen and the Ternary SLIC-interface is set to high impedance of the Tip output (HIT: C1 = VOM, C2 = VOH).

5.7 Changing Modes

Offhook detection is low pass filtered with the time of 2 x DUP counter if any change of the modes or if one of the following crossovers occurs:

ring burst	<---->	ring pause
reverse	<---->	normal polarity
boosted	<---->	normal battery
ground start on	<---->	off
PDNR on	<---->	off
FIXC, LOAD, RESET on	<---->	off

Transmission Characteristics

6 Transmission Characteristics

The target figures in this specification are based on the subscriber-line board requirements. The proper adjustment of the programmable filters (transhybrid balancing, impedance matching, frequency-response correction) needs a complete knowledge of MuSLIC analog environment. Unless otherwise stated, the transmission characteristics are guaranteed within the test conditions.

Test Conditions

$T_A = 0 \text{ to } 70 \text{ }^\circ\text{C}$;

$V_{DDI} = V_{DDA} = V_{DDB} = V_{DDC} = V_{DDD} = 5 \text{ V} \pm 5\%$; $V_{SS} = -5 \text{ V} \pm 5\%$;

$V_{DD} = 3.3 \text{ V} \pm 5\%$

$GNDI = GND A = GND B = GND C = GND D = 0 \text{ V}$

H_{IM} , H_{TH} , H_{FRX} , H_{FRR} , AR , AX will be defined to meet the 0 dBm0 specification.

$f = 1004 \text{ Hz}$; 0 dBm0; A-Law;

A 0dBm0 AC signal in Transmit direction is equivalent to $2 \times 0.775 \text{ V}_{rms}$ and in Receive direction equivalent to 0.775 V_{rms} (referred to 600Ω).

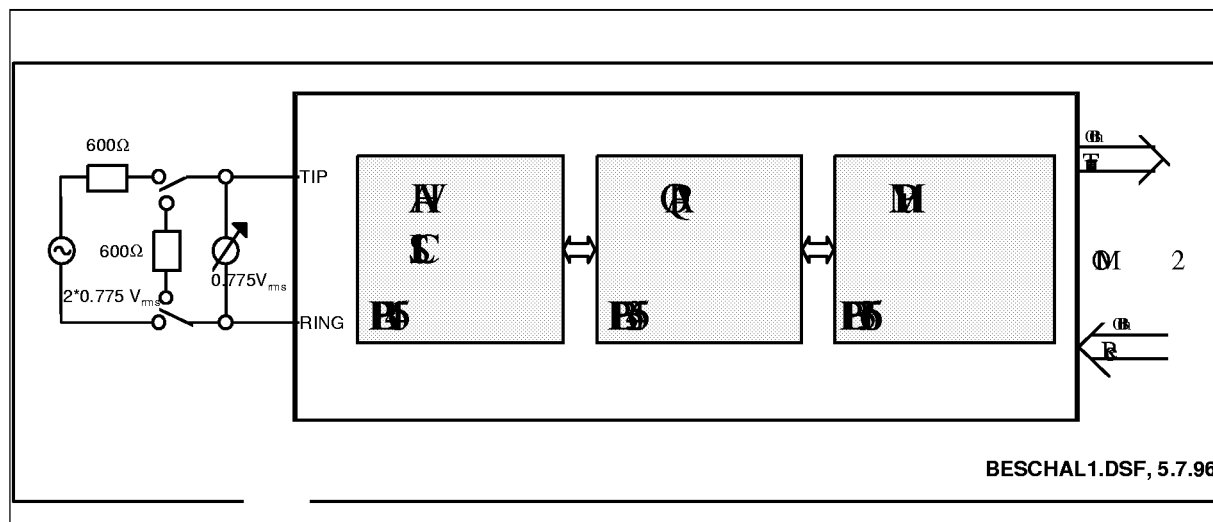


Figure 26

$0 \text{ dBm0}|_{\text{MuSLIC}} = 0 \text{ dBm0}|_{600 \Omega} = 0.775 \text{ V}_{rms}$ for receive direction.

$0 \text{ dBm0}|_{\text{MuSLIC}} = 0 \text{ dBm0}|_{600 \Omega} = 2 \times 0.775 \text{ V}_{rms}$ for transmit direction.

Transmission Characteristics
6.1 Transmission Values

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		

Interface Requirements

2-wire port						$2 \times 100 \Omega R_p$ incl.
Out of band signalling						
Metering signal	V_{ab}	4.5	4.85	5.2	Vrms	12/16 kHz @ 200 Ω
Ringing injection	V_{ab}	60	63	66	Vrms	16 Hz to 50 Hz
Longitudinal current capability AC	III	30			mArms	per line active
Transmission performance						
Overload level	V_{ab}	2.3			Vrms	300 Hz to 4 kHz
Return loss (2-wire)	R_L	14		18	dB	300 Hz to 500 Hz
	R_L		18		dB	500 Hz to 2 kHz
	R_L	14		18	dB	2 kHz to 3.4 kHz
Insertion loss						
Transmit V gain	G_t	- 0.3		0.3	dB	0 dBm0, 1 kHz
Receive V gain	G_r	- 0.3		0.3	dB	0 dBm0, 1 kHz
Insertion loss versus frequency						relative to 1 kHz
Transmit V gain	G_t	see chapter 6.2				0 dBm0, 0.3 to 3.4 kHz
Receive V gain	G_r	see chapter 6.2				0 dBm0, 0.3 to 3.4 kHz
Gain/Loss programmability						
Transmit absolute + 3 dBr	T_x			0.5	dB	voice band, in steps of
Receive absolute 0 ... - 12 dBr	R_x			0.5	dB	voice band, in steps of

Transmission Characteristics
6.1 Transmission Values (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Gain linearity						relative to 1 kHz, – 10 dBm0
Transmit V gain	G_t	see chapter 6.3				– 55 dBm0 to + 3 dBm0
Receive V gain	G_r	see chapter 6.3				– 55 dBm0 to + 3 dBm0
Balance return loss		20			dB	500 Hz to 2.5 kHz
Absolute group delay distortion		see chapter 6.4				
Overload compression A/A	OC	see chapter 6.5				
Longitudinal balance						
Longitudinal to transversal world market requirement	L-T	52			dB	300 Hz to 3.4 kHz
US market requirement	L-T	58	65		dB	at 1020 Hz
Transversal to longitudinal	T-L	46			dB	300 Hz to 4 kHz
Longitudinal signal generation	T-L	46			dB	300 Hz to 4 kHz

Transmission Characteristics
6.1 Transmission Values (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Out-of-band Noise						single frequency inband – 25 dBm0
Transversal	V_{ab}			– 50	dBm	12 kHz to 200 kHz
Longitudinal	V_{ab}			– 50	dBm	12 kHz to 200 kHz
Metering injection						
Impulse noise during switching	V_{ab}			1	mV	psophometrically
At 2-, 4-wire interface	V_{tx}			1	mV	weighted
Harmonic distortion				5	%	
Ringing injection						
Transfer gain	G_{rng}	t.b.d.	0.5	t.b.d.	dB	$Z_L = 1200 \Omega$
Superimposed d.c. voltage	V_{rdc}	20	22	24	V	$R_L = 10 k\Omega$
Harmonic distortion	THD			5	%	$Z_L = 1 k\Omega \parallel 6 \mu F$
Ring trip function						
Detection time and delay after		12 ms		2	periods	
The ringing to off hook status				2	periods	
Cut off the ringing						

Transmission Characteristics
6.1 Transmission Values (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		

Interface Requirements

2-wire port and PCM side

Total harmonic distortion						
2- to 4-wire	T_{hd4}			– 46	dB	– 7 dBm0, 0.3 to 3.4 kHz
4- to 2-wire	T_{hd2}			– 46	dB	– 7 dBm0, 0.3 to 3.4 kHz
Idle channel noise						
2-wire port (receive) A-Law	V_{ab}			– 70	dBmp	psophometric (idle code +0)
μ-Law	V_{ab}			20	dBrc	C-massage (idle code +0)
PCM side (transmit) A-Law	N_{TP}			–67	dBmp	psophometric ($V_{IN} = 0$)
μ-Law	N_{TC}			20	dBrc	C - massage ($V_{IN} = 0$)
Signal to total distortion ratio						
Input connection: $L_i = 0$ dBr	S/D	see chapter 6.6				– 45 dBm0 to 0 dBm0
Output connection: $L_o = -7$ dBr	S/D	see chapter 6.6				– 45 dBm0 to 0 dBm0

Transmission Characteristics
6.1 Transmission Values (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Battery Feeding						$V_{BAT} = -68\text{ V}$, $V_H = +52\text{ V}$
Power Down Mode (PDNR)						
Loop resistance	R_S	6.4	8	9.6	k Ω	
Active Mode						without calibration
Loop current (without TTX)	I_L	19			mA	$R_L = 1.8\text{ k}\Omega$
I_{loop} accuracy	I_L	23	25	27	mA	$I_{link2} = 25\text{ mA}$
I_{loop} accuracy	I_L	27	30	33	mA	$I_{link3} = 30\text{ mA}$
I_{loop} accuracy	I_L	41	45	49	mA	$I_{link4} = 45\text{ mA}$
I_l negative wire	I_W	90		120	mA	wire to ground
Transition time	T_{off}	0.5		1.5	ms	On to Offhook
Boost Battery Mode						
Loop current						same as active state
Output voltage	V_{ab}	78		86	V	$I_{line} = 20\text{ mA}$
Indication thresholds						
Offhook indication						
Offhook current	I_{det}	7	9	11	mA	
Hysteresis			2		mA	
Ground Key indication						
Ground Key current	I_{det}	10	17	24	mA	
Ring trip indication						
Current threshold 1	I_{det}	6	7	8	mA	short line + bat. charging
Current threshold 2	I_{det}	2.5	3.5	4.5	mA	long line
Power supply rejection ratio						$V_{ripple} = 100\text{ mVpp}$
VCC referred to AGND	PSRR	30			dB	50 Hz to 4 kHz
-objective		40	t.b.d		dB	50 Hz to 4 kHz 4 kHz to 128 kHz

Transmission Characteristics
6.1 Transmission Values (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
VBAT referred to AGND -objective	PSRR	30			dB	50 Hz to 4 kHz
		40			dB	50 Hz to 4 kHz
			t.b.d			4 kHz to 128 kHz
BGND referred to AGND -objective	PSRR	40			dB	50 Hz to 4 kHz
		40			dB	50 Hz to 4 kHz
			t.b.d			4 kHz to 128 kHz

Transmission Characteristics

6.2 Frequency Response

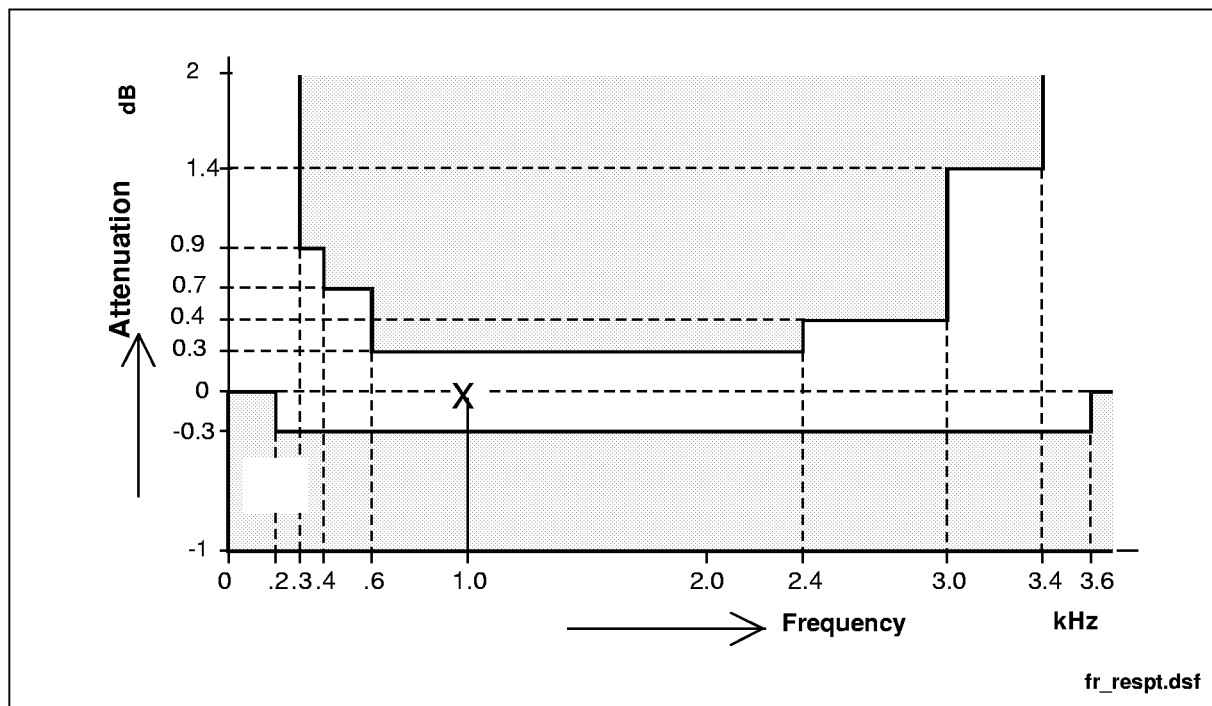


Figure 27 Transmit: reference frequency 1 kHz, signal level – 10 dBm0, $H_{FRX} = 1$

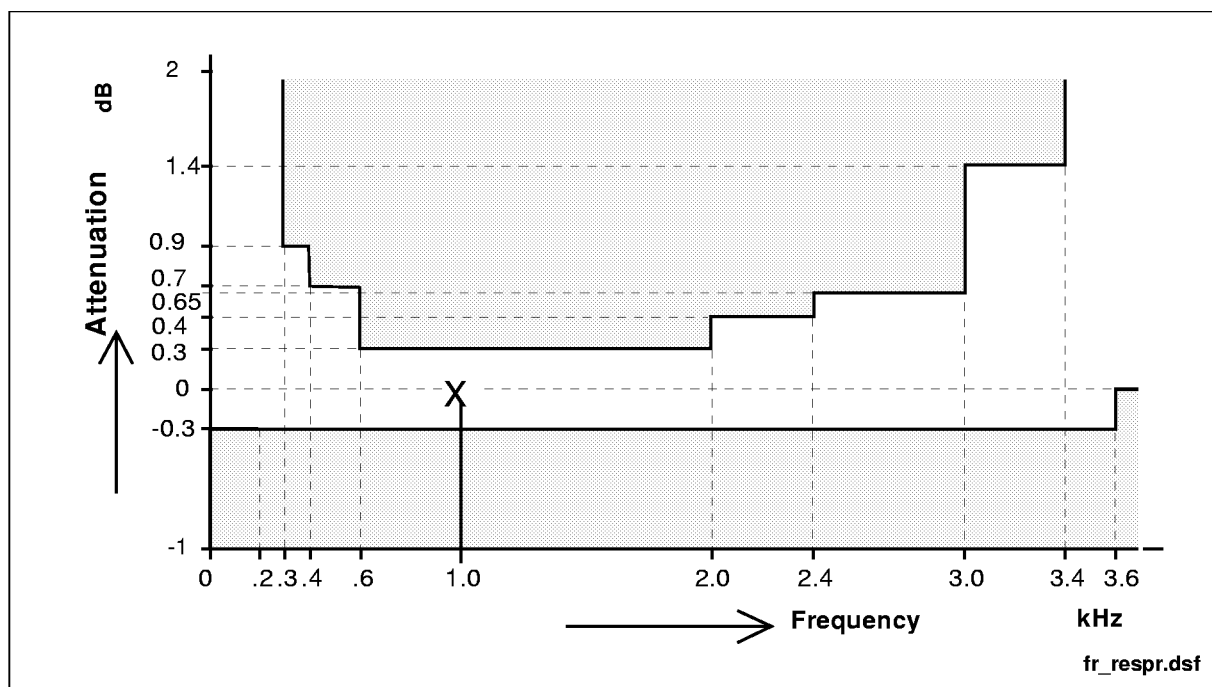


Figure 28 Receive: reference frequency 1 kHz, signal level – 10 dBm0, $H_{FRR} = 1$

Transmission Characteristics

6.3 Gain Tracking (receive or transmit)

The gain deviations stay within the limits in the figures below.

measured with sine wave $f = 1004 \text{ Hz}$

reference level is -10 dBm0 .

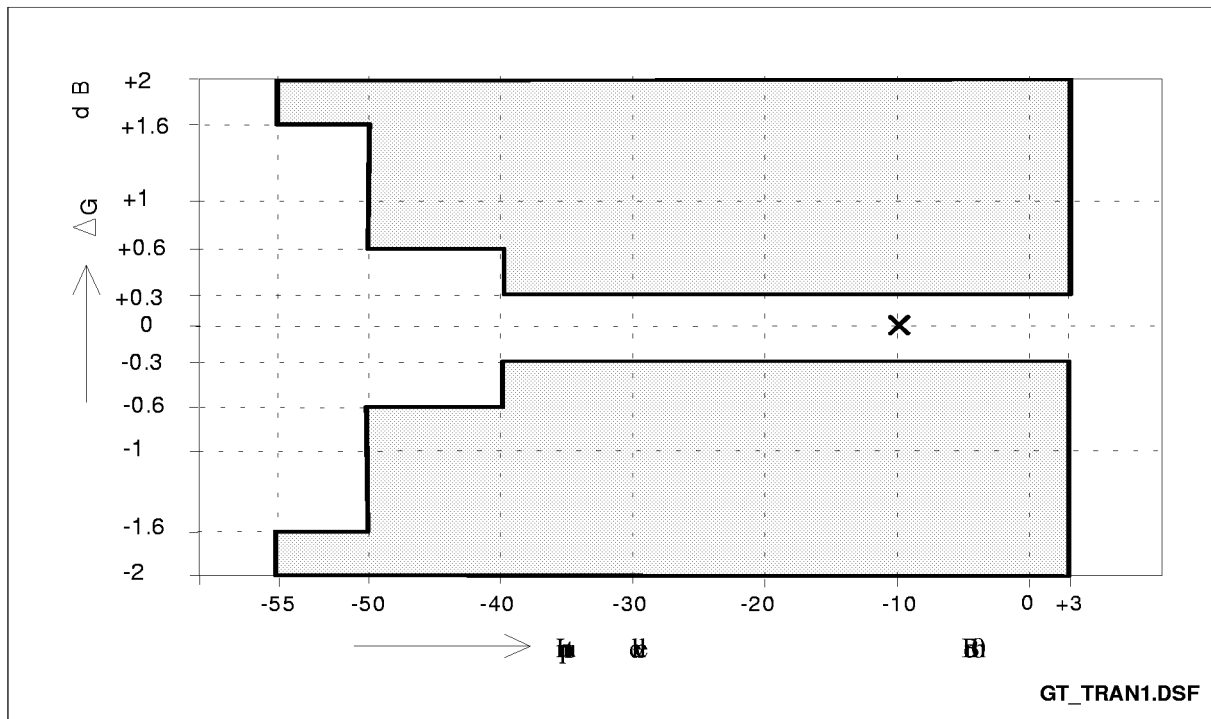


Figure 29

Transmission Characteristics

6.4 Group Delay

Maximum delays when the PEB 3465 and the PEB 31665 are operating with $H_{TH} = H_{IM} = 0$ and $H_{FRR} = H_{FRX} = 1$ including delay through A/D- and D/A converters. Specific filter programming may cause additional group delays.

Group Delay deviations stay within the limits in the figures below.

Group Delay absolute values: Signal level – 10 dBm0

Table 11

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Transmit delay	D_{XA}	330		475	μs	$f = 1.5 \text{ kHz}$
Receive delay	D_{RA}	250		425	μs	$f = 1.5 \text{ kHz}$
Trans.-Receiver delay	D_{XRA}			900	μs	$f = 1.5 \text{ kHz}$

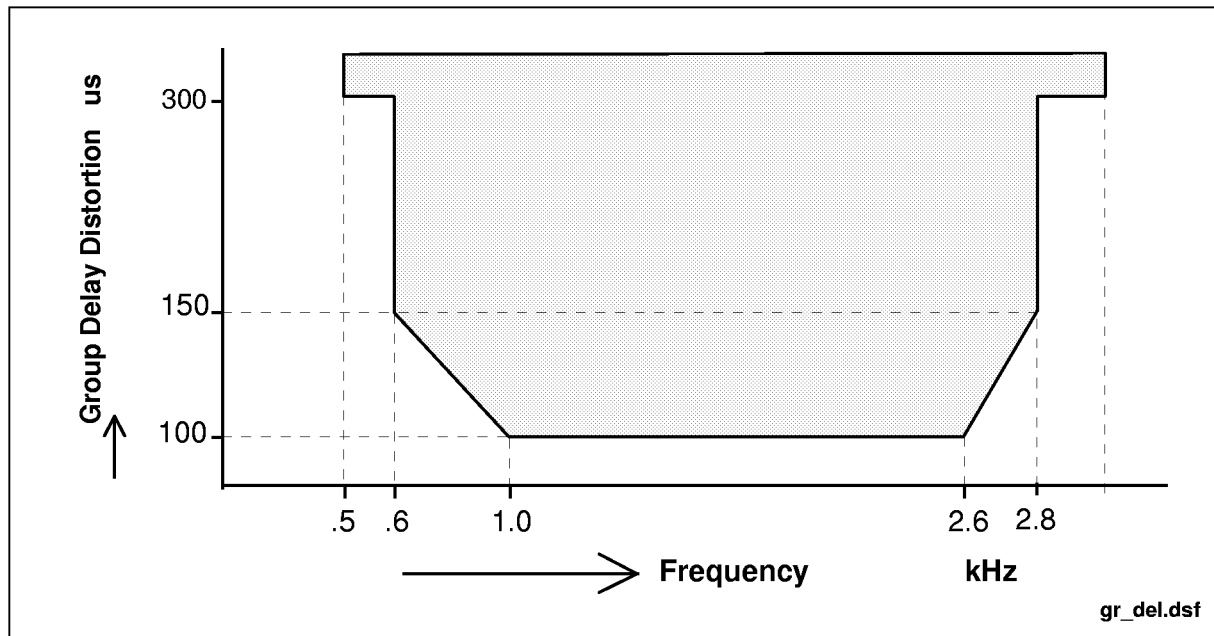


Figure 30 Group Delay Distortion receive and transmit:

Signal level – 10 dBm0, $f_{Test} @ T_{Gmin}$

Transmission Characteristics

6.5 Overload Compression

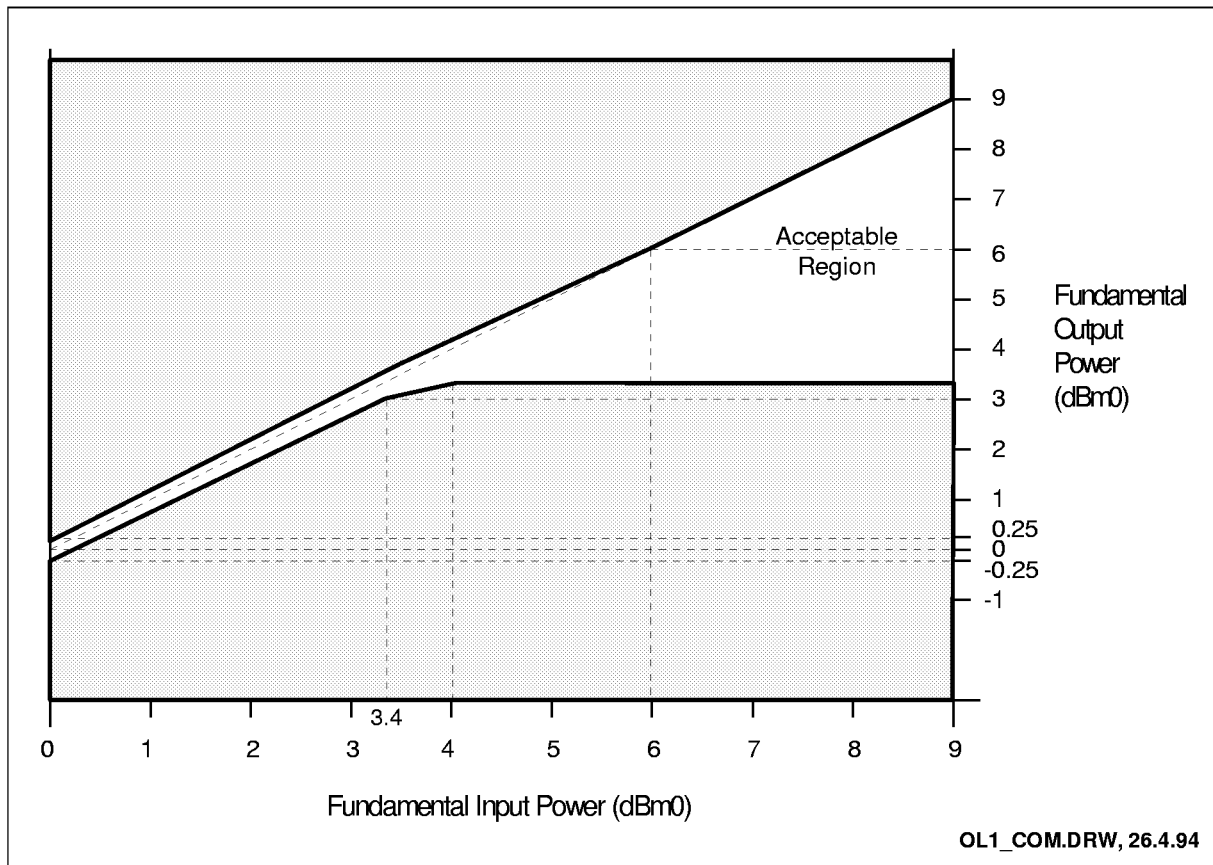


Figure 31 Transmit: measured with sine wave $f = 1004$ Hz

Transmission Characteristics

6.6 Total Distortion

The signal to distortion ratio exceeds the limits in the following figure:

Receive: measured with sine wave $f = 1004$ Hz. (C-message weighted for μ -law, psychoacoustically weighted for A-law). The mean relative level is -7 dBr.

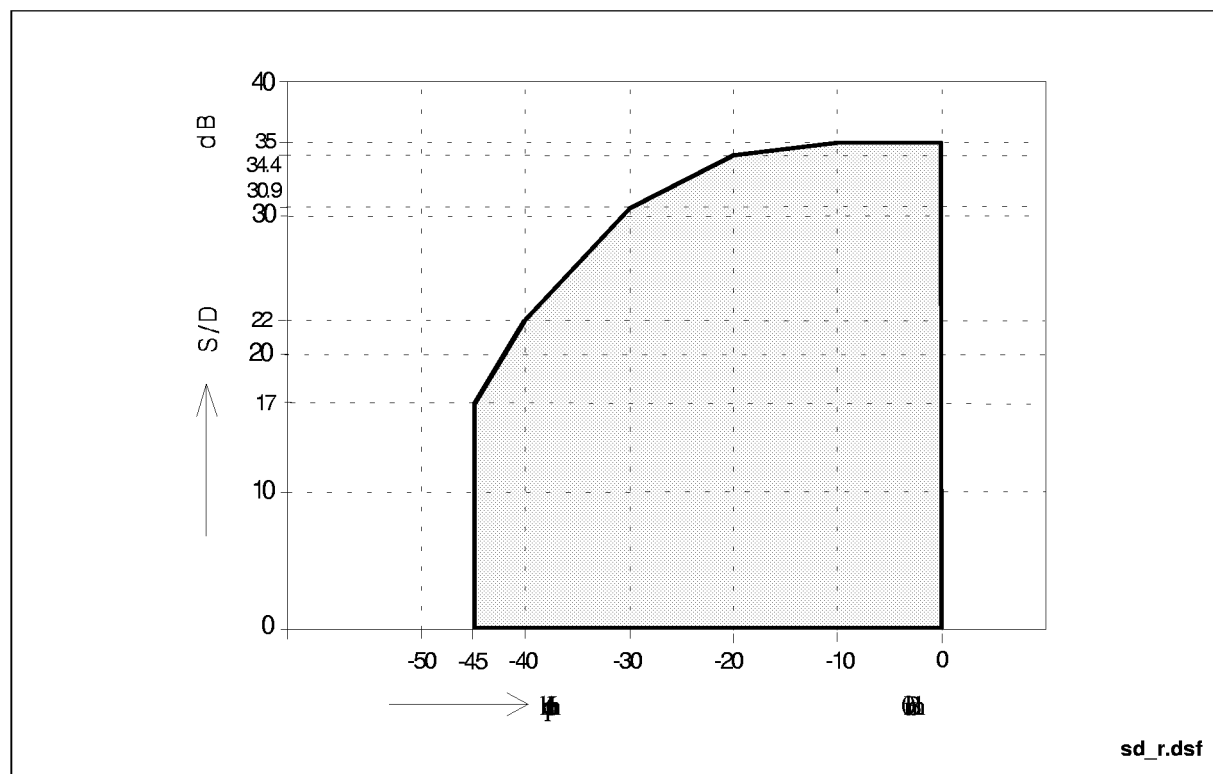


Figure 32

$$AR = 7 \text{ dBr}$$

Table 12

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Signal to distortion at full attenuation	$SD_{\text{att R}}$		- 13		dB	Signal S = - 40 dB AR = + 30 dB

Transmission Characteristics

Transmit: measured with sine wave $f = 1004 \text{ Hz}$. (C-message weighted for μ -law, psychoacoustically weighted for A-law). The mean relative level is 0 dBr.

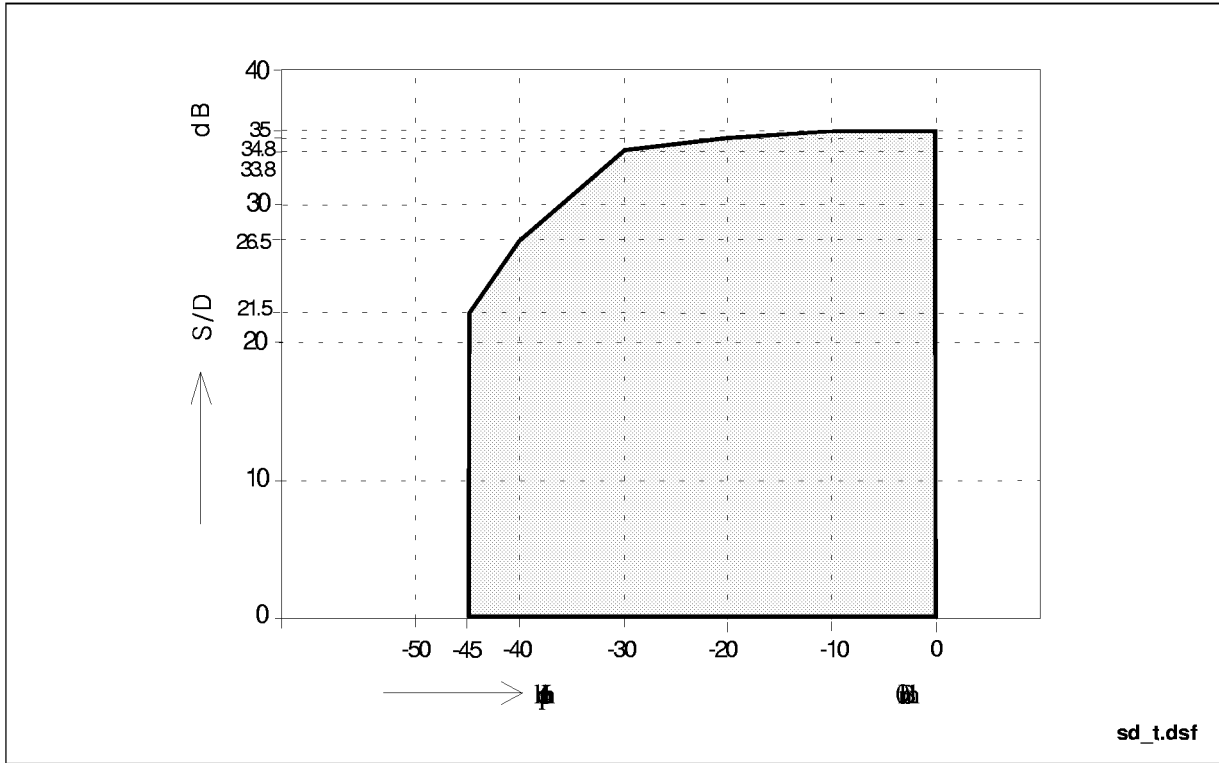


Figure 33

AX = 0 dBr

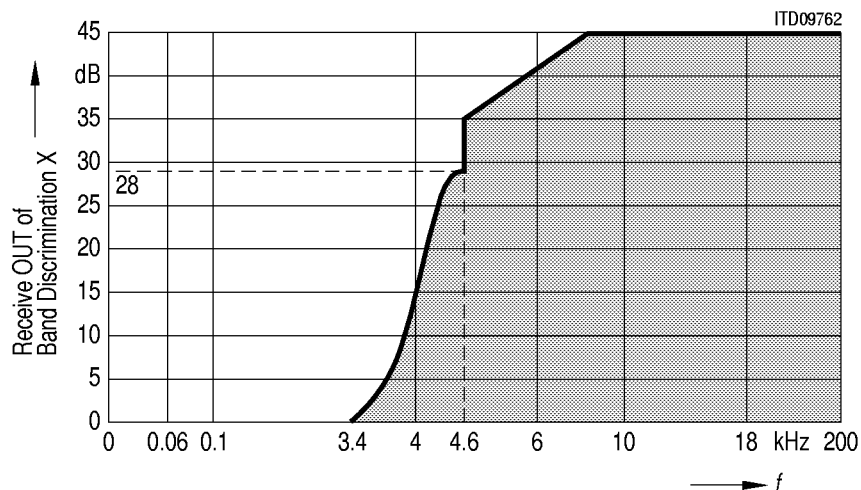
Table 13

Parameter	Symbol	Limit Values			Unit	Test Condition
		mi.n	typ.	max.		
Signal to distortion at full gain	$SD_{att T}$		- 17		dB	Signal S = - 40 dB AX = - 30 dB

Transmission Characteristics

6.7 Out-of-Band Signals at Analog Output (receive)

With a 0 dBm0 sine wave with frequency f (300 Hz to 3.4 kHz) applied to the digital input, the level of any resulting out-of-band signal at the analog output will stay at least X dB below a 0 dBm0, 1 kHz sine wave reference signal at the analog output.



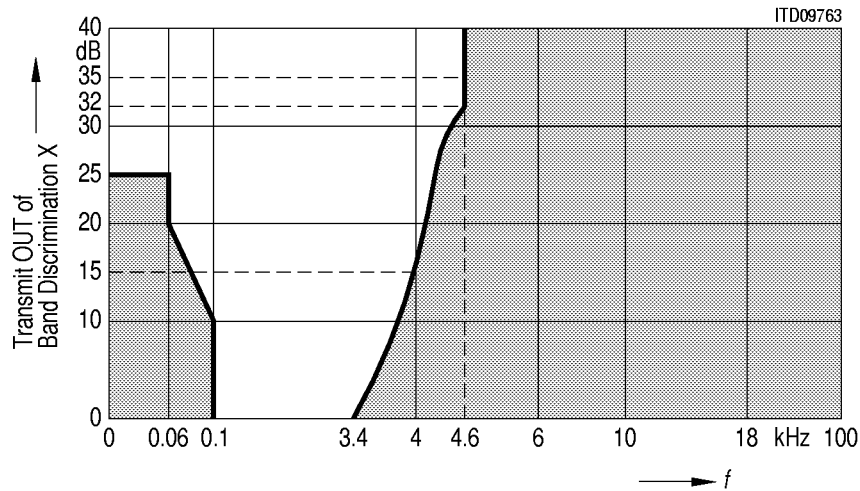
$$3.4 \dots 4.6 \text{ kHz: } X = -14 \left(\sin \left(\pi \frac{4000 - f}{1200} \right) - 1 \right)$$

Figure 34

Transmission Characteristics

Out-of-Band Signals at Analog Input (transmit)

With a 0 dBm0 out-of-band sine wave signal with frequency f (< 100 Hz or 3.4 kHz to 100 kHz) applied to the analog input, the level of any resulting frequency component at the digital output will stay at least X dB below a 0 dBm0, 1 kHz sine wave reference signal at the analog input. ¹⁾



$$3.4 \dots 4.0 \text{ kHz: } X = -14 \left(\sin \left(\pi \frac{4000-f}{1200} \right) - 1 \right)$$

$$4.0 \dots 4.6 \text{ kHz: } X = -18 \left(\sin \left(\pi \frac{4000-f}{1200} \right) - \frac{7}{9} \right)$$

Figure 35

¹⁾ Poles at 12 kHz $\pm$ 150 Hz respectively 16 kHz $\pm$ 150 Hz and harmonics will be provided

Transmission Characteristics
6.8 Transhybrid Loss

The quality of Transhybrid-Balancing is very sensitive to deviations in gain and group delay – deviations inherent to the MuSLIC A/D- and D/A-converters as well as to all external components used on a line card.

Measurement of MuSLIC Transhybrid-Loss: A 0dBm0 sine wave signal with a frequency in the range between 300 – 3400 Hz is applied to the digital input. The resulting analog output signal at the differential outputs ACP and ACN is connected to the pin ITAC. The programmable filters FRR, AR, FRX, AX and IM are disabled, the balancing filter TH is enabled with coefficients optimized for this configuration (ACP–ACN = ITAC).

The resulting echo measured at the digital output is at least X dB below the level of the digital input signal as shown in the table below.

Table 14

	COP-write	Coefficients
TH-Filter Part 1	t.b.d.	t.b.d.
TH-Filter Part 2	t.b.d.	t.b.d.
TH-Filter Part 3	t.b.d.	t.b.d.

Table 15

Parameter	Symbol	Limit Values		Unit	Test Condition
		min.	typ.		
Transhybrid Loss at 500 Hz	THL ₅₀₀		50	dB	
Transhybrid Loss at 2500 Hz	THL ₂₅₀₀		44	dB	
Transhybrid Loss at 3000 Hz	THL ₃₀₀₀		42	dB	

Electrical Characteristics
7 Electrical Characteristics
7.1 PEB 3465 (QAP)
7.1.1 Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit	Test Condition
		min.	max.		
VDDA-VDDD referred to GNDA-GNDD		– 0.3	5.5	V	
VDDI referred to GNDI		– 0.3	5.5	V	
VSS referred to all GND pins		– 5.5	0.3	V	
GNDA-GNDD to GNDI		– 0.3	0.3	V	
VDDA-VDDD to VDDI		– 0.3	0.3	V	
Analog input and output voltages referred to VDD = 5 V; (VSS = – 5 V)		– 10.3	0.3	V	
referred to VSS = – 5 V; (VDD = 5 V)		– 0.3	10.3	V	
All digital input voltages referred to GNDI = 0 V; (VDDI = 5 V)		– 0.3	5.3	V	
referred to VDDI = 5 V; (GNDI = 0 V)		– 5.3	0.3	V	
DC input and output current at any input or output pin (free from latch-up)			100	mA	
Storage temperature	T_{STG}	– 65	125	°C	
Ambient temperature under bias	T_A	– 10	80	°C	
Power dissipation	P_D		1	W	

Note: Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device.

Functional operation under these conditions is not implied.

Exposure to conditions beyond those indicated in the recommended operational conditions of this specification may effect device reliability.

Electrical Characteristics
7.1.2 Operating Range

$T_A = 0$ to $70\text{ }^{\circ}\text{C}$; all V_{DD} 's = $5\text{ V} \pm 5\%$; $V_{SS} = -5\text{ V} \pm 5\%$; all GND's = 0 V

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
V_{DD} supply current ¹⁾						
Power down	$I_{DD_{PDown}}$		24		mA	all channels PDown
Active	$I_{DD_{Act}}$		67		mA	all channels active
V_{SS} supply current ¹⁾						
Power down	$I_{SS_{PDown}}$		0		mA	all channels PDown
Active	$I_{SS_{Act}}$		5		mA	all channels active
Power supply rejection-ratio	PSRR					ripple: 1 kHz, 100 mVrms
Receive VDD						t.b.d.
Receive VSS						t.b.d.
Transmit VDD		40			dB	at IOM-2
Transmit VSS		40			dB	at IOM-2
Power dissipation ¹⁾						
Power down	P_{PDown}		120		mW	all channels PDown
Active	P_{act1}		180		mW	1 channel active
Active	P_{act}		360		mW	all channels active

¹⁾ Power dissipation and supply currents are target values

Note: In the operating range the functions given in the circuit description are fulfilled.

Electrical Characteristics

7.1.3 I/O-Pins

$T_A = 0$ to $70\text{ }^{\circ}\text{C}$; all V_{DD} 's = $5\text{ V} \pm 5\%$; $V_{SS} = -5\text{ V} \pm 5\%$; all GND's = 0 V

Parameter	Symbol	Limit Values		Unit	Test Condition
		min	max.		
For all input pins:					
Low-input pos.-going	V_{T+}	- 0.3	3.15	V	see figure 36
Low-input neg.-going	V_{T-}	1.35	$V_{DD} + 0.3$	V	see figure 36
Low-input Hysteresis	V_H	0.5		V	$V_H = V_{T+} - V_{T-}$
Input leakage current	I_{IL}	- 1	1	μA	$- 0.3 \leq V_{in} \leq V_{DD}$
Spike rejection for RESET	t_{rej}	50	200	ns	
For I/O1 and O1:					
Low-output voltage	V_{OL}		0.5	V	$I_O = - 50\text{ mA}$
High-output voltage	V_{OH}	3.5		V	$I_O = 2\text{ mA}$
For I/O2:					
Low-output voltage	V_{OL}		0.5	V	$I_O = - 2\text{ mA}$
High-output voltage	V_{OH}	3.5		V	$I_O = 2\text{ mA}$

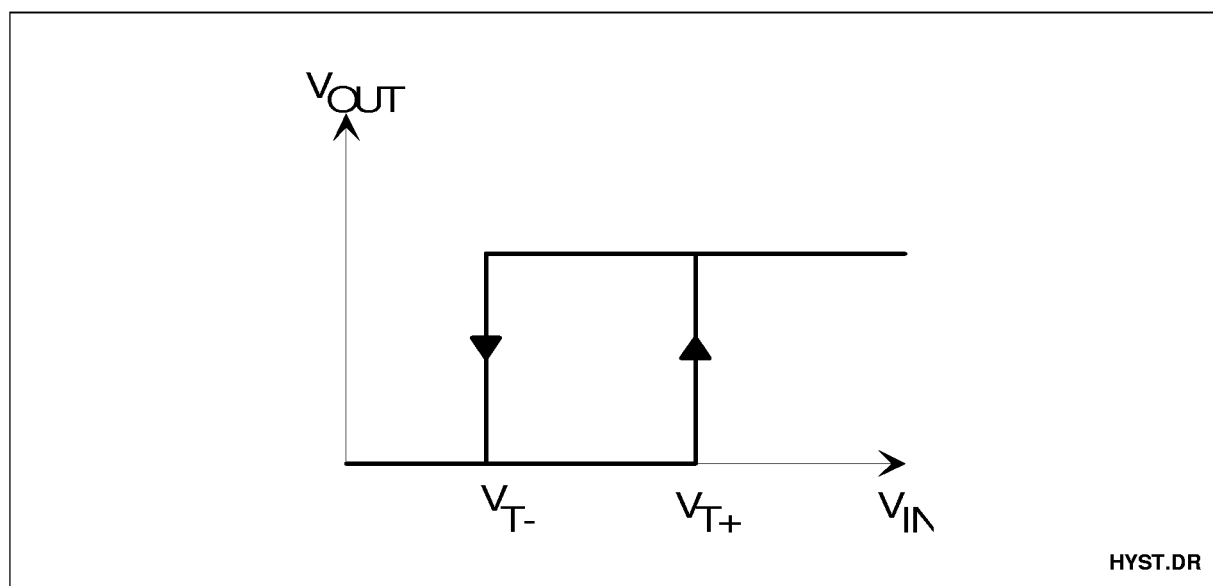


Figure 36

Electrical Characteristics
7.1.4 DC-Feeding

$T_A = 0$ to 70 °C; all V_{DD} 's = $5\text{ V} \pm 5\%$; $V_{SS} = -5\text{ V} \pm 5\%$; all GND's = 0 V

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
“Line Current” Measurement: Transmit	$V_{IT\text{ offset}}$	– 25		25	mV	direct/reverse polarity ¹⁾
	$V_{IT\text{ gain}}$	0.95		1.05		$f < 50\text{ Hz}$, direct/reverse polarity
	$V_{IT\text{ THD}}$	40	50		dB	direct/reverse polarity
“Line Voltage” Feeding: Receive Receive Boosted	$V_{DC\text{ offset}}$	– 25		25	mV	normal battery, $f = 300\text{ Hz}$
	$V_{DC\text{ gain}}$	0.94		1.06		normal battery, $f = 300\text{ Hz}$
	$V_{DC\text{ THD}}$	40	50		dB	normal battery
	$V_{DC\text{ offset}}$	– 40		40	mV	boosted battery, $f = 300\text{ Hz}$
	$V_{DC\text{ gain}}$	1.5	1.6	1.7		boosted battery, $f = 300\text{ Hz}$
	$V_{DC\text{ THD}}$	40	50		dB	boosted battery

¹⁾ Reverse polarity is an internal state of the PEB 31665; the polarity of the voltage at PIN IT is positive.

Electrical Characteristics
7.1.5 AHV-SLIC Interface and Supervision Functions

$T_A = 0$ to 70 °C ; all V_{DD} 's = $5\text{ V} \pm 5\%$; $V_{SS} = -5\text{ V} \pm 5\%$; all GND's = 0 V

Parameter	Symbol	Limit Values			Unit	Test Condition/ Result
		min.	typ.	max.		
Longitudinal Current Input (IL)	$V_{IL\text{ gain}}$	0.9	1	1.1		$f < 50\text{ Hz}$ $V_{in} = -2.4 \dots +2.4\text{ V}$
Auxiliary Inputs (VA, VB, VBIM)	$V_{x\text{ gain}}$	0.9	1	1.1		$f < 50\text{ Hz}$; $V_{in} = -2.4 \dots +2.4\text{ V}$
Output voltage: AHV-SLIC-Interface C1, C2						
High level	V_{OHHV}		$0.8 \times VDD$		V	$I_{out} < 10\text{ }\mu\text{A}$
Mid level	V_{OMHV}		$0.51 \times VDD$		V	$I_{out} < 10\text{ }\mu\text{A}$
Low level	V_{OLHV}		$0.22 \times VDD$		V	$I_{out} < 10\text{ }\mu\text{A}$
Current drained from pin C1 in all 3 states	I_{OTLo} I_{OTHi}	120		80	μA μA	TEMPA = 0 ¹⁾ TEMPA = 1

¹⁾ TEMPA is reported via the MuPP/QAP-Interface to the PEB 31665

Electrical Characteristics

7.2 PEB 31665 (MuPP)

7.2.1 Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
V_{DD} referred to GND		– 0.3	3.6	V	
V_{DD5} referred to GND		– 0.3	5.5	V	
All digital input voltages ($V_{DD5} = 5$ V) referred to GND = 0 V; ($V_{DD} = 3.3$ V)		– 0.3	5.3	V	
referred to $V_{DD} = 3.3$ V; (GND = 0 V)		– 5.3	0.3	V	
DC input and output current at any input or output pin (free from latch-up)			100	mA	
Storage temperature	T_{STG}	– 65	125	°C	
Ambient temperature under bias	T_A	– 10	80	°C	
Package power dissipation	P_D		1	W	

Note: Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Functional operation under these conditions is not implied. Exposure to conditions beyond those indicated in the recommended operational conditions of this specification may effect device reliability.

7.2.2 Operating Range

$T_A = 0$ to 70 °C; $V_{DD} = 3.3$ V $\pm$ 5%; GND = 0 V

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Power supply current			t.b.d.		mA	$V_{DD} = 3.3$ V
Power dissipation (all channels active)			t.b.d.		mW	$V_{DD} = 3.3$ V
Power dissipation (only 1 channel active)			t.b.d.		mW	$V_{DD} = 3.3$ V
Power dissipation (no channel active)			t.b.d.		mW	$V_{DD} = 3.3$ V

Note: In the operating range the functions given in the circuit description are fulfilled.

Electrical Characteristics
7.2.3 Characteristics
 $T_A = 0 \text{ to } 70 \text{ }^{\circ}\text{C}; V_{DD} = 3.3 \text{ V} \pm 5\%; \text{GND} = 0 \text{ V}$

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
For all input pins					
Input low-voltage	V_{IL}				TTL Level
Input high-voltage	V_{IH}				
Input leakage current	I_{IL}	- 1	1	μA	$- 0.3 \leq V_{in} \leq V_{DD5}$
Spike rejection for RESET	t_{rej}	50	200	ns	
For all output pins					
Set-up time	t_s		typ. 30	ns	Load capacitance 30 pF $I_{OL} = - 3.2 \text{ mA}^{1)}$ $I_{OH} = 2 \text{ mA}$
Output low-voltage	V_{OL}		0.45	V	
Output high-voltage	V_{OH}	0.7 VDD		V	

¹⁾ DU: $I_{OL} = - 7 \text{ mA}$

Note: The listed characteristics are ensured over the operating range of the integrated circuit. Typical characteristics specify mean values expected over the production spread. If not otherwise specified, typical characteristics apply at $T_A = 25^{\circ}\text{C}$ and the given supply voltage.

Electrical Characteristics

7.2.4 IOM[®]-2 Switching Characteristics

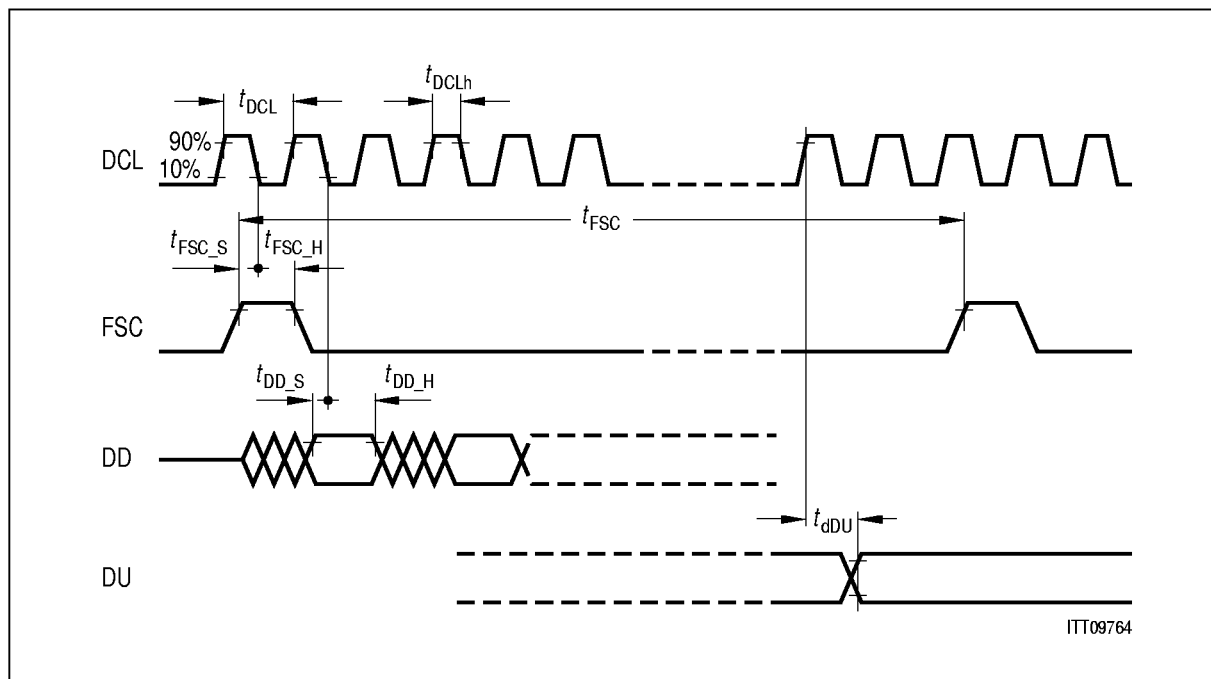


Figure 37

Table 16 Switching Characteristics

Parameter	Symbol	Limit Values			Unit
		min.	typ.	max.	
Period DCL	t_{DCL}		1/4096 kHz		
DCL duty cycle	t_{DCLh}	40		60	%
Period FSC	t_{FSC}		125		μ s
FSC set-up time	t_{FSC_S}	70	t_{DCL_h}		ns
FSC hold time	t_{FSC_H}	40			ns
DD data in set-up time	t_{DD_S}	20			ns
DD data in hold time	t_{DD_H}	50			ns
DU data out delay	t_{dDU}		150 ¹⁾		ns

¹⁾ With a pull-up resistor of 1 k Ω and a capacity of 50 pF.

Electrical Characteristics

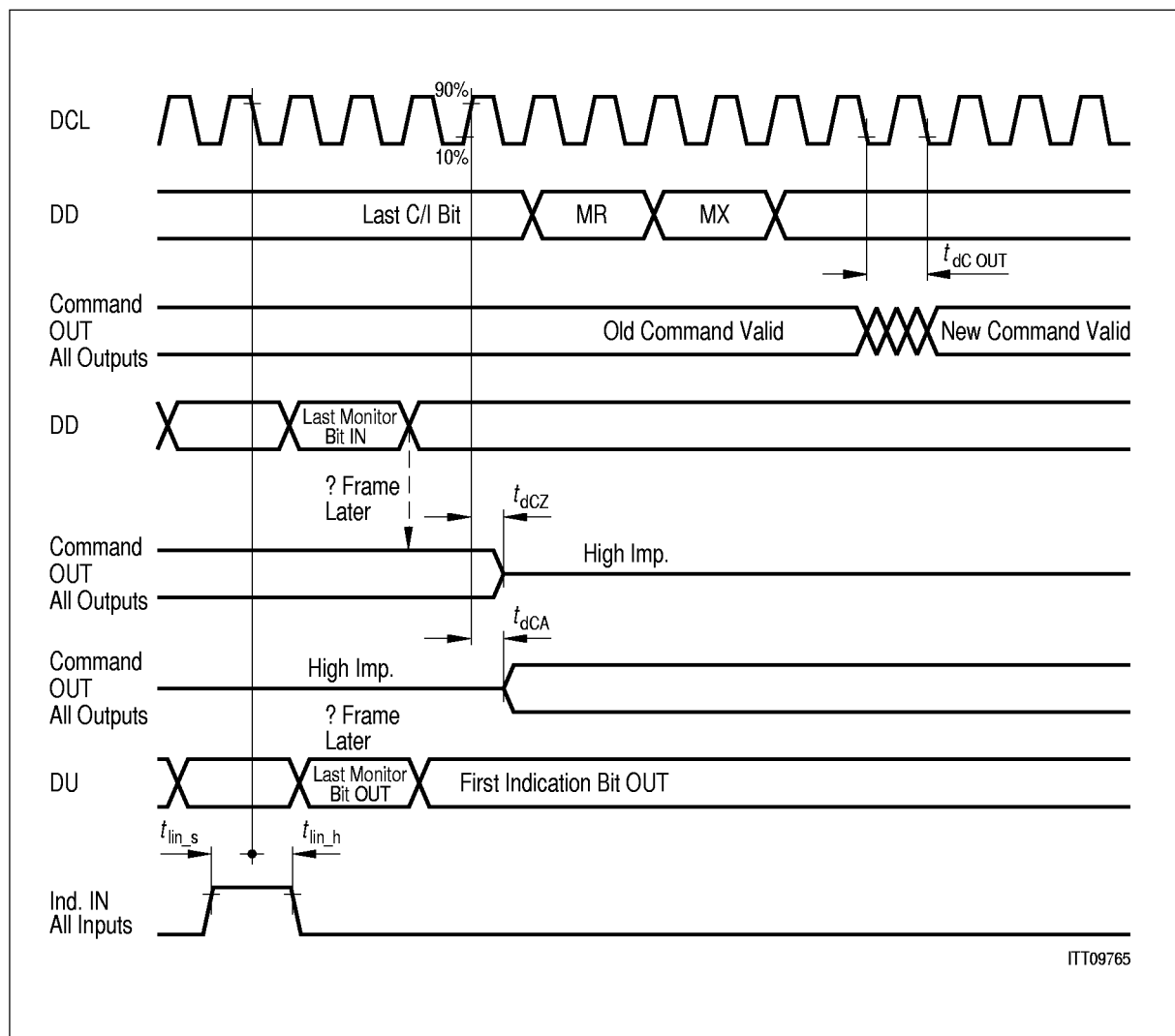


Figure 38 IOM[®]-2 Command/Indication Interface Timing

Electrical Characteristics

Table 17 Switching Characteristics

Parameter	Symbol	Limit Values			Unit
		min.	typ.	max.	
Command out delay	t_{dCout}		t.b.d.		ns
Command out high impedance	t_{dCZ}		t.b.d.		ns
Command out active	t_{dCA}		t.b.d.		ns
Indication in set-up time	t_{lin_s}		t.b.d.		ns
Indication in hold time	t_{lin_h}		t.b.d.		ns

Command/Indication interface timing depends on time slot and for QIOs additionally on AFSC-period.

7.2.5 μ C-Interface Switching Characteristics

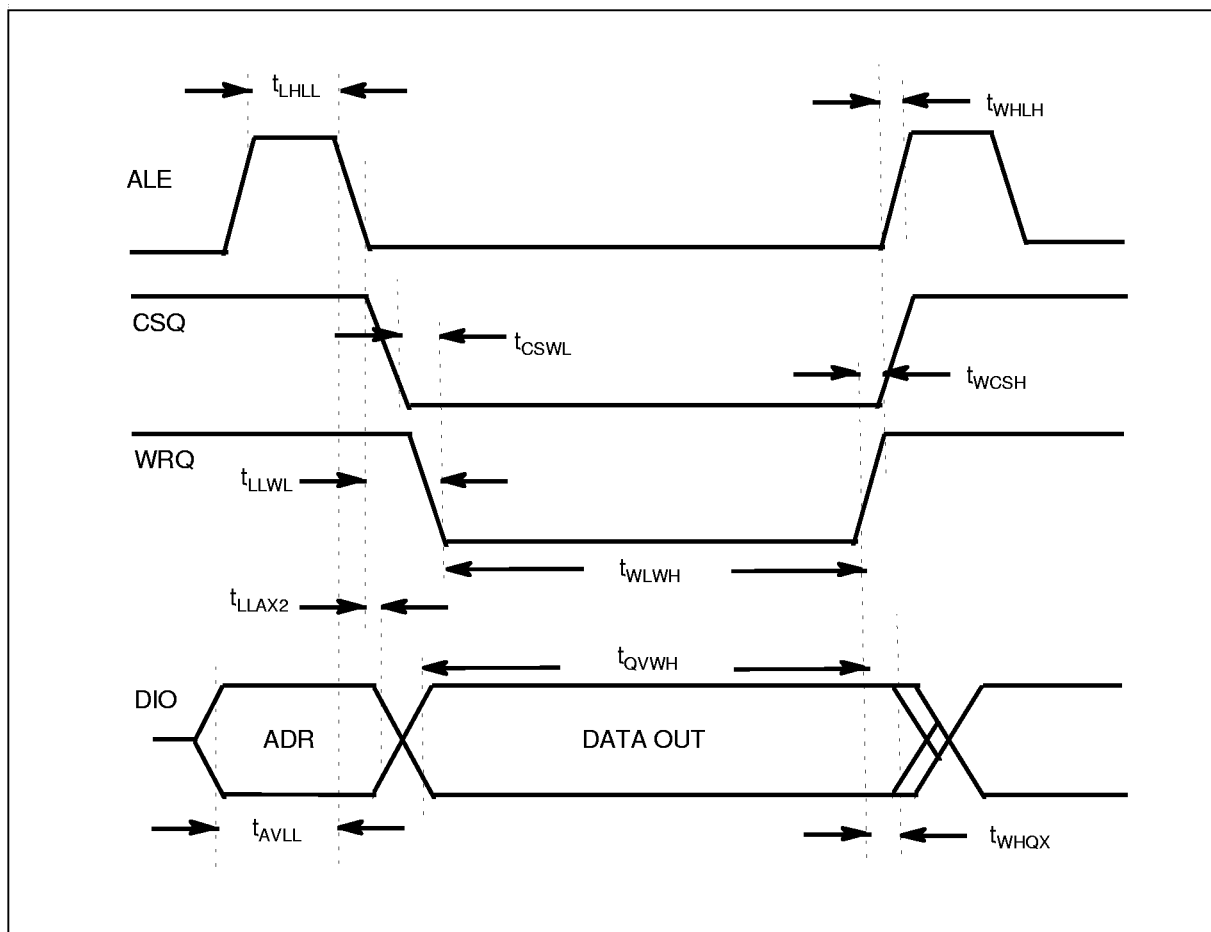


Figure 39 Timing Specifications for a Write Access to the μ C-Interface

Electrical Characteristics

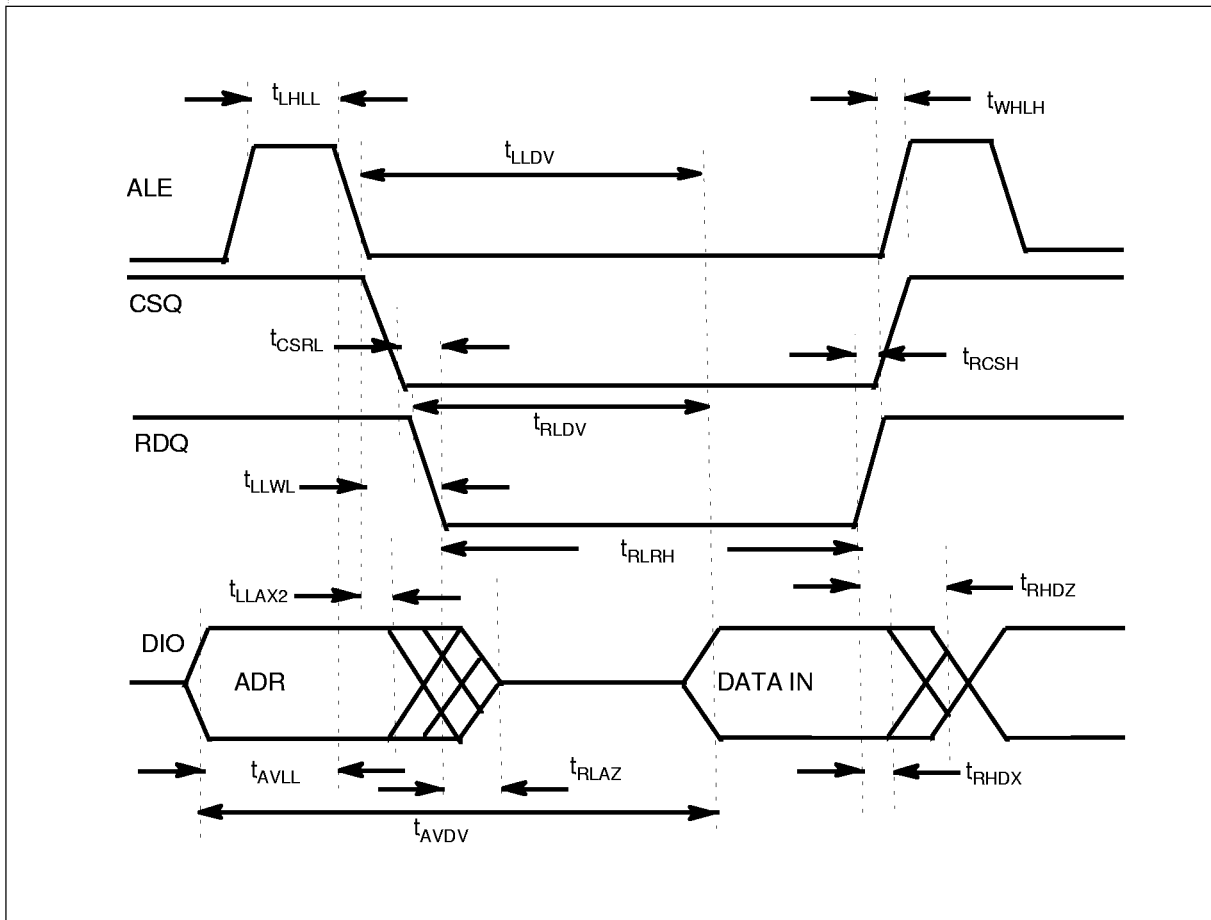


Figure 40 Timing Specifications for a Read Access to the μ C-Interface

Electrical Characteristics
Table 18

Parameter	Symbol	Limit Values					Unit
		16 MHz			3.5-16 MHz		
		min.	typ.	max.	min.	max.	
RD pulse width	t_{RLRH}		85				ns
WR pulse width	t_{WLWH}		85				ns
Address hold after ALE	t_{LLAX2}		35				ns
RD to valid data in	t_{RLDV}		35				ns
Data hold after RD	t_{RHDX}		15				ns
Data float after RD	t_{RHDZ}		40				ns
ALE to valid data in	t_{LLDV}		35				ns
Address to valid data in	t_{AVDV}		50				ns
ALE to WR or RD	t_{LLWL}		30				ns
WR or RD high to ALE high	t_{WHLH}		55				ns
ALE high time	t_{LHLL}		40				ns
Address setup to ALE	t_{AVLL}		30				ns
Data setup before WR	t_{QVWH}		45				ns
Data hold after WR	t_{WHQX}		35				ns
Address float after RD	t_{RLAZ}		15				ns
CS low to WR low	t_{CSWL}		20				ns
CS low to RD low	t_{CSRL}		20				ns
WR high to CS high	t_{WCSH}		20				ns
RD high to CS high	t_{RCSH}		20				ns

Electrical Characteristics

7.2.6 QAP-Interface Switching Characteristics

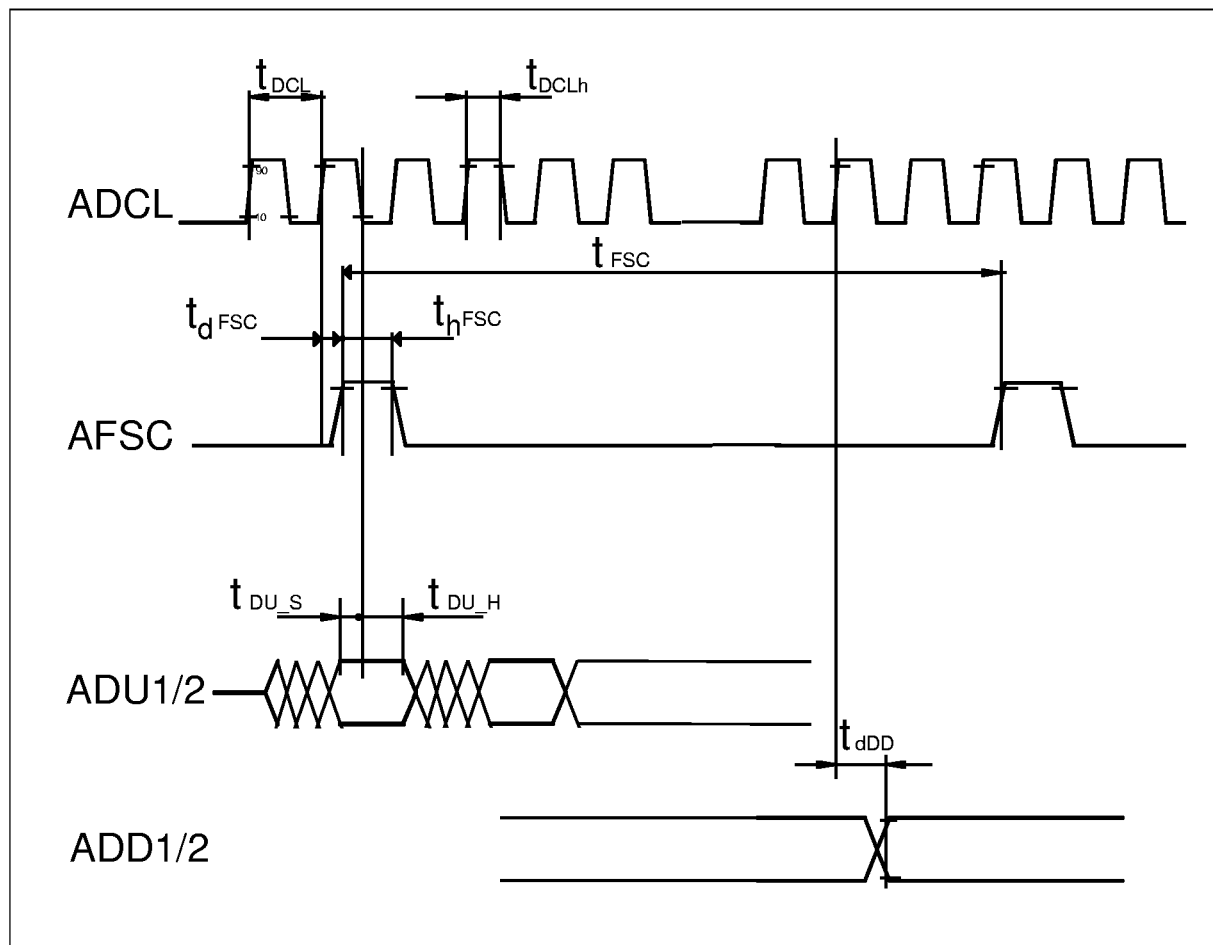


Figure 41

Table 19

Parameter	Symbol	Limit Values			Unit
		min.	typ.	max.	
Period ADCL	t_{DCL}		1/16.384 MHz		
ADCL duty cycle	t_{DCLh}	40	50	60	%
Period AFSC	t_{FSC}		500		μs
AFSC delay	t_{dFSC}		5	20	ns
AFSC high	t_{hFSC}		t_{DCL}		ns
ADU1/2 setup time	$t_{DU S}$	20			ns
ADU1/2 hold time	$t_{DU H}$	20			ns
ADD1/2 delay	t_{dDD}			20	ns

Electrical Characteristics
7.2.7 I/O-Switching Characteristics (IO1 to IO4, ID0 to ID3)

t.b.d concerned to IOM-2 and μC
7.3 PEB 4165 (AHV-SLIC)
7.3.1 Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit	Condition
		min.	max.		
Battery voltage	V_{BAT}	– 90	0.5	V	referred to BGND
Auxiliary supply voltage	V_{H}	– 0.5	90	V	referred to BGND
Total battery supply voltage, continuously	$V_{\text{H}} - V_{\text{BAT}}$		160	V	
Total battery supply voltage, pulse < 1 ms	$V_{\text{H}} - V_{\text{BAT}}$		170	V	
VDD supply voltage	V_{DD}	– 0.4	5.5	V	referred to AGND
VSS supply voltage	V_{SS}	– 5.5	0.4	V	referred to AGND
Ground voltage difference	VBGND - VAGND	– 0.5	0.5	V	
Junction temperature	T_{j}		150	°C	
Input voltages	VDCP/N VACP/N VC1, VC2	$V_{\text{SS}} - 0.3$ – 0.3	$V_{\text{DD}} + 0.3$ $V_{\text{DD}} + 0.3$	V	
Voltages on current outputs	VIT, VIL	– 3.5	$V_{\text{DD}} + 0.3$	V	
RING, TIP voltages, continuously	$V_{\text{R}}, V_{\text{T}}$	$V_{\text{BAT}} - 0.3$	$V_{\text{H}} + 0.3$	V	
RING, TIP voltages, pulse < 1 ms	$V_{\text{R}}, V_{\text{T}}$	$V_{\text{BAT}} - 10$	$V_{\text{H}} + 10$	V	
RING, TIP voltages, pulse < 1 μs	$V_{\text{R}}, V_{\text{T}}$	$V_{\text{BAT}} - 20$	$V_{\text{H}} + 20$	V	
ESD-voltage, all pins			1	kV	Human body model

Electrical Characteristics
7.3.2 Operating Range

Parameter	Symbol	Limit Value		Unit	Condition
		min.	max.		
Battery voltage	V_{BAT}	– 80	– 24	V	referred to BGND
Auxiliary supply voltage	V_H	5	85	V	referred to BGND
Total battery supply voltage	$V_H - V_{BAT}$		150	V	
VDD supply voltage	V_{DD}	4.75	5.25	V	referred to AGND
VSS supply voltage	V_{SS}	– 5.25	– 4.75	V	referred to AGND
Ground voltage difference		– 0.3	0.3	V	
Ambient temperature	T_A	0 – 40	70 85	°C °C	PEB 4165 PEF 4165
Voltage compliance IT, IL	V_{IT}, V_{IL}	– 3	3	V	
Input range VDCP, VDCN	VDC	– 3.2	+ 3.2	V	

Thermal Resistances

Junction to case	$R_{th, jC}$	5	K/W	
Junction to ambient	$R_{th, jA}$	20	K/W	with heatsink, typ.

Electrical Characteristics
7.3.3 Electrical Parameters

Min / max values are valid within the full operating range. If PEB- and PEF-specifications are different, both values can be found in the respective column.

Testing is performed according to the test figures with external circuitry as depicted in fig. t.b.d. Unless otherwise stated, load impedance $R_L = 600 \Omega$, $V_{BAT} = -70 \text{ V}$ and $V_H = +60 \text{ V}$, $V_{DD} = +5 \text{ V}$, $V_{SS} = -5 \text{ V}$. Test temperatures are 25 °C and 70 °C for PEB, -40 °C, 25 °C and 85 °C for PEF-type (without heatsink).

Supply Currents and Power Dissipation ($I_R = I_{TIP} = 0 \text{ A}$; $V_{RT} = 0 \text{ V}$) ¹⁾

No.	Parameter	Symbol	Mode	Limit Values			Unit
				min.	typ.	max.	

Power Down Mode

1.	V_{DD} current	I_{DD}	PDNH, PDNR		50		μA
2.	V_{SS} current	I_{SS}	PDNH PDNR		50 150		μA μA
3.	V_{BAT} current	I_{BAT}	PDNH PDNR		10 50		μA μA
4.	V_H current	I_H	PDNH HIRT, $V_H = +80 \text{ V}$		1 1	10 10	μA μA

Active Mode

5.	V_{DD} current	I_{DD}	ACT		3.3		mA
6.	V_{SS} current	I_{SS}	ACT		0.7		mA
7.	V_{BAT} current	I_{BAT}	ACT		5.5		mA
8.	V_H current	I_H	ACT		1		μA
9.	Quiescent power dissipation	PQ	ACT		400		mW

Electrical Characteristics

Supply Currents and Power Dissipation ($I_R = I_{TIP} = 0 \text{ A}$; $V_{RT} = 0 \text{ V}$) ¹⁾ (cont'd)

No.	Parameter	Symbol	Mode	Limit Values			Unit
				min.	typ.	max.	

Boosted Battery Mode

10.	V_{DD} current	I_{DD}	BB		1.5		mA
11.	V_{SS} current	I_{SS}	BB		0.8		mA
12.	V_{BAT} current	I_{BAT}	BB		5		mA
13.	V_H current	I_H	BB		4		mA
14.	Quiescent power dissipation	PQ	BB		600		mW

¹⁾ The total power dissipation consists of the quiescent power dissipation PQ given above, a V_{RT} dependent component PV and a component PI depending on the line current I_{RT} :

$$P_{tot} = PQ + PV + PI \text{ with}$$

	PV	PI
Active	0	$1.08 \times I_{RT} \times (-V_{BAT}) - I_{RT} \times V_{RT}$
Boosted	$(V_{RT} / 100 \text{ k}) \times (V_H - V_{BAT})$	$1.05 \times I_{RT} \times (V_H - V_{BAT}) - I_{RT} \times V_{RT}$

Electrical Characteristics
7.4 DC-Characteristics

No.	Parameter	Symbol	Mode	Limit Values			Unit	Test Condition
				min.	typ.	max.		

Line Termination TIP, RING

15.	DC line voltage	VTR, DC	ACT, BB		0		V	VDCP = - VDCN = 0 V
16.		VT, DC	ACT		- 35		V	
			BB		- 5		V	
17.		VTR, DC	ACT		50		V	VDCP = - VDCN = 1 V
18.					- 50		V	VDCP = - VDCN = - 1 V
19.	Max. DC line voltage		ACT		67		V	VDCP = - VDCN = 1.5 V $I_{RT} = 20 \text{ mA}$
20.	Output current limit	$ I_R, \text{max} $ $ I_T, \text{max} $	all	90		130	mA	VR, VT
21.	Loop open resistance TIP to BGND	R_{TG}	PDNR	6.8	8	9.2	k Ω	$I_{TIP} = 2 \text{ mA}$, Temp = 25 °C ¹⁾
22.	Loop open resistance RING to V _{BAT}	R_{RB}	PDNR	6.8	8	9.2	k Ω	$I_R = 2 \text{ mA}$, Temp = 25 °C ¹⁾
23.	Power denial output leakage current	ILeak, R	PDNR	- 30		30	μA	$V_{BAT} < V_R < V_H$
24.		ILeak, T		- 30		30	μA	$V_{BAT} < V_T < V_H$
25.	High impedance output leakage current	ILeak, R	HIR(T)	- 30		30	μA	$V_{BAT} < V_R < V_H - 3$
26.		ILeak, T	HI(R)T	- 30		30	μA	$V_{BAT} < V_T < V_H - 3$

Inputs DCP, DCN, ACP, ACN

27.	Input resistance DCP, DCN	RDC	all	100			k Ω	
28.	Input resistance ACP, ACN	RAC	all	13	16		k Ω	

Electrical Characteristics
7.4 DC-Characteristics (cont'd)

No.	Parameter	Symbol	Mode	Limit Values			Unit	Test Condition
				min.	typ.	max.		

Current Outputs I_T , I_L

29.	IT output current	I_T	ACT			15	μA	$I_R = I_T = 0 \text{ mA}$
30.				380		420	μA	$I_R = I_T = 20 \text{ mA}$
31.				- 380		- 420	μA	$I_R = I_T = - 20 \text{ mA}$
32.				0.95		1.05	mA	$I_R = I_T = 50 \text{ mA}$
33.				- 0.95		- 1.05	mA	$I_R = I_T = - 50 \text{ mA}$
34.	Offhook output current on I_T		PDNR		850		μA	TIP/RING shorted
35.	I_L output current	I_L	ACT			30	μA	$I_R = I_T = 20 \text{ mA}$
36.				75		125	μA	$I_R = 15 \text{ mA}, I_T = 25 \text{ mA}$
37.				- 190		- 310	μA	$I_R = 62.5 \text{ mA}$ $I_T = 37.5 \text{ mA}$

Control Inputs C1, C2

38.	H-input voltage	V_{IH}	all		4.03		V	$V_{DD} = 5 \text{ V}$
39.	M-input voltage	V_{IM}	all		2.57		V	$V_{DD} = 5 \text{ V}$
40.	L-input voltage	V_{IL}	all		1.125		V	$V_{DD} = 5 \text{ V}$
41.	Input leakage current	I_{Leak}	all	- 5		5	μA	$0 < VC1(2) < + 5 \text{ V}$
42.	Thermal overload current C1	I_{therm}	all	120	150		μA	$VC1 = 1.25 \text{ V}$
43.	Switching temperature (guaranteed by design)	T_{joff} T_{jon}	all all		165 145		$^{\circ}C$ $^{\circ}C$	

¹⁾ The systematic temperature dependence of these resistances is + 0.1% / $^{\circ}C$

Electrical Characteristics

7.5 AC-Characteristics

No.	Parameter	Symbol	Mode	Limit Values			Unit	Test Condition
				min. PEB/PEF	typ.	max.		

Line Termination TIP, RING

44.	Receive gain	Gr	ACT, BB	9.78	9.90	10.02	dB	VACP = – VACN = 320 mVrms $f = 1015 \text{ Hz}$ $I_{RT} = 25 \text{ mA}$
45.	Gain flatness (guaranteed by design)	dGr	ACT, BB	– 0.05		0.05	dB	$300 \text{ Hz} < f < 3400 \text{ Hz}$
46.	Gain tracking (guaranteed by design)	dGr	ACT	– 0.2		0.2	dB	$3 \text{ dBm}_0 > V_{RT}$ $> -20 \text{ dBm}_0$
47.	Total harmonic distortion V_{RT}	THD	ACT			0.3	%	VACP = – VACN = 320 mVrms $f = 1015 \text{ Hz}$, $I_{RT} = 25 \text{ mA}$
48.	Teletax distortion	THD TTX	ACT			3	%	$f = 16 \text{ kHz}$, $R_L = 200 \Omega$ $I_{RT} = 25 \text{ mA}$ $V_{RT}, AC = 5 \text{ Vrms}$
49.						5	%	$I_{RT} = 0 \text{ mA}$, $V_{RT} = 55 \text{ V}$ $V_{RT}, AC = 2 \text{ Vrms}$
50.	Psophometric noise	Np, VRT	ACT			– 75	dBmp	$I_{RT} = 25 \text{ mA}$
51.	Longitudinal to transversal rejection ratio V_{long}/V_{RT}	LTRR	ACT	61 / 58			dB	$V_{long} = 3 \text{ Vrms}$ $300 \text{ Hz} < f < 3.4 \text{ kHz}$ $I_{RT} = 25 \text{ mA}$
52.	Transversal to longitudinal rejection ratio V_{RT} $/V_{long}$	TLRR	ACT	50			dB	VACP = – VACN = 960 mVrms $300 \text{ Hz} < f < 3.4 \text{ kHz}$ $I_{RT} = 25 \text{ mA}$
53.	Power supply rejection ratio V_{BAT}/V_{RT}	PSRR	ACT, BB	33	40		dB	$300 \text{ Hz} < f < 3.4 \text{ kHz}$ V_{Supply} , $AC = 100 \text{ mVp}$ $I_{IRT} = 25 \text{ mA}$
54.	V_H/V_{RT}		BB	33	40		dB	
55.	V_{DD}/V_{RT}		ACT, BB	33	50		dB	
56.	V_{SS}/V_{RT}		ACT	33	50		dB	

Electrical Characteristics

7.5 AC-Characteristics (cont'd)

No.	Parameter	Symbol	Mode	Limit Values			Unit	Test Condition
				min. PEB/PEF	typ.	max.		
57.	Ringing distortion	THD	BB			4	%	$R_L = 1\text{ K}$, $C_L = 1\text{ }\mu\text{F}$ $f = 66\text{ Hz}$, $V_{DCP} = -V_{DCN}$ $= 0.4\text{ V (DC)}$ $+ 1.3\text{ V}_{rms}$ (sine wave)
58.	Transversal current ratio	Git	ACT, BB	33.89	33.98	34.07	dB	$V_{ACP} = -V_{ACN}$ $= 320\text{ mV}_{rms}$ $f = 1015\text{ Hz}$ $I_{RT} = 25\text{ mA}$ $I_{RT} = -25\text{ mA}$
59.			ACT, BB	33.89	33.98	34.07	dB	
60.	Gain flatness (guaranteed by design)	dGit	ACT, BB	- 0.05		0.05	dB	$300\text{ Hz} < f < 3400\text{ Hz}$
61.	Gain tracking (guaranteed by design)	dGit	ACT, BB	- 0.2		0.2	dB	$3\text{ dBm}_0 > V_{RT}$ $> -20\text{ dBm}_0$
62. 63.	Total harmonic distortion VIT	THD,IT	ACT		0.01 t.b.d.	0.3	%	$V_{ACP} = -V_{ACN}$ $= 320\text{ mV}_{rms}$ $f = 1015\text{ Hz}$ $I_{RT} = 25\text{ mA}$ $I_{RT} = 0\text{ mA}$
64.	Psophometric noise	Np,VIT	ACT			- 102	dBmp	$I_{RT} = 25\text{ mA}$
65.	Longitudinal to transversal current output rejection ratio V_{long}/V_{IT}	LITRR	ACT	t.b.d.			dB	$V_{long} = 3\text{ V}_{rms}$ $300\text{ Hz} < f < 3.4\text{ kHz}$ $I_{RT} = 25\text{ mA}$
66.				t.b.d.			dB	$I_{RT} = 25\text{ mA}$
67.	Power supply rejection ratio	PSRR	ACT	50	60		dB	$300\text{ Hz} < f < 3.4\text{ kHz}$ V_{supply} , $AC = 100\text{ mVp}$ $I_{RT} = 25\text{ mA}$
68.			BB	50	60		dB	
69.			ACT	50	60		dB	
70.			ACT	50	60		dB	

Test Features
8 Test Features
Table 20 Card Tests: (900 Ω Testloop, Option: with relay)

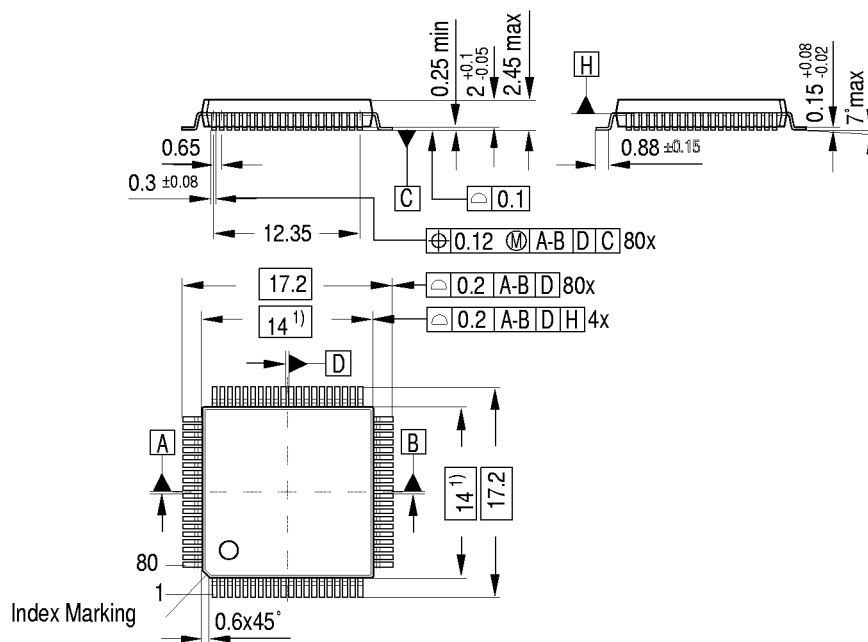
No.	Test	Result	Loops	Settings	Switches	Description
1.	Level metering AC	PCM MVA, RLM0/1	AC Loop	ITIME LMBP LMNOTCH LM2PCM LMSEL0/1 ELM	ENTE on ELM on	After programming the settings and release with the ENTE the levelmetering will be started by ELM = 1. The end of measurement is shown by MVA, RLM0/1 and the result can be sent to the CIDU-voice channel. ITIME determines the Integration time either 16 ms or 256 ms.
2.	Level metering DC	PCM MVA, RLM0/1	DC Loop	LP03, LP5, DISPOFI, PCM2DC DCAD16 ERAMP ERECT LM2PCM LMSEL0/1 ELM f_{RING}	ENTE on ELM on	After programming the settings and release with the ENTE the levelmetering will be started by ELM = 1. The measurement time is programmable using the ring generator. The end of measurement is shown by MVA, RLM0/1 and the result can be sent to the DU-voice channel. Includes measurement of Offset, and Ringer Capacitance.
3.	Level metering TTX	PCM MVA, RLM0/1	DC Loop	ELM TTXL LMSEL0/1 LM2PCM PCM2DC	ENTE on ELM on	After programming the settings and release with the ENTE the levelmetering will be started by ELM = 1. The measurement time is programmable by ITIME either 16 ms or 256 ms. The end of measurement is shown by MVA, RLM0/1 and the result can be sent to the DU-voice channel. By setting TTXL and correct programming of the IM-Filters the TTX current is measured directly.

9 Package Outlines

9.1 PEB 3465 (QAP)

P-MQFP-80-1

(Plastic Metric Quad Flat Package)



1) Does not include plastic or metal protrusions of 0.25 max per side

GPM05249

Sorts of Packing

Package outlines for tubes, trays etc. are contained in our Data Book "Package Information".

SMD = Surface Mounted Device

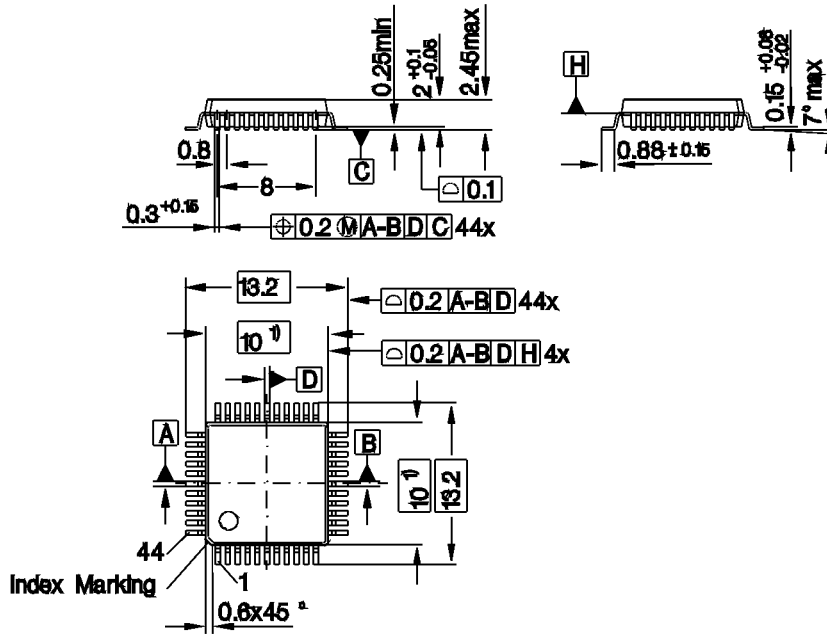
Dimensions in mm

Package Outlines

9.2 PEB 31665 (MuPP)

P-MQFP-44-2

(Plastic Metric Quad Flat Package)



1) Does not include plastic or metal protrusion of 0.25 max. per side

GPM05622

Sorts of Packing

Package outlines for tubes, trays etc. are contained in our Data Book "Package Information".

SMD – Surface Mounted Device

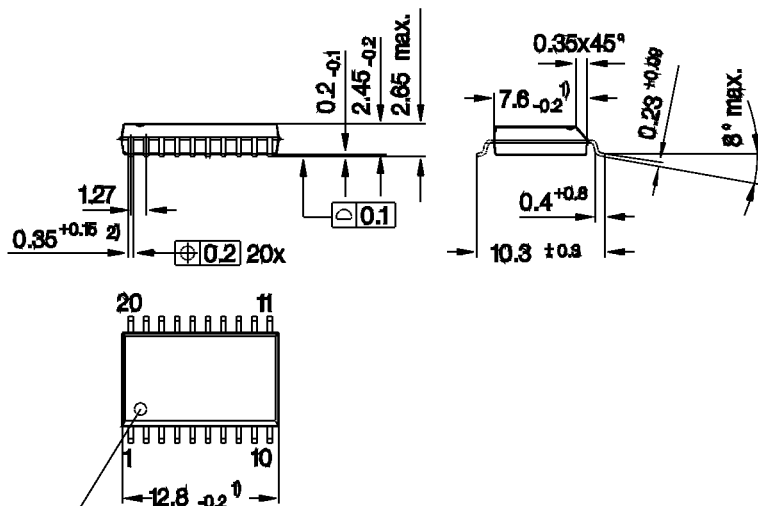
Dimensions in mm

Package Outlines

9.3 PEB 4165 (AHV-SLIC)

P-DSO-20-5

(Plastic Dual Small Outline)



Index Marking

- 1) Does not include plastic or metal protrusion of 0.15 max. per side
- 2) Does not include dambar protrusion

GPS05094

Sorts of Packing

Package outlines for tubes, trays etc. are contained in our Data Book "Package Information".

SMD – Surface Mounted Device

Dimensions in mm

10 Appendix

10.1 IOM[®]-2 Interface Monitor Transfer Protocol

Monitor Channel Operation

The monitor channel is used for the transfer of maintenance information between two functional blocks. Using two monitor control bits (MR and MX) per direction, the data are transferred in a complete handshake procedure. The MR and MX bits in the fourth octet (C/I channel) of the IOM-2 frame are used for the handshake procedure of the monitor channel

The monitor channel transmission operates on a pseudo-asynchronous basis:

- Data transfer (bits) on the bus is synchronized to Frame Sync FSC
- Data flow (bytes) are asynchronously controlled by the handshake procedure.

For example: Data is placed onto the DD-Monitor-Channel by the Monitor-transmitter of the master device (DD-MX-Bit is activated i.e. set to '0'). This data transfer will be repeated within each frame (125 μ s rate) until it is acknowledged by the MuPP Monitor-receiver by setting the DU-MR-bit to '0', which is checked by the Monitor-transmitter of the master device. Thus, the data rate is not 8-kbytes/s.

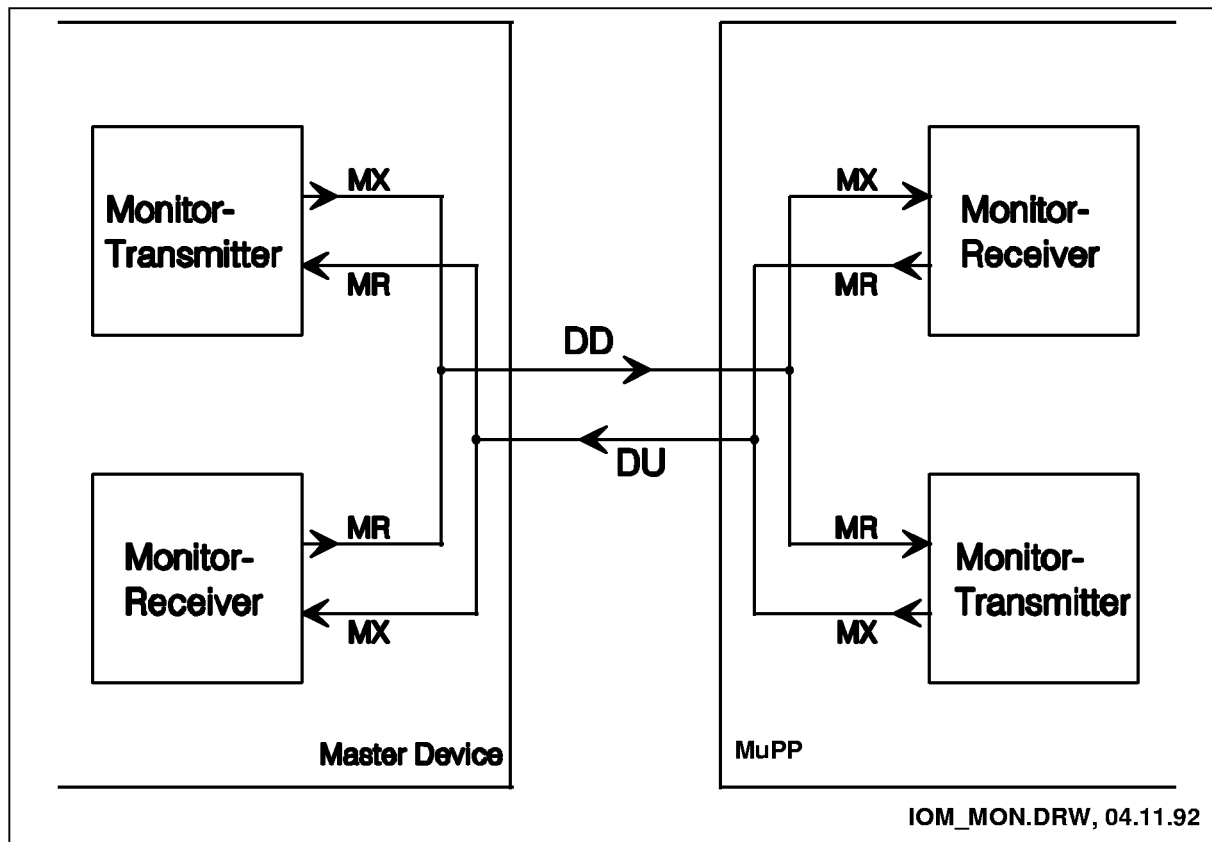


Figure 42

Appendix

Monitor handshake procedure

The monitor channel works in 3 states

- idle state: A pair of inactive (set to '1') MR- and MX-bits during two or more consecutive frames: End of Message (EOM)
- sending state: MX-bit is activated (set to '0') by the Monitor-transmitter, together with data-bytes (can be changed) on the Monitor-channel
- acknowledging: MR-bit is set to active (set to '0') by the Monitor-receiver, together with a data-byte remaining in the Monitor-channel.

A start of transmission is initiated by a Monitor-transmitter in sending out an active MX-bit together with the first byte of data (the address of the receiver) to be transmitted in the Monitor-channel.

This state remains until the addressed Monitor-Receiver acknowledges the received data by sending out an active MR-bit, which means that the data-transmission is repeated each 125 µs frame (minimum is one repetition). During this time the Monitor-transmitter evaluates the MR-bit.

Flow control, means in the form of transmission delay, can only take place when the transmitters MX and the receivers MR bit are in active state.

Since the receiver is able to receive the monitor data at least twice (in two consecutive frames), it is able to check for data errors. If two different bytes are received the receiver will wait for the receipt of two identical successive bytes (last look function).

A collision resolution mechanism (check if another device is trying to send data during the same time) is implemented in the transmitter. This is done by looking for the inactive ('1') phase of the MX-bit and making a per bit collision check on the transmitted monitor data (check if transmitted '1's are on DU/DD-line; DU/DD-line are open-drain lines).

Any abort leads to a reset of the MuPP command stack, the device is ready to receive new commands.

To obtain a maximum speed data transfer, the transmitter anticipates the falling edge of the receivers acknowledgment.

Due to the inherent programming structure, duplex operation is not possible. It is not **allowed** to send any data to the MuPP, while transmission is active.

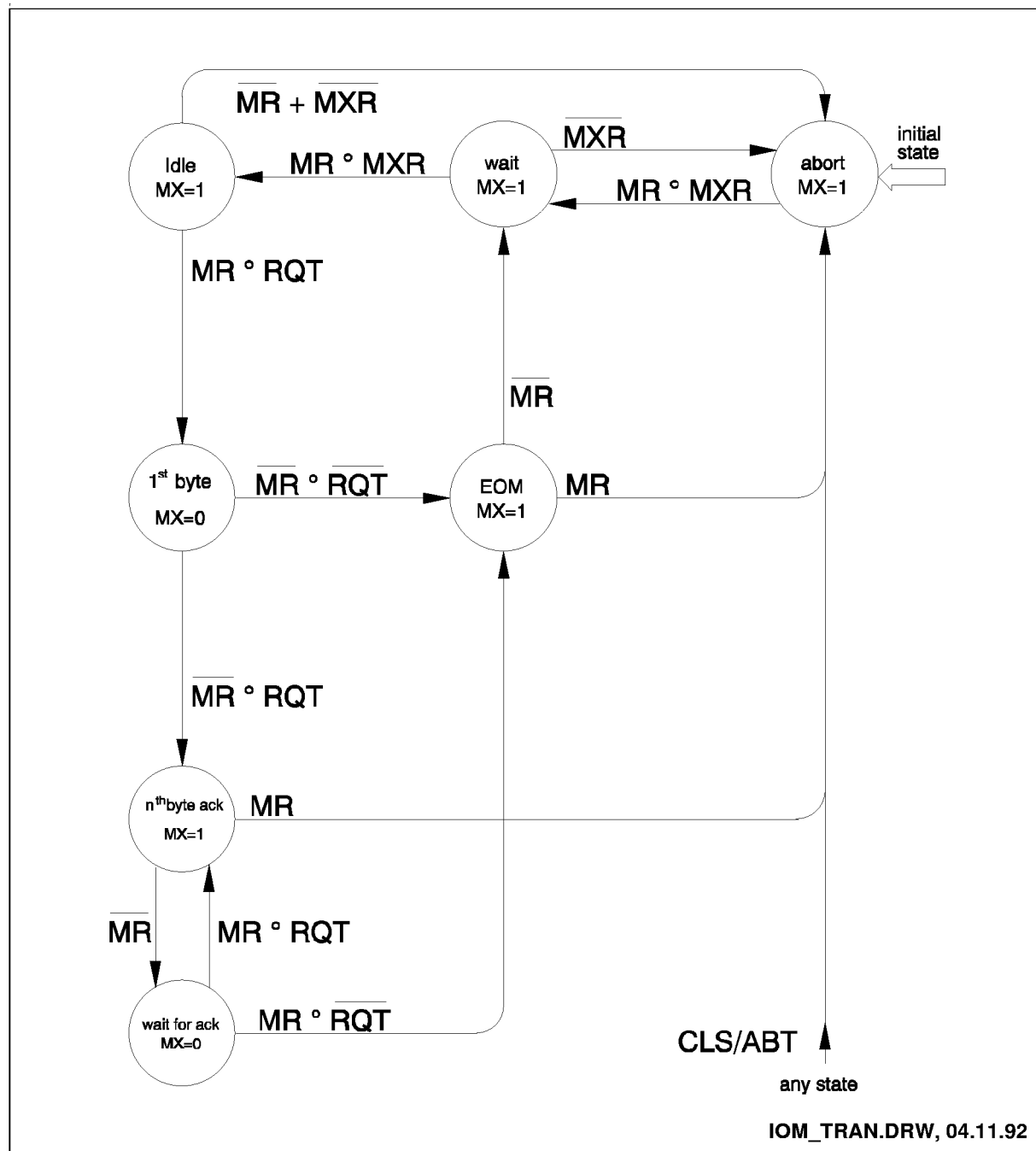


Figure 43 State Diagram of the MuPP Monitor Transmitter

MR ... MR - bit	Received on DD - line
MX ... MX - bit	Calculated and expected on DU - line
MXR ... MX - bit	Sampled on DU - line
CLS ...	Collision within the monitor data byte on DU - line
RQT ...	Request for transmission from internal source
ABT ...	Abort request/indication

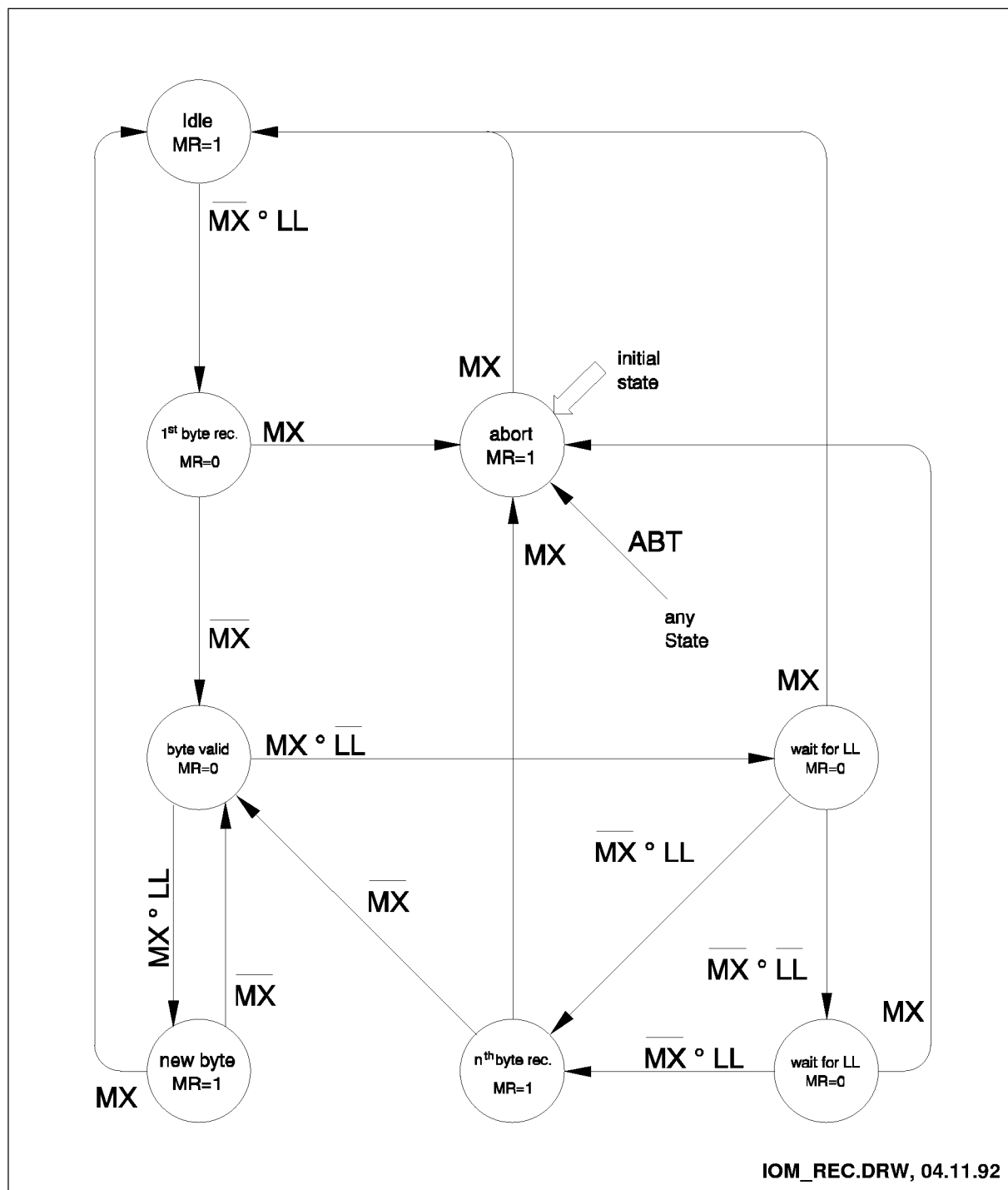


Figure 44 State Diagram of the MuPP Monitor Receiver

MR ... MR - bit Calculated and transmitted on DU - line
 MX ... MX - bit Received data downstream (DD - line)
 LL ... Last lock of monitor byte received on DD - line
 ABT ... Abort indication to internal source

Monitor Channel Data Structure

The monitor channel is used for the transfer of maintenance information between two functional blocks. By use of two monitor control bits (MR and MX) per direction, the data are transferred in a complete handshake procedure.

Address Byte

Messages to and from the MuPP are started with the following byte:

Bit	7	6	5	4	3	2	1	0
	1	0	0	0	0	0	0	1

Thus providing information for up to 16 analog lines, the MuPP is one device for up to 16 IOM-2 time slots. Monitor data for the analog channels is selected by the MuPP specific commands (SOP, XOP, TOP or COP) following.

10.2 Channel Identification Command (CIC)

In order to unambiguously identify different devices by software, a two Byte identification command is defined for analog lines IOM-2 devices. A device requesting the identification of the MuPP will send the following 2 byte code:

1	0	0	0	0	0	0	0
0	0	0	0	0	0	0	0

Each device will then respond with its specific identification code. For the MuPP this two byte identification code is:

1	0	0	0	CONF			
1	0	0	0	0	0	0	1

CONF an optional 4-bit code indicating the specific hardware environment. A typical application of the CONF code is the differentiation of various types of line circuits that use the same MuSLIC hardware within the same system.

For the realization of the Channel Identification Commands on the line card, it needs 4 pins of the MuPP (ID0,...ID3). One pin (ID0) is switchable as a digital serial interface of a shift register, to transfer special line card design informations up to 2×15 bytes into the monitor channel of the IOM-2 interface.

Appendix

There are two different solutions of the CIC for the MuPP to identify the version of the line card.

Solution 1: ('Normal' Channel Identification Command)

The input of the 4 pin interface (ID0 ... ID3) is transferred to the 4 bit CONF information using the following truth-table (binary coded):

Table 21

MuPP Ports				CONF-inf.
ID3	ID2	ID1	ID0	(4 bits)
0 V	0 V	0 V	0 V	0 0 0 0
0 V	0 V	0 V	3 V	0 0 0 1
0 V	0 V	3 V	0 V	0 0 1 0
0 V	0 V	3 V	3 V	0 0 1 1
0 V	3 V	0 V	0 V	0 1 0 0
0 V	3 V	0 V	3 V	0 1 0 1
0 V	3 V	3 V	0 V	0 1 1 0
0 V	3 V	3 V	3 V	0 1 1 1
3 V	0 V	0 V	0 V	1 0 0 0
3 V	0 V	0 V	3 V	1 0 0 1
3 V	0 V	3 V	0 V	1 0 1 0
3 V	0 V	3 V	3 V	1 0 1 1
3 V	3 V	0 V	0 V	1 1 0 0
3 V	3 V	0 V	3 V	1 1 0 1
3 V	3 V	3 V	0 V	1 1 1 0
3 V	3 V	3 V	3 V	1 1 1 1

This is a 14 possible individual line card design information or an address pointer for the system to get more basic information.

The information is read through the IOM-2 monitor channel with the CIC command.

Appendix

Solution 2 (Extended Channel Identification Command):

The second realization step is that the combination of ports (ID1, ID2, ID3 = + 3 V) changes the input port ID0 to a shift register input.

Table 22

MuPP Ports				CONF-inf.
ID3	ID2	ID1	ID0	(4 bits)
+ 3 V	+ 3 V	+ 3 V	x	1 1 1 x

An external shift register on the line card transmits up to 2×15 bytes of special HW + FW line card design information.

The information is read through the IOM-2 monitor channel with the XOP Command for XR7 or XR8. The CONF code is '111x' by this extended identification.

The first schematic gives an overview of the different timings for the extended channel identification.

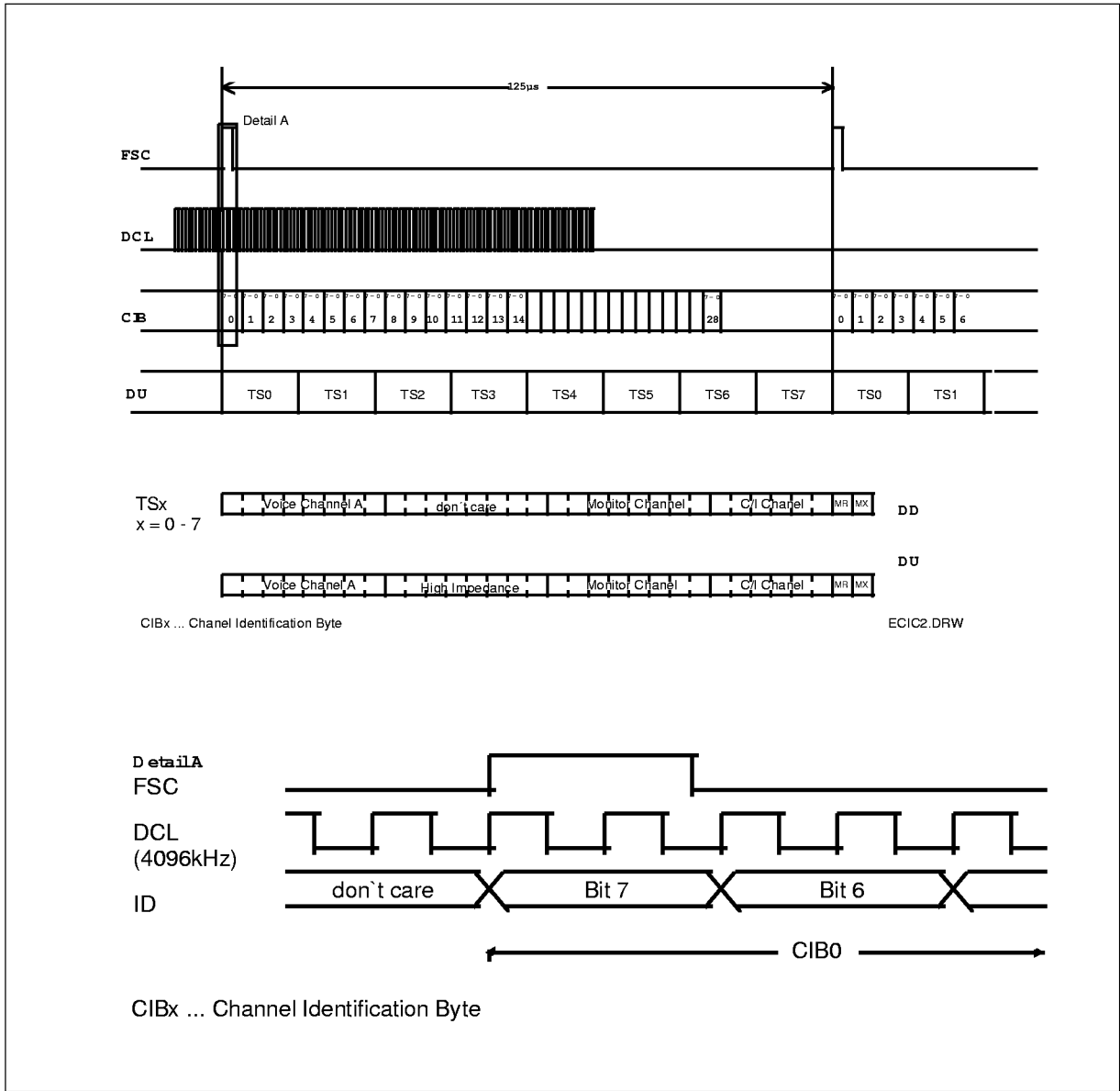


Figure 45 General Timing

Appendix

Expected Output of the ASIC Which Sends the Channel Identification:

The MuPP sends the Extended Channel Identification in the Monitor Channel of that time slot in which the XOP Command was sent. If – for example – the MuPP uses the time slot 6, the Monitor Channel of TS6 looks like the following (for all other time slots equivalent).

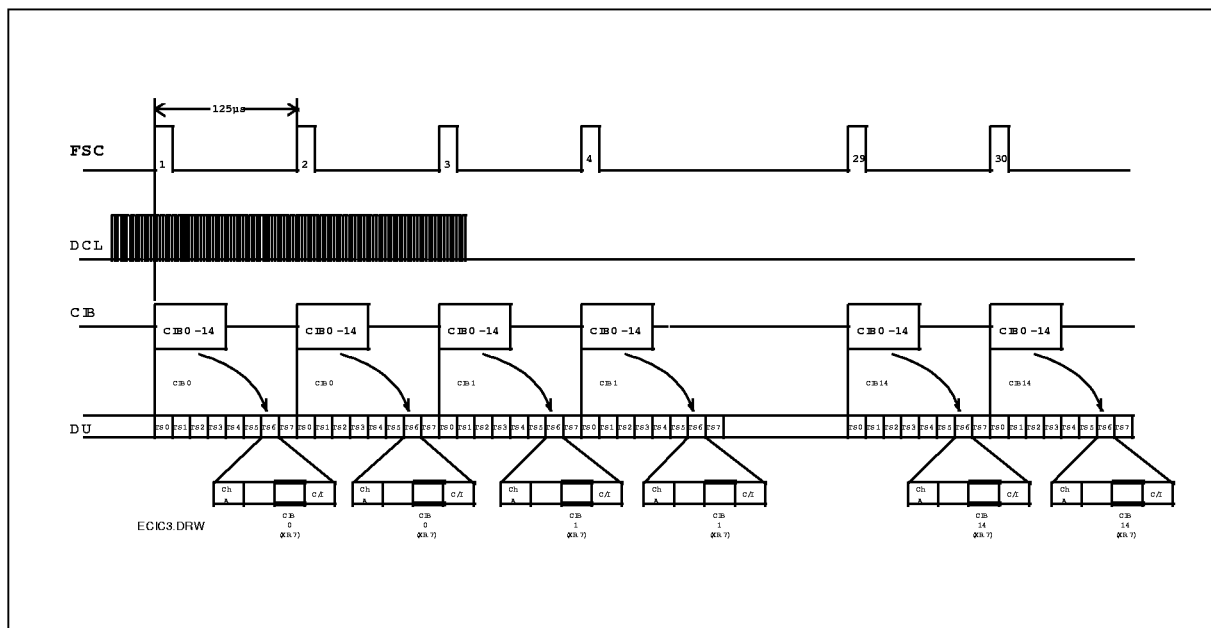


Figure 46

Expected Input Timing and IOM-2 Interface Timing and Switching characteristic: To be defined

10.3 List of Abbreviations

ACT	Active Mode
ADC	Analog Digital Converter
AGDCR	Attenuation DC Receive
AGDCX	Attenuation DC Transmit
AGR	Attenuation Receive
AGX	Attenuation Transmit
AGTTX	Attenuation Teletax
AR	Attenuation Receive
ASIC	Application Specific Integrated Circuit
AX	Attenuation Transmit
BB	Boosted Battery
BiCMOS	Bipolar Complementary Metal Oxid Semiconductor
BP	Band Pass
C/I-DD	Channel Identification-Data Downstream
C/I-DU	Channel Identification-Data Upstream
C1, 2	Digital Interface between QAP and AHV-SLIC
CHOP	Chopper (see SCR8_6)
CMP	Compander
CODEC	Coder Decoder
COMP	Comparator (Testloops, Levelmetering)
COP	Coefficient Operation
CRAM	Coefficient RAM
DAC	Digital Analog Converter
DAC-HOLD	DC DAC Hold (Testloop TVP)
DTAG	Deutsche Telecom AG
DCCHAR	DC Characteristic block
DCL	Data Clock
DD	Data Downstream
DHP_R	Disable Receive Highpass (SCR5_7)
DHP_X	Disable Transmit Highpass (SCR1_1)
DSP	Digital Signal Processor
DU	Data Upstream
DUP	Data Upstream Persistency Counter
DUPGNK	Data Upstream Persistency Counter for GNK
EXP	Expander

Appendix

FRR	Frequency Response Receive Filter
FRX	Frequency Response Transmit Filter
FSC	Frame Sync.
GNDIT	Analog Ground
GNK	Ground Key
AHV-SLIC	Advanced High Voltage Subscriber Line Interface Circuit
I1	Fixed Input Pin
ID	External Identification
IL	Longitudinal Current Input
IM I	Impedance Matching Filter (programmable)
IMFIX	Impedance Matching Filter (fixed)
IO	User Programmable I/O Pin
IOM 2-Interface	ISDN Oriented Modular Interface
ISDN	Integrated Service Digital Network
IT	Transversal Current Input (for AC and DC)
ITAC	Transversal Current Input (for AC)
LP03	Low Pass 0.3 Hz
LP5	Low Pass 5 Hz
LSSGR	Local area transport access Switching System Generic Requirements
MEAN VAL.	Mean Value (Testloops, Levelmetering)
MR	Monitor Receive
MX	Monitor Transmit
MuPP	Multi Channel Processor for POTS
MuSLIC	Multi Channel Subscriber Line Interface Circuit
MuSLICOS	MuSLIC Oriented Software
O1	Fixed Output Pin
PCM	Pulse Code Modulation
PDen	Power Denial
PDN	Power Down
PDN	PDN Pin (Sets the HV SLIC to Power Denial)
POFI	Post Filter
PREFI	Antialiasing Pre Filter

Appendix

QAP	Quad Analog POTS
RB	Ring Burst
RECT	Rectifier (Testloops, Levelmetering)
RES	Reset
REXT	External Ring Sync. Input
RFIX	Receive Filter (fixed)
RNG	Ring Generator
RREF	External Resistor to GNDA
SCR	Status Configuration Register
SLIC	Subscriber Line Interface Circuit
SLMA	Subscriber Loop Marging
SLXC	Summary Line Card Outputs
SOP	Status Operation
STCR	Status Test Configuration Register
TCR	Transfer Configuration Register
TST1	Test Pin
TG	Tone Generator
TH	Transhybrid Balancing
THFIX	Transhybrid Balancing Filter (fixed)
THRESH	Threshold (Testloops, Levelmetering)
TOP	Transfer Operation
TS	Time Slot
TS 0-2	Time Slot selection Pin
TTX	Teletax
TTXFI	Teletax Adaptation
TTXGEN	Teletax Generator
VBIM	Battery Image Input
VB/2	Half Battery Voltage Input
X	Transmit Filter (programmable)
XFIX	Transmit Filter (fixed)